





Prototype & **System Development Products That Accelerate** Time-to-Marke **For Your Products**





"We're **Committed To Delivering** Technology's **Tools For** Tomorrow's Products."

Dale Scoville. President

By providing tools for R&D, Vector Electronic Company has played an exciting role in some of technology's most important accomplishments. Vector products have been to the moon and flown on the space shuttle. They've even been to Disneyland.

In the 90's the technological pace will accelerate even more. We all need to be innovative, quick on our feet. We'll handle faster circuits, denser packages, and we'll need to maintain greater precision and signal integrity than ever.

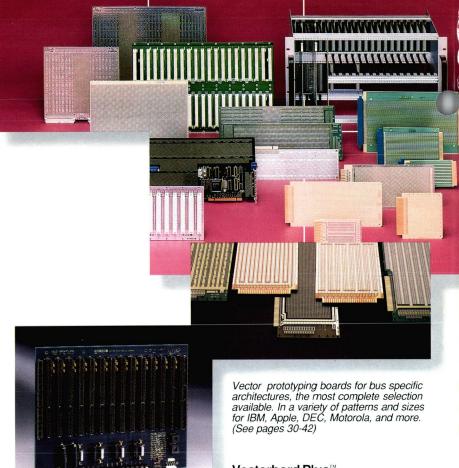
Vector is ready for the 90's. We've updated our design and manufacturing operations using innovative CAD, CAM, and CIM techniques. We've expanded our product line with standard and custom products that meet your needs for higher performance applications.

Vector continues to save you time and money. by providing tools that meet your most simple or complex needs. Our goal, since 1947, has been to meet the prototyping needs of the designer and engineer- the people who create the future.

This catalog is another example of our dedication. It features standard Vectorbord® and Vectorbord Plus™ products, as well as innovative new tools like the AT Industrial Computer Development System and the Multilayer AT Extender. You'll find your products easily, and Vector products are always as near as your local electronics distributor.



12460 Gladstone Ave., Sylmar, CA 91342 Phone (818) 365-9661 Fax (818) 365-5718 Inside CA (800) 426-4652 Outside CA (800) 423-5659



An excellent platform for configuring industrial computers, Vector's multilayer AT Passive Backplane provides capacity and ensures compatibility for the most complex systems. (see page 78)

Vectorbord®

The Vectorbord trademark refers to our standard, or catalog, line of prototyping boards. Known for quality, versatility, and availability, all Vectorbord products are designed and manufactured to the strictest standards and are available at electronics distributors nationwide.

Vectorbord Plus™

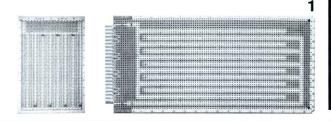
Vectorbord Plus™ prototyping boards have been adapted for discrete wire interconnection techniques to meet requirements for high performance applications. Utilizing multilayer construction, onboard decoupling capacitors, and terminator resistors, Vectorbord Plus products provide for greater circuit speeds, higher package densities, and reliable signal handling. Vectorbord Plus products can be found in the Europackaging and Bus Specific sections of this catalog. Standard Vectorbord Plus products are available from electronics distributors nationwide. For custom configurations, contact factory.



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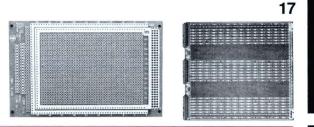
Vectorbord® General Purpose Prototyping Board

PunchBoards Circbords[™] Plugbords[™]



Vectorbord® Eurocards

Metric Prototyping Boards from 3U x 160MM To 9U x 400MM



Vectorbord® Bus Specific Prototyping Boards

IBM Apple Motorola Micromodule Multibus Commodore DEC PDP



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Europackaging

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19" Subracks and Card Cages Parts and Accessories

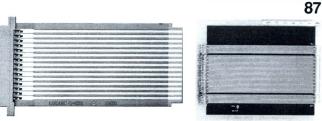


Vectorbord® Backplanes General Purpose Uncommitted **Bus Specific**



Vectorbord® Extender Cards

General Purpose **Bus Specifics**



Tool and Accessories

Connectors Sockets Pins, Connectors and Terminals Wire and Wiring Tools Insertion Tools VLS-3 Vacuum Lamination System Vector Multiwire® Custom-Wired PCBs



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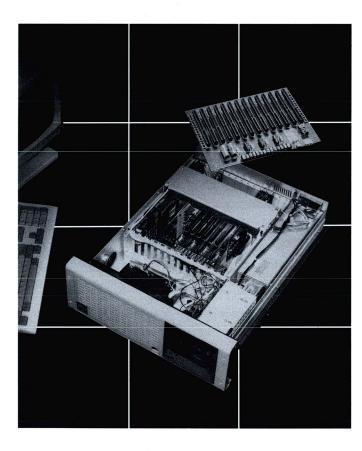


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AT Industrial Computer



Vector's New AT
Industrial Computer
Development
System...Designed
And Built To Be
Configured Quickly,
Then Provide A
Long, Reliable
System Life

Rugged and reliable, Vector's AT platform provides the capacity and performance needed to configure even complex systems—for applications such as CAM, CIM, data acquisition, file server, or process control—without spending days or weeks tracing esoteric integration problems. Built around an enhanced passive backplane, the AT Industrial Computer Development System gives you the freedom to design systems using virtually any available third-party CPUs (including 80386) and add-in cards. It lets you make choices based on the individual requirements of your application, not on the compatibility requirements of your hardware.

And once your system's operational, you're assured a long, reliable system life—even in harsh industrial environments. The enclosure has been

ruggedized and designed to withstand heat and vibration,and all components have been selected for maximum durability.



14-Slot Multilayer Passive Backplane

Provides capacity (8 full size ISA slots, 6 half or three quarter size), as well as ease of configuration and maintenance.

By maintaining accurate "square wave" switching, compatibility problems caused by different cards operating at different speeds are eliminated. This is accomplished utilizing multilayer construction to ensure uniform impedance, and extensive filtering. All incoming power voltages are kept scrupulously clean by inductor-capacitor filter networks, shielding backplane and cards from interference caused by peripheral motors. Also provided are sockets, five at each end, for usersupplied terminator resistors. Termination of signal lines eliminates reflection and ringing in higher performance systems, further ensuring signal integrity.

A Unique Configuration Board

Simplifies the process of interconnecting CPU and chassis circuitry. One inline and one dual row connector (either is standard on most third-party CPUs) are provided. Standard cables are routed to Configuration Board, then on-board jumpers are used to configure appropriate functions. No special cabling or connectors are required.

Industrial Strength Power Supply

An internal 275W switching power supply is capable of handling demands of the most complex systems, and will operate under full load in environments up to 100°F. It's housed in a separate enclosure for thermal and EMI shielding. For added protection, an over-temp sensor is provided. The sensor signals overheating conditions via usersupplied alarm (light, buzzer, or other), providing ample time for corrective action and/or data backup. In addition, power input can be switched easily between 110 and 220VAC, 50/60Hz, from a rear panel fuse hookup.

Rugged Construction

For vibration protection, cards of varying heights are secured by foam-backed card retainer bar. The chassis is constructed of .125 and .090 inch aluminum to combine light

Development System

weight and ruggedness.

For cooling and protection from airborne particles and moisture, two 90 cfm fans provide positive internal pressure. Fans are 12 volt, brushless design to prevent the induction of motor noise into the system.

Front panel indicators and controls include a lighted on-off switch, lighted reset switch, keyboard lock switch, LED hard drive indicator. DIN keyboard connector also is included. The system is available with an attractive, bezeled front panel with cooling slots and a hinged, translucent door for access to controls and disk drives. Coupled with the removable and reusable air filter, the front panel protects against contamination by dust and dirt often found in

harsh environments.

Built-In Options

Mounting bracket provided for two half-height drives with access through front panel door. Ample internal space for one or two hard drives. The AT Industrial Computer Development System from Vector.

For more information contact:

VECTOR ELECTRONIC COMPANY, (818) 365-9661. Or call toll-free 800-426-4652 (inside CA), or 800-423-5659 (outside CA).

Specifications

Dimensions: 19" wide, 21.5" deep, 7" high

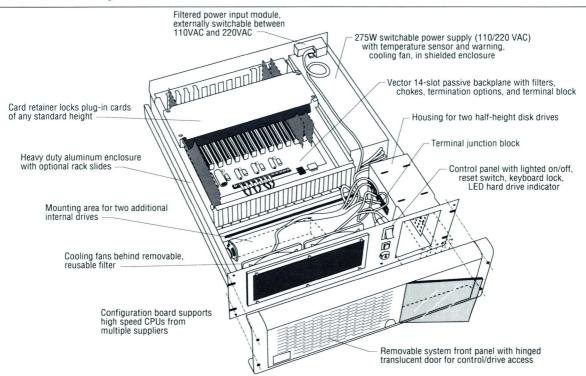
Voltage Input: 90-132 VAC,47-63 Hz 180-264 VA47-63 Hz Boards; Accepts 14 AT/XT boards, 8 full size, 6 half-size Operating Temperature: 0 to 122° F/-18 to 50° C

Humidity: 90% non-condensing

Power Supply: +5VDC at 35A +12 VDC at 5.0A (9.5A for 10 seconds)-12 VDC at 2.5A - 5 VDC at 1.8A

MTBF: 100,000 hours per MIL-STD HDBK-217D

Cooling: Two 90 cfm fans for card cage with removable, reuseable



Vector Electronic's 14-Slot AT Development System



Vectorbord® Patterns

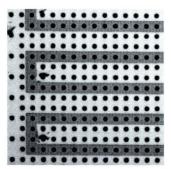
Bus Patterns:

Our boards are designed for optimum peformance and convenience. For most boards, voltage and ground buses (or voltage and ground planes) are incorporated into an overall circuit pattern. Other types of boards combine one or more circuit patterns with one of the bus designs described below. Still other boards are manufactured with buses only. That is, no etched circuit patterns are included, for maximum design flexibility.

All bus surfaces on Vectorbord Prototyping Boards are solder-plated copper. Vectorbord Bus Patterns include:

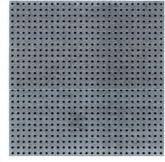
Interleaved Bus Pattern:

Interleaved bus lines originate at the I/O area and are traced, voltage and ground in opposite directions, along the board perimeter. Both buses then are interleaved, or alternated. across board surface. Voltage and ground signals can be accessed conveniently from any hole or solder pad in the signal area. Interleaved buses may be etched onto one side of board only, or onto both sides of board, back to back and with plated-thru holes.



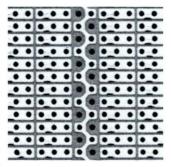
Peripheral Bus Pattern:

Voltage and ground bus lines trace a path around board perimeter. Peripheral buses may be on one side of board, or back-to-back on both board sides, with plated-thru holes.



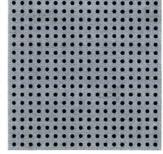
Zig-Zag Buses:

Zig-Zag Buses usually are interleaved across board surfaces. Unique shape (see photo) provides access to buses at alternating holes.



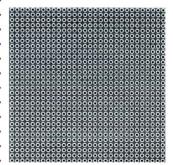
Contacts Only Pattern

For maximum flexibility, boards are bare except for edge connector contacts. Available for Vectorbord® Plugbords, with connector contacts committed for general purpose applications, or to bus specific specifications. Contacts Only boards provide unrestricted component placement and orientation, and accommodate both Wire Wrap and solder connectors.



Pad-Per-Hole Pattern:

Pad-Per-Hole Boards combine the convenience of solder mounting and the flexibility of bare board designs. The Pad-Per-Hole Pattern features isolated solder pads around all holes for convenient mounting of all types of DIPs and other components. Most Pad-Per-Hole boards have plated-thru copper holes. Pad-Per-Hole Boards also have peripheral voltage and ground buses. All pad and bus surfaces are solderplated for user convenience. Available for general purpose and bus specific applications. Wire Wrap socket pins and connectors are available separately.



Vectorbord® Patterns

3-Hole Solder Pad Pattern:

3-hole solder pads provide for convenient soldered jumper wire connections to IC leads and sockets, or axial-lead resistors and capacitors. Voltage and ground buses are interleaved between pad areas for overall accessibility. Board capacities can be maximized by mounting DIP IC sockets and other components over bus lines. Wire Wrap pins for 3-Hole Solder Pad Boards are available separately. All pad and bus surfaces are solder-coated for user convenience.

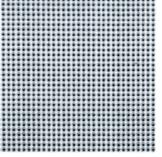
Selected 3-Hole Solder Pad Boards also come with Zig-Zag Buses, which provide access to positive or negative voltage at alternating hole positions.



Voltage/Ground Plane Pattern

Voltage/Ground Plane Prototyping Boards feature overall power and ground planes on opposite board sides. Holes are isolated from planes by 0.085" diameter clearance pads, both sides of board. Pins in all holes can be committed easily to either voltage or ground plane with solder washers, Vector Part No. T124, or connecting eyelets, Vector Part No. T123. Voltage/Ground Plane Boards are designed for optimum signal performance distributed capacitance. low inductance, low noise—and are ideal for DIP ICs, Wire Wrap posts, and socket pins.

For selected boards the Voltage/Ground Plane Pattern is combined with other patterns. An overall ground plane is etched onto one side of board only. Another Vectorbord Circuit Pattern is etched onto the other side of the board, or the other side is left bare. A ground plane on one side of board, formerly called Clearance Hole Ground Plane, is now called simply Ground Plane.

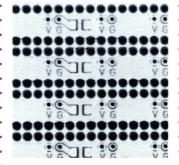


VECTORBORD plus™ Pattern

High performance prototyping boards—Vectorbord plus[™] boards incorporate many features of Voltage/ Ground Plane Boards, optimized for socket pins. Available in double-sided and multilayer designs, and with a wide range of available options. Full voltage and ground planes are on opposite board sides. Holes are 0.055" diameter on 0.1" grid, with 0.085" diameter clearance pad around holes on both sides.

The high density grid patterns provide for minimum wire lengths, maximum circuit performance. DIP mounting areas accept all standard lead spacings. Large PGA areas provide for mounting most PLCC and PGA devices.

Vectorbord plus™ boards also provide mounting positions for SMD decoupling capacitors (available factory-installed for most boards). Surface mounting allows components to straddle cap positions for increased package density and low board profiles. 0.042" diameter, precision-drilled and platedthru voltage and ground holes at each SMD cap position provide access to both planes for doublesided boards, and to multiple planes for multilayer boards.

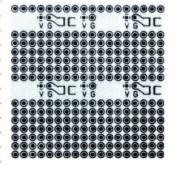


Pads & Planes™ Pattern

The Pads & Planes™
Pattern is designed for high
performance circuitry, unrestricted component placement, and for mixing Wire
Wrap and solder components on the same board.

Pads & Planes™ combines features of both Voltage/Ground Plane and Vectorbord plus™ patterns. Full voltage and ground planes are on opposite sides of board. Holes are 0.042" diameter, plated-thru on 0.1" grid with 0.080" diameter isolated solder pad around each hole, both sides. The overall hole pattern provides for mounting DIP IC devices, as well as PLCC and PGA devices.

Pads & Planes Boards also include mounting positions for surface mount decoupling capacitors. Surface mounting allows components to straddle cap positions for increased package density, low board profiles. Voltage and ground holes at each SMD cap position provide overall access to both planes. All pad and plane surfaces are solder coated for user convenience. SMD caps can be ordered factory-installed for most boards.





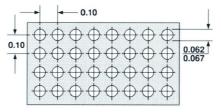
VECTORBORD® Prototyping Boards

Vectorbord ®
Prototyping Boards
with punched holes are
convenient, economical
tools for assembling
circuit components—
and cost efficient alternatives to custom
designs.

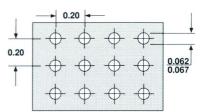
Available in several hole patterns for a full range of design needs, circuit speeds, component types and density. May be copper clad on one side. A complete line of accessory products also available, including eyelets, push-in (solderable or solderless), Wire Wrap and screw machine terminals for all Vectorbord ® Prototyping Boards.

Pattern	Part No.	Width	Longth	Thick	Hole	Material
Pattern	Part No.	wiatn	Length	Inick	Hole	матела
P	59P44-032	4.50	6.00	0.031	0.042	FR4 Epoxy Glass
P	64P44EP	4.50	6.50	0.062	0.042	FR3 Epoxy Paper
Р	64P44WE	4.50	6.50	0.062	0.042	FR4 Epoxy Glass
P	64P44XXXP	4.50	6.50	0.062	0.042	FR2 Phenolic
P	64P44	4.50	6.50	0.062	0.042	CEM-1 Epoxy Glass Composite
P	84P44WE	4.50	8.50	0.062	0.042	FR4 Epoxy Glass
Р	169P44C1	4.50	17.00	0.062	0.042	CEM-1 Epoxy Glass Composite
P	169P44C2	4.50	17.00	0.062	0.042	CEM-1 Epoxy Glass Composite
P	169P44	4.50	17.00	0.062	0.042	CEM-1 Epoxy Glass Composite
P	169P44XXXP	4.50	17.00	0.062	0.042	FR2 Phenolic
P	169P44WEC1	4.50	17.00	0.062	0.042	FR4 Epoxy Glass
P	169P44WE	4.50	17.00	0.062	0.042	FR4 Epoxy Glass
P	169P44EP	4.50	17.00	0.062	0.042	FR3 Epoxy Paper
P	169P47EP	4.80	17.00	0.062	0.042	FR3 Epoxy Paper
P	169P59-047	6.00	17.00	0.047	0.042	FR4 Epoxy Glass
P	169P59-032	6.00	17.00	0.031	0.042	FR4 Epoxy Glass
P	169P59C1	6.00	17.00	0.062	0.042	CEM-1 Epoxy Glass Composite
P	169P59XXXP	6.00	17.00	0.062	0.042	FR2 Phenolic
P	169P79WE	8.00	17.00	0.062	0.042	FR4 Epoxy Glass
P	169P79	8.00	17.00	0.062	0.042	CEM-1 Epoxy Glass Composite
P	169P84	8.50	17.00	0.062	0.042	CEM-1 Epoxy Glass Composite
P	169P84C1	8.50	17.00	0.062	0.042	CEM-1 Epoxy Glass Composite
P	169P84EP	8.50	17.00	0.062	0.042	FR3 Epoxy Paper
P	169P84WE	8.50	17.00	0.062	0.042	FR4 Epoxy Glass
P	169P84WEC1	8.50	17.00	0.062	0.042	FR4 Epoxy Glass
P	349P84	8.50	35.00	0.062	0.042	CEM-1 Epoxy Glass Composite
P	169P99	10.00	17.00	0.062	0.042	CEM-1 Epoxy Glass Composite
G	42G22WEC1	4.50	8.50	0.062	0.062	CEM-1 Epoxy Glass Composite
G	42G24WE	4.80	8.50	0.062	0.062	CEM-1 Epoxy Glass Composite
G	85G24EP	4.80	17.00	0.062	0.062	FR3 Epoxy Paper
G	85G24WE	4.80	17.00	0.062	0.062	CEM-1 Epoxy Glass Composite
G	85G42EP	8.50	17.00	0.062	0.062	FR3 Epoxy Paper
G	85G42WE	8.50	17.00	0.062	0.062	FR4 Epoxy Glass
H	85H48WE	4.80	8.50	0.062	0.062	FR4 Epoxy Glass
Н	170H48WE	4.80	17.00	0.062	0.062	FR4 Epoxy Glass
H	85H85WE	8.50	8.50	0.062	0.062	FR4 Epoxy Glass
H	170H85WE	8.50	17.00	0.062	0.062	FR4 Epoxy Glass
F	85F24EP	4.80	17.00	0.062	0.062	FR3 Epoxy Paper
F F	85F42WEC1	8.50	17.00	0.062	0.062	CEM-1 Epoxy Glass Composite
E	175F99WE	20.00	35.00	0.062	0.062	FR4 Epoxy Glass

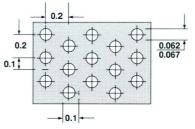
PATTERN H



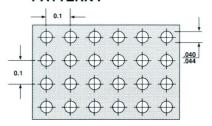
PATTERN F



PATTERN G



PATTERN P



C1 = copper-cald one side

C2 = copper-clad both sides



Vector's Most Functional Circuit Patterns and Provisions for Adding I/O Connectors

Vectorbord ® Printed Circuit Prototyping Boards cover a wide range of development requirements—without the expense of edge connectors.

Vector makes a Printed Circuit Prototyping Board for virtually any application—including those requiring high component densities and solder or Wire Wrap connections. All boards are manufactured to precision standards and specifications. All bus and circuit patterns are solder-coated for user convenience.

Common Features Include:

- 0.042" diameter holes on 0.1" grid
- Flame retardant, epoxy glass or epoxy glass composite materials
- Complete selection of terminals, accessories and tools available.

3.5" x 11.5"

8009: Pad-Per-Hole

With Precision-Drilled, Plated-Thru Holes

- 0.042" diameter holes on 0.1" grid
- 0.080" diameter, isolated solder,pad around each hole
- Unrestricted component placement
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- Board size and surface area approximate IBM PS/2 specifications

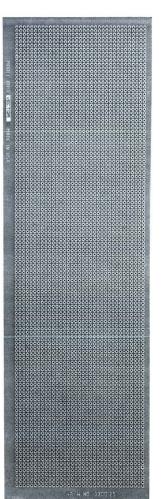


4.0" x 13"

8010: Pad-Per-Hole

With Precision-Drilled, Plated-Thru Holes

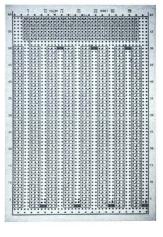
- 0.042" diameter holes on 0.1" grid
- 0.080" diameter, isolated solder pad around each hole
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- Unrestricted component placement
- Board size and surface area approximate Macintosh II specifications



4.5" x 6.5"

8001: 3-Hole Solder Pad

- 0.042" diameter holes on 0.1" grid
- Circuit pattern etched onto wiring side only
- Solder mount DIP sockets or IC devices with any width lead spacing
- Capacity for mounting up to 20, 16-pin DIP devices
- 3-hole solder pads (0.28" x 0.080") for interconnecting multiple component leads
- All pad and bus surfaces solder-coated for user convenience



Part No.	Width	Height	Thick	Hole	16-Pin	Material	Circuit Pattern	Wire	Wrap
				Dia.	DIP Capacity			Terminals	Socket Pins
8009	11.50	3.50	0.062	0.042	94	FR4 Epoxy Glass	Pad-Per-Hole	T125, T126	R32
8010	12.86	4.00	0.062	0.042	124	FR4 Epoxy Glass	Pad-Per-Hole	T125, T126	R32
8001	6.50	4.50	0.062	0.042	20	CEM-1 Epoxy Glass Composite	3-Hole Solder Pad	T125, T126	R32



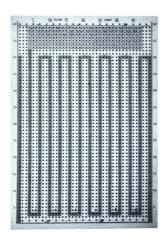
Printed Circuit Prototyping Boards (Circbords®)

VECTORBORD®

4.5" x 6.5"

8002: Interleaved Buses

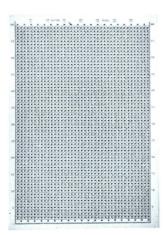
- 0.042" diameter holes on 0.1" grid
- Ideal for Wire Wrap applications
- Power and ground buses etched onto wiring side only
- Bus surfaces soldercoated for user convenience
- Mount components with 0.3", 0.6" and 0.9" lead spacing
- Accommodates up to 36, 16-pin DIP IC devices
- I/O area with solder pads for mounting connector
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately



4.5" x 6.5"

8003: Pad-Per-Hole

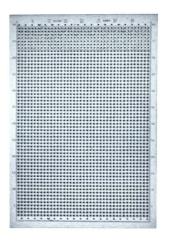
- 0.042" diameter holes on 0.1" grid
- Square solder pad etched around each hole on wiring side
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- Mount up to 60, 16-pin DIP IC devices
- Accommodates any type DIP IC device or discrete component



4.5" x 6.5"

8004: Ground Plane

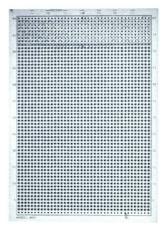
- 0.042" diameter holes on 0.1" grid
- 0.085" diameter clearance areas around holes
- Etched overall ground plane on wiring side only
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- To commit Wire Wrap pins to voltage and ground planes, use Vector T124 solder washers, available separately
- Plane surface soldercoated for user convenience
- Accommodates up to 50, 16-pin DIP IC devices
- I/O area with solder pads for mounting connector



4.5" x 6.5"

8007: Pad-Per-Hole/ Ground Plane

- 0.042" diameter holes on 0.1" grid
- Pad-Per-Hole Pattern on component side—overall Ground Plane Pattern on wiring side
- 0.080" diameter, isolated solder pad around holes, component side
- 0.085" diameter clearance areas isolate holes from ground plane, wiring side
- Plane and pad surfaces solder-coated for user convenience
- Accommodates any type DIP IC device or discrete component
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- To commit Wire Wrap pins to ground plane, use Vector T124 solder washers, available separately



Part No.	Width	Height	Thick	Hole	16-Pin	Material Circ	rcuit Pattern	Wire	Wrap
				Dia.	DIP Capacity			Terminals	Socket Pins
8002	6.50	4.50	0.062	0.042	36	CEM-1 Epoxy Glass Composite Interle	leaved Buses	T125, T126	R32
3003	6.50	4.50	0.062	0.042	60	CEM-1 Epoxy Glass Composite Pad-I	Per-Hole	T125, T126	R32
3004	6.50	4.50	0.062	0.042	50	CEM-1 Epoxy Glass Composite Groun	ind Plane	T125, T126	R32
8007	6.50	4.50	0.062	0.042	60	CEM-1 Epoxy Glass Composite Pad-F	Per-Hole/Ground Plane	T125, T126	R32

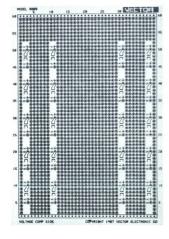


4.5" x 6.5"

8008: Pads & PlanesTM

Unique Circuit Pattern Features Full Voltage and Ground Planes With Isolated, Plated-Thru Holes, and Positions for Mounting SMD Capacitors

- 0.042" diameter holes on 0.1" grid
- 0.080" diameter, isolated solder pad around each hole, both sides
- Massive overall voltage and ground planes on opposite board sides for controlled impedance
- Plane surfaces are solder coated for user convenience
- SMD cap positions for discrete decoupling capacitors
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately



4.5" x 8.08"

3677-6: 3-Hole Solder Pad

- 0.042" diameter holes on 0.1" grid
- Etched circuit pattern on wiring side only
- 3-hole solder pads (0.28" x 0.080") for interconnecting multiple component leads
- Pad and bus surfaces solder-coated for user convenience
- Bus outlines traced on component side to facilitate component placement
- Mount up to 21, 16-pin DIP IC devices
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately



4.5" x 8.08"

45P80-1: Pad-Per-Hole

- 0.042" diameter holes on 0.1" grid
- 0.080" diameter, isolated solder pad around holes, both sides
- Capacity for mounting 80, 16-pin DIP IC devices
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately



4.5" x 9.6"

8011: Pad-Per-Hole

With Precision-Drilled, Plated-Thru Holes

- 0.042" diameter holes on 0.1" grid
- 0.080" diameter, isolated solder pad around holes, both sides
- Capacity for mounting 103, 16-pin DIP IC devices
- Unrestricted component placement, extended area for high density applications.
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately



Part No.	Width	Height	Thick	Hole	16-Pin	Material	Circuit Pattern	Wire	Wrap
				Dia.	DIP Capacity			Terminals	Socket Pins
8008	6.50	4.50	0.062	0.042	70	FR4 Epoxy Glass	Pads & Planes	T125, T126	R32
3677-6	8.08	4.50	0.062	0.042	21	CEM-1 Epoxy Glass Composite	3-Hole Solder Pad	T125, T126	R32
45P80-1	8.08	4.50	0.062	0.042	80	CEM-1 Epoxy Glass Composite	3-Hole Solder Pad	T125, T126	R32
8011	9.60	4.50	0.062	0.042	103	FR4 Epoxy Glass	Pad-Per-Hole	T125, T126	R32



5.0" x 13.25"

8006: Pad-Per-Hole

With Precision-Drilled, Plated-Thru Holes

- 0.042" diameter holes on 0.1" grid
- 0.080" diameter, isolated solder pad around each hole, both sides
- Unrestricted component placement, extended area for high density applications
- Capacity for mounting up to 154, 16-pin DIP IC devices
- Board can be cut down into smaller units
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately



9.2" x 11"

8012: Pad-Per-Hole

Approximates Eurocard (DIN) Specifications: 6U x 280mm, Can Be Sheared Down to 6U x 220mm, or 160mm

- 0.042" diameter holes on 0.1" grid
- 0.080" diameter, isolated solder pad around holes, both sides
- Unrestricted component placement over entire board surface
- Capacity for mounting 283, 16-pin DIP IC devices
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately



10.6" x 10.6"

106P106-1: Pad-Per-Hole

- 0.042" diameter holes on 0.1" grid
- 0.080" diameter, isolated solder pad around each hole, both sides
- Square solder pad around each hole, both sides of board
- Capacity for mounting up to 275, 16-pin DIP IC devices
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately



Part No.	Width	Height	Thick	Hole	16-Pin	Material	Circuit Pattern	Wire	Wrap
				Dia.	DIP Capacity			Terminals	Socket Pins
8006	13.25	5.00	0.062	0.042	154	FR4 Epoxy Glass	Pad-Per-Hole	T125, T126	R32
8012	11.00	9.20	0.062	0.042	283	FR4 Epoxy Glass	Pad-Per-Hole	T125, T126	R32
106P106-1	10.60	10.60	0.062	0.042	275	CEM-1 Epoxy Glass Composite	Pad-Per-Hole	T125, T126	R32



Vectorbord®
Plugbords,™
Featuring GoldPlated Edge
Connectors and
0.042" Diameter
Holes on 0.1" Grids*

Streamline prototyping activities with Vectorbord ® General Purpose Plugbords™. All General Purpose Plugbords™ are made of flame-retardant, epoxy glass or epoxy glass composite materials and are built to precise specifications for secure solder or Wire Wrap connections.

Many optional sizes, models and etched circuit patterns are available.

Vector also supplies a full line of accessories which include: extender cards; solder and Wire Wrap terminals; pins; DIP and PGA sockets; socket pins; mating receptacles; cases; and card cages.

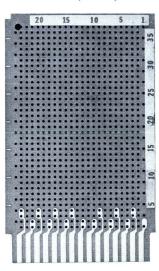
All Vectorbord [®] Plugbords[™] are supplied with layout sheets and comprehensive instructions to facilitate design and assembly activities.

838 Series boards are designed for transistors. Holes are 0.062" diameter holes positioned at alternating intersections of 0.1" grid.

2.73" x 4.5"

3797: Contacts Only

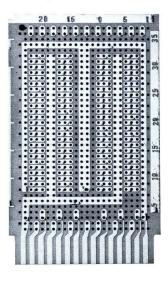
- 0.042" diameter holes on 0.1" grid
- 30 edge contacts: 15 per side on 0.156" centers, nickel/gold plated
- Unrestricted component placement over entire board surface
- Accepts virtually any discrete component
- Capacity for mounting 15, 16-pin DIP IC devices
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately



2.73" x 4.5"

3797-2: 3-Hole Solder Pad

- 0.042" diameter holes on 0.1" grid
- 30 edge contacts: 15 per side on 0.156" centers, nickel/gold plated
- 3-hole solder pads (0.28" x 0.080") for interconnecting multiple component leads
- All pad and bus surfaces solder-coated for user convenience
- Convenient, easy-to-read hole marking legend on wiring side



Part No.	Width		Spac- N		Hole Dia.	16-Pin DIP Capacity	Material	Circuit Pattern	Solder Connector	Wire Wrap Connector	Extender	Recommended Card Cage	Wire Wi Terminals Sc	
3797 3797-2	4.50 4.50	2.73 2.73	0.156 0.156	30 0.062 30 0.062			CEM-1 Epoxy Glass Composite CEM-1 Epoxy Glass Composite		R630 d R630	±	3690-10 3690-10	Series 12 Series 12		R32 R32



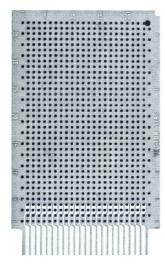
Plugbord™ Prototyping Boards, General Purpose 44 Contacts

VECTORBORD®

2.73" x 4.5"

3795: Contacts Only

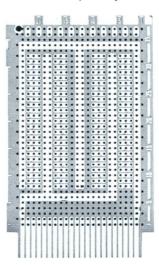
- 0.042" diameter holes on 0.1" grid
- 44 edge contacts: 22 per side on 0.1" centers, nickel/gold-plated
- Unrestricted component placement over entire board surface
- Capacity for mounting 15, 16-pin DIP IC devices
- Accepts virtually any type of component
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately



2.73" x 4.5"

3795-1: 3-Hole Solder Pad

- 0.042" diameter holes on 0.1" grid
- 44 edge contacts: 22 per side on 0.1" centers, nickel/gold-plated
- 3-hole solder pads (0.28" x 0.080") for interconnecting multiple component leads
- Pad and bus surfaces solder-coated for user convenience
- Convenient, easy-to-read hole marking legend on wiring side
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately



4.5" x 4.5"

3662-5: Contacts Only

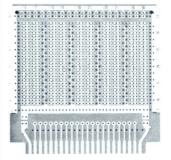
- 0.042" diameter holes on 0.1" grid
- 44 edge contacts: 22 per side on 0.156" centers, nickel/gold-plated
- 22 numbered edge contacts on front side; 21 plus grounding contact on reverse side
- Bare board provides for unrestricted component placement over entire board surface
- Hole marking legend on both sides of board
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately



4.5" x 4.5"

4112-5: Ground Plane/3-Hole Solder Pad (With Zig-Zag Buses)

- 0.042" diameter holes on 0.1" grid
- 44 edge contacts: 22 per side 0.156" centers, nickel/gold plated
- 3-Hole Solder Pad Pattern on wiring side; Ground Plane on component side with 0.085" diameter, clearance areas around holes
- 3-hole solder pads (0.28" x 0.080") for interconnecting multiple component leads
- Area at top end has solder pads around holes for test points, LEDs, and other devices
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- To commit Wire Wrap pins to ground planes, use Vector T124 solder washers, available separately



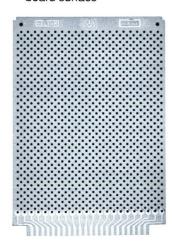
Part No.	Width	Height	Contac Spac- ing			Dia.	16-Pir DIP Capacit		Circuit Pattern	Solder Connector	Wire Wrap Connector	Extender	Recommended Card Cage	d Wire Wrap Terminals Socket Pins
3795	4.50	2.73	0.100	44	0.062	0.042	15	CEM-1 Epoxy Glass Composite	Contacts Only	-	R644-2	3690-8	Series 12	T125, T126 R32
3795-1	4.50	2.73	0.100	44	0.062	0.042	4	CEM-1 Epoxy Glass Composite	3-Hole Solder Pa	ad -	R644-2	3690-8	Series 12	T125, T126 R32
3662-5	4.50	4.50	0.156	44	0.062	0.042	40	CEM-1 Epoxy Glass Composite	Contacts Only	R644	R644-3	3690	Series 13	T125, T126 R32
4112-5	4.50	4.50	0.156	44	0.062	0.042	8	CEM-1 Epoxy Glass Composite	3-Hole Solder Pa	ad R644	R644-3	3690	Series 13	T125, T126 R32



4.5" x 6.5"

838WE: Contacts Only

- 0.062" diameter holes positioned at alternating intersections of 0.1" grid— See G Pattern
- Designed for mounting transistors
- 44 edge contacts: 22 per side on 0.156" centers, tin alloy plated
- Unrestricted component placement over entire board surface



4.5" x 6.5"

838WE1GN: Contacts Only

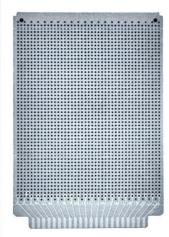
- 0.062" diameter holes positioned at alternating intersections of 0.1" grid
- 44 edge contacts: 22 per side on 0.156" centers, nickel/ gold-plated
- Designed for mounting transistors
- Unrestricted component placement over entire board surface



4.5" x 6.5"

3662: Contacts Only

- 0.042" diameter holes on 0.1" grid
- Unrestricted component placement over entire board surface
- Capacity for mounting 50, 16-pin DIP IC devices
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately



4.5" x 6.5"

3662A6: Ground Plane

- 0.042" diameter holes on 0.1" grid
- 0.085" diameter clearance area around holes
- Ground plane on component side; wiring side has contacts only
- Plane surface is soldercoated for user convenience
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- To commit Wire Wrap pins to ground planes, use Vector T124 solder washers, available separately



Part No.	Width	Height	Co Spac-	ntacts Num-	Thick	Hole Dia.	16-Pin DIP	Material	Circuit Pattern		Wire Wrap Connector		Recommended Card Cage	Wire Terminals	Wrap Socket Pins
			ing	ber			Capacit	у							
838WE	6.50	4.50	0.156	44	0.062	0.062	-	CEM-1 Epoxy Glass Composite	Contacts Only	y R644	R644-3	3690	Series 13	T125,T126	R32
838WE1GN	6.50	4.50	0.156	44	0.062	0.062	-	FR4 Epoxy Glass	Contacts Only	y R644	R644-3	3690	Series 13	T125, T126	R32
3662	6.50	4.50	0.156	44	0.062	0.042	50	CEM-1 Epoxy Glass Composite	Contacts Only	y R644	R644-3	3690	Series 13	T125,T126	R32
3662A6	6.50	4.50	0.156	44	0.062	0.042	90	CEM-1 Epoxy Glass Composite	Ground Plane	R644	R644-3	3690	Series 13	T125.T126	R32



Plugbord™ Prototyping Boards, General Purpose 44 Contacts

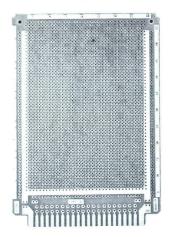
VECTORBORD®

4.5" x 6.5"

3662-9: Pad-Per-Hole

With Precision-Drilled, Plated-Thru Holes

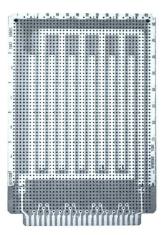
- 0.042" diameter holes on 0.1" grid
- 0.080" diameter, isolated solder pad around holes, both sides
- Capacity for mounting 48, 16-pin DIP IC devices
- Pad and bus surfaces solder-coated for quick, convenient soldering
- Convenient, easy-to-read hole marking legend provided
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately



4.5" x 6.5"

3682-2: Interleaved Buses

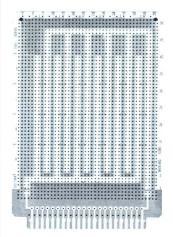
- 0.042" diameter holes on 0.1" grid
- Bus pattern on wiring side, solder-coated for user convenience
- Bus outline traced on component side to facilitate component placement
- Capacity for mounting 24, 16-pin DIP IC devices
- Mounts DIPs with 0.3", 0.4" and 0.9" lead spacing
- Unclad test point area at top of board
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately



4.5" x 6.5"

3682-4: Interleaved Power Bus/Ground Plane

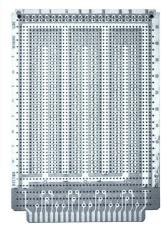
- 0.042" diameter holes on 0.1" grid
- Power bus in rows across component side; overall ground plane on wiring side
- 0.085" etched clearance area around each hole on ground plane side
- Bus and plane surfaces solder coated for user convenience
- Capacity for mounting 24, 16-pin DIP IC devices
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- To commit Wire Wrap pins to ground planes, use Vector T124 solder washers, available separately



4.5" x 6.5"

3677-2: 3-Hole Solder Pad

- 0.042" diameter holes on 0.1" grid
- 3-hole solder pads (0.28" x 0.080") for interconnecting multiple component leads
- Voltage/ground buses interleaved between pad areas on wiring side
- Pad and bus surfaces solder-coated for user convenience
- Test point area, with solder pads around holes, provided along back edge of board
- Convenient, easy-to-read hole marking legend provided



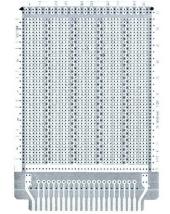
Part No.	Width	Height	Con Spac-	tacts	Thick	Hole Dia.	16-Pin DIP	n Material	Circuit Pattern		Wire Wrap Connector		Recommende Card Cage	d Wire Wra Terminals Soc	
			ing	ber			Capacit	tv		00111100101	00111100101		oura ougo	TOTTIMI COO	
			9				- apao.	9							
3662-9	6.50	4.50	0.156	44	0.062	0.042	48	FR4 Epoxy Glass	Pad-Per-Hole	R644	R644-3	3690	Series 13	T125, T126	R32
3682-2	6.50	4.50	0.156	44	0.062	0.042	24	CEM-1 Epoxy Glass Composite	Interleaved Buses	R644	R644-3	3690	Series 13	T125, T126	R32
3682-4	6.50	4.50	0.156	44	0.062			CEM-1 Epoxy Glass Composite		e R644	R644-3	3690	Series 13	T125, T126	R32
3677-2	6.50	4.50	0.156	44	0.062			CEM-1 Enoxy Glass Composite		B644	B644-3	3690	Spring 13	T125 T126	B32



4.5" x 6.5"

4112-4: 3-Hole Solder Pad (With Zig-Zag Buses)

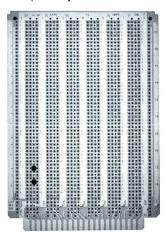
- 0.042" diameter holes on 0.1" grid
- Continuous ground plane on component side with 0.085" clearance pad around each hole
- 3-hole solder pads (0.28" x 0.080") for interconnecting multiple component leads
- Bus, plane, and pad surfaces solder-coated for user convenience
- Unclad area at top end for test points, LEDs, and other components
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- To commit Wire Wrap pins to ground planes, use Vector T124 solder washers, available separately



4.5" x 6.5"

4494: Voltage/Ground Plane

- 0.042" diameter holes on 0.1" grid
- Voltage/ground planes on opposite board sides
- 0.085" diameter clearance area around each hole, both sides of board
- Plane surfaces soldercoated for user convenience
- Circuit pattern provides for mounting DIP IC devices with leads on 0.3", 0.4", 0.6" or 0.9" centers combined with other discrete components
- Capacity for mounting 42, 16-pin DIP IC devices
- Convenient, easy-to-read hole marking legend provided
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- To commit Wire Wrap pins to voltage and ground planes, use Vector T124 solder washers, available separately



4.5" x 9.6"

3662-2: Contacts Only

- 0.042" diameter holes on 0.1" grid
- Unrestricted component placement over entire board surface
- Capacity for mounting 90, 16-pin DIP IC devices
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately



4.5" x 9.6"

3677: 3-Hole Solder Pad

- 0.042" diameter holes on 0.1" grid
- 3-hole solder pads (0.28" x 0.080") for interconnecting multiple component leads
- Pad and bus surfaces solder-coated for user convenience
- Unclad test point area provided along top edge of board
- Capacity for mounting 21, 16-pin DIP IC devices
- Convenient, easy-to-read hole marking legend provided
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately

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Part No.	Width	Height	Con	tacts	Thick	Hole	16-Pin	Material	Circuit Pattern	Solder	Wire Wrap	Extender	Recommended	Wire	e Wrap
			Spac-	Num-		Dia.	DIP			Connector	Connector		Card Cage	Terminals	Socket Pins
			ing	ber		C	apaci	ty							
4112-4	6.50	4.50	0.156	44	0.062	0.042	25	CEM-1 Epoxy Glass Composite	3-Hole Solder Pad	R644	R644-3	3690	Series 13	T125, T126	R32
4494	6.50	4.50	0.156	44	0.062	0.042	42	CEM-1 Epoxy Glass Composite	Voltage/Ground Plane	s R644	R644-3	3690	Series 13	T125, T126	R32
3662-2	9.60	4.50	0.156	44	0.062	0.042	90	CEM-1 Epoxy Glass Composite	Contacts Only	R644	R644-3	3690-6	Series 14	T125, T126	R32
3677	9.60	4.50	0.156	44	0.062	0.042	21	CEM-1 Epoxy Glass Composite	3-Hole Solder Pad	R644	R644-3	3690-6	Series 14	T125, T126	R32



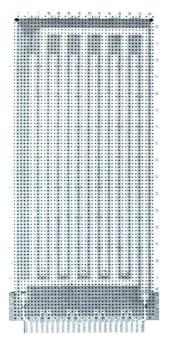
Plugbord™ Prototyping Boards, General Purpose 44 Contacts

VECTORBORD®

4.5" x 9.6"

3682: Interleaved Buses

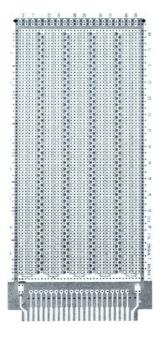
- 0.042" diameter holes on 0.1" grid
- Etched bus pattern on wiring side, solder-coated for user convenience
- Bus outlines traced on component side
- Capacity for mounting 48, 16-pin DIP IC devices
- Mounts DIPs with 0.3", 0.4" and 0.9" lead spacings
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately



4.5" x 9.6"

4112: 3-Hole Solder Pad (With Zig-Zag Buses)

- 0.042" diameter holes on 0.1" grid
- Zig-zag bus pattern on wiring side provides access to voltage or ground at alternating hole positions
- 3-hole solder pads (0.28" x 0.080") for interconnecting multiple component leads
- Continuous ground plane on component side with 0.085" etched clearance area around each hole
- Bus, pad, and plane surfaces are soldercoated for user convenience
- Unclad area at top end for test points, LEDs, and other components
- To commit Wire Wrap pins to ground planes, use Vector T124 solder washers, available separately



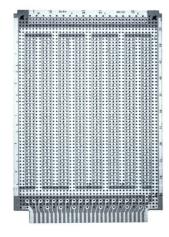
Part No.	Width	Height	Con	tacts	Thick	Hole	16-Pin	Material	Circuit Pattern	Solder	Wire Wrap	Extender	Recommended	Wire	Vrap
			Spac-	Num-		Dia.	DIP			Connector			Card Cage	Terminals	Socket Pins
			ing	ber		(Capacit	ty							
3682	9.60	4.50	0.156	44	0.062	0.042	48	CEM-1 Epoxy Glass Composite	Interleaved Buses	R644	R644-3	3690-6	Series 13	T125, T126	R32
4112	9.60	4.50	0.156	44	0.062	0.042	40	CEM-1 Epoxy Glass Composite	3-Hole Solder Pad	R644	R644-3	3690-6	Series 13	T125, T126	R32



4.5" x 6.5"

4610: 3-Hole Solder Pad

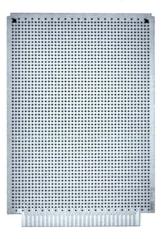
- 0.042" diameter holes on 0.1" grid
- Circuit pattern on wiring side only; component side has contacts only
- 3-hole solder pads (0.28" x 0.080") for interconnecting multiple component leads
- Pads on top of board accommodate ribbon cable I/O connector
- Pad and bus surfaces solder-coated for user convenience
- Capacity for mounting 20, 16-pin DIP IC devices
- Designed to STD Bus specifications: 5 volt bus terminates to pins 1 and 2; ground bus terminates to pins 3 and 4
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately



4.5" x 6.5"

4610-1: Contacts Only

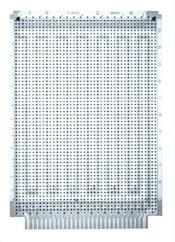
- 0.042" diameter holes on 0.1" grid
- Unrestricted component placement over entire board surface
- Capacity for mounting 59, 16-pin DIP IC devices
- Designed to STD Bus specifications: 5 volt bus terminates to pins 1 and 2; ground bus terminates to pins 3 and 4
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately



4.5" x 6.5"

4610-2: Interleaved Buses

- 0.042" diameter holes on 0.1" grid
- Bus pattern on wiring side, solder-coated for user convenience
- Pads at top of board accommodate ribbon cable I/O connector
- Capacity for mounting 35, 16-pin DIP IC devices
- Designed to STD Bus specifications: 5 volt bus terminates to pins 1 and 2; ground bus terminates to pins 3 and 4
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately

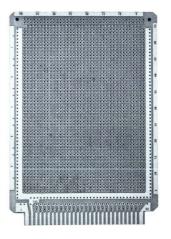


4.5" x 6.5"

4610-3: Pad-Per-Hole

With Precision-Drilled, Plated-Thru Holes

- 0.042" diameter holes on 0.1" grid
- 0.085" diameter, etched clearance pad around holes, both sides
- Peripheral bus pattern connected to edge contacts
- Pad and bus surfaces solder-coated for user convenience
- Capacity for mounting 52, 16-pin DIP IC devices
- Pads at top of board accommodate ribbon cable I/O connector
- Designed to STD Bus specifications: 5 volt bus terminates to pins 1 and 2; ground bus terminates to pins 3 and 4
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately



Part No.	Width	Height	Cont	acts	Thick	Hole	16-Pin	Material	Circuit Pattern	Solder	Wire Wrap	Extender	Recommended	Wire	Wrap
			Spac-	Num-		Dia.	DIP			Connector	Connector		Card Cage	Terminals	Socket Pins
			ing	ber		(Capacit	У							
4610	6.50	4.50	0.125	56	0.062	0.042	20	CEM-1 Epoxy Glass Composite	3-Hole Solder Pad	R656-1	R656	3690-16	Series 13	T125, T126	R32
4610-1	6.50	4.50	0.125	56	0.062	0.042	59	CEM-1 Epoxy Glass Composite	Contacts Only	R656-1	R656	3690-16	Series 13	T125, T126	R32
4610-2	6.50	4.50	0.125	56	0.062	0.042	35	CEM-1 Epoxy Glass Composite	Interleaved Buses	R656-1	R656	3690-16	Series 13	T125, T126	R32
4610-3	6.50	4.50	0.125	56	0.062	0.042	52	FR4 Epoxy Glass	Pad-Per-Hole	R656-1	R656	3690-16	Series 13	T125, T126	R32



Plugbord™ Prototyping Boards, General Purpose 72 Contacts

VECTORBORD®

4.5" x 4.5"

3719-5: Contacts Only

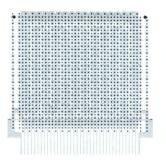
- 0.042" diameter holes on 0.1" grid
- Unrestricted component placement over entire board surface
- Convenient, easy-to-read hole marking legend on board surface
- Capacity for mounting 30, 16-pin DIP IC devices
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately



4.5" x 4.5"

4066-5: Ground Plane/ Interleaved Buses

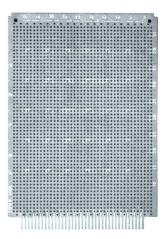
- 0.042" diameter holes on 0.1" grid
- 0.085" etched clearance area around each hole on ground plane side
- Overall ground plane on wiring side; etched zig-zag buses on component side provide three bus lines for ECL logic
- Bus and plane surfaces solder-coated for user convenience
- Capacity for mounting 18, 16-pin DIP IC devices
- Accommodates any component with 0.3", 0.6", or 0.9" lead spacing
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- To commit Wire Wrap pins to ground planes, use Vector T124 solder washers, available separately



4.5" x 6.5"

3719-1: Contacts Only

- 0.042" diameter holes on 0.1" grid
- Unrestricted component placement over entire board surface
- Capacity for mounting 50, 16-pin DIP IC devices
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately

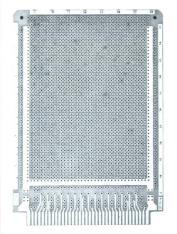


4.5" x 6.5"

3719-6: Pad-Per-Hole

With Precision-Drilled, Plated-Thru Holes

- 0.042" diameter holes on 0.1" grid
- 0.080" diameter, isolated solder pad around holes, both sides
- Low resistance, etched peripheral bus pattern
- Pad and bus surfaces solder-coated for user convenience
- Capacity for mounting 40, 16-pin DIP IC devices
- Convenient, easy-to-read hole marking legend on board surface
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately



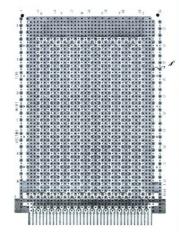
Part No.	Width	Height	Cont Spac-	tacts Num-		Hole Dia.	16-Pir DIP	Material Material	Circuit Pattern		Wire Wrap Connector		Recommende Card Cage	d Wire W Terminals S	
			ing	ber			Capaci	ty					-		
3719-5	4.50	4.50	0.100	72	0.062	0.042	30	CEM-1 Epoxy GlassComposite	Contacts Only	R636-2	R636-1	3690-4	Series.12	T125, T126	R32
4066-5	4.50	4.50	0.100	72	0.062	0.042	18	CEM-1 Epoxy Glass Composite	Ground Plane/Interleaved Buses	s R636-2	R636-1	3690-4	Series 12	T125, T126	R32
3719-1	6.50	4.50	0.100	72	0.062	0.042	50	CEM-1 Epoxy Glass Composite	Contacts Only	R636-2	R636-1	3690-4	Series 13	T125, T126	R32
3719-6	6.50	4.50	0.100	72	0.062	0.042	40	FR4 Epoxy Glass	Pad-Per-Hole	R636-2	R636-1	3690-4	Series 13	T125, T126	R32



4.5" x 6.5"

4066-4: Ground Plane/ Interleaved Buses

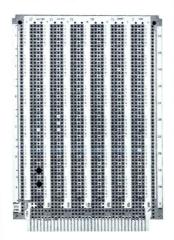
- 0.042" diameter holes on 0.1" grid
- Overall ground plane on wiring side; etched, interleaved zig-zag bus pattern on component side provides three bus lines for ECL logic
- 0.085" etched clearance area around each hole on ground plane side
- Bus and plane surfaces solder-coated for user convenience
- Capacity for mounting 34, 16-pin DIP IC devices
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- To commit Wire Wrap pins to ground planes, use Vector T124 solder washers, available separately



4.5" x 6.5"

4493: Voltage/Ground Plane

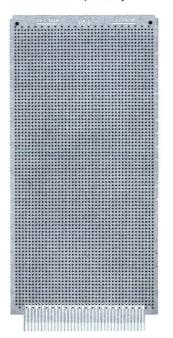
- 0.042" diameter holes on 0.1" grid
- Voltage/ground planes on opposite board sides
- 0.085" diameter clearance areas around holes, both sides
- Plane surfaces soldercoated for user convenience
- Circuit pattern provides for mounting of DIP IC or other devices with leads on 0.3", 0.4", 0.6" or 0.9" centers and for combining with other discrete components
- Capacity for mounting 42, 16-pin DIP IC devices
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- To commit Wire Wrap pins to voltage and ground planes, use Vector T124 solder washers, available separately



4.5" by 9.6"

3719-4: Contacts Only

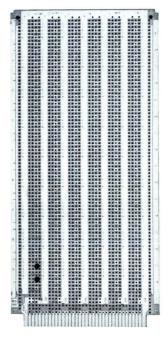
- 0.042" diameter holes on 0.1" grid
- Unrestricted component placement over entire board surface
- Capacity for mounting 90, 16-pin DIP IC devices
- Convenient, easy-to-read hole marking legend provided
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately



4.5" by 9.6"

4493-1: Voltage/Ground Plane

- 0.042" diameter holes on 0.1" grid
- Voltage/ground planes on opposite board sides
- 0.085" diameter clearance areas around holes, both sides
- Plane surfaces soldercoated for user convenience
- Capacity for mounting 63, 16-pin DIP IC devices
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- To commit Wire Wrap pins to voltage and ground planes, use Vector T124 solder washers, available separately



Part No.	Width	Height		tacts Num-	Thick	Hole Dia.	16-Pin DIP	Material	Circuit Pattern		Wire Wrap		Recommende Card Cage	ed Wire Wra Terminals Sock	
			ing	ber		(Capacity						· ·		
4066-4	6.50	4.50	0.100	72	0.062	0.042	34 CEM	-1 Epoxy Glass Composite	Ground Plane/Interleaved Buses	s R636-2	R636-1	3690-4	Series 13	T125, T126	R32
4493	6.50	4.50	0.100	72	0.062	0.042	42 CEM	-1 Epoxy Glass Composite	Voltage/Ground Planes	R636-2	R636-1	3690-4	Series 13	T125, T126	R32
3719-4	9.60	4.50	0.100	72	0.062	0.042	90 CEM	-1 Epoxy Glass Composite	Contacts Only	R636-2	R636-1	3690-2	Series 14	T125, T126	R32
4493-1	9 60	4.50	0.100					-1 Fpoxy Glass Composite		B636-2	B636-1	3690-2	Series 14	T125, T126	R32



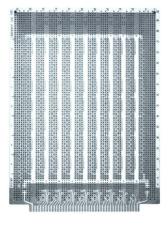
Plugbord™ Prototyping Boards, General Purpose 80 Contacts

VECTORBORD®

7.0" x 9.6"

4350: Zig-Zag Buses

- 0.042" diameter holes on 0.1" grid
- 0.085" diameter clearance area around holes, both sides
- Voltage and ground buses on opposite board sides, solder-coated for user convenience
- Zig-zag buses: pins, terminals, or wires contact either voltage or ground at each hole
- Unclad, punched area for I/O connectors, test points and other devices
- Mount decoupling capacitors at any DIP position
- Capacity for mounting 63, 16-pin DIP IC devices
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- To commit Wire Wrap pins to voltage and ground planes, use Vector T124 solder washers, available separately



8.0" x 9.6"

3673: Contacts Only

- 0.042" diameter holes on 0.1" grid
- Ideal size for applications requiring high component densities
- Unrestricted component placement over entire board surface
- Capacity for mounting 152, 16-pin DIP IC devices
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately



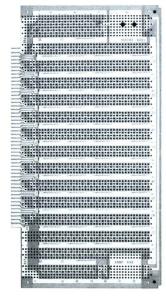
Part No.	Width	Height	Con Spac- ing	Thick	Dia.	16-Pir DIP Capaci		Circuit Pattern		Wire Wrap Connector		Recommended Card Cage		Wrap Socket Pins
4350 3673	9.60 9.60						CEM-1 Epoxy Glass Composite FR4 Epoxy Glass	Voltage/Ground Planes Contacts Only	R680-2 R680-2	R680-1 R680	3690-14 3690-14	Series17 Series17	T125, T126 T125, T126	



10.0" x 5.3"

8800V: Voltage/Ground Planes

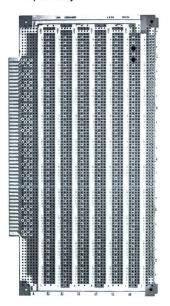
- 0.042" diameter holes on 0.1" grid
- 0.085" diameter clearance area around holes, both sides
- Full voltage and ground planes on opposite board sides
- Mounting holes for heat sink and voltage regulator provided
- Designed to S100 (IEEE 696) specifications
- Capacity for mounting 52, 16-pin DIP IC devices
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- To commit Wire Wrap pins to voltage and ground planes, use Vector T124 solder washers, available separately



10.0" x 5.3"

8804: Voltage/Ground Plane

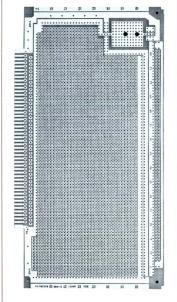
- 0.042" diameter holes on 0.1" grid
- 0.085" diameter clearance area around holes, both sides
- Full voltage and ground planes on opposite board sides
- Mounting holes for heat sink and voltage regulator provided
- Two rows of pads for ribbon wire I/O connectors
- Designed to S100 (IEEE 696) specifications
- Capacity for mounting 70, 16-pin DIP IC devices
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- To commit Wire Wrap pins to voltage and ground planes, use Vector T124 solder washers, available separately



10.0" x 5.3"

8801-6: Pad-Per-Hole

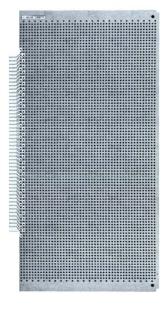
- 0.042" diameter holes on 0.1" grid
- Square solder pads around holes, both sides
- Capacity for mounting 80, 16-pin DIP IC devices
- Two rows of pads for ribbon wire I/O connectors
- Mounting holes for heat sink and voltage regulator provided
- Designed to S100 (IEEE 696) specifications
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately



10.0" x 5.3"

8801-1: Contacts Only

- 0.042" diameter holes on 0.1" grid
- Unrestricted component placement over entire board surface
- Mounts 100, 16-pin DIP IC devices
- Designed to S100 (IEEE 696) specifications
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately



Part No.	Width	Height		tacts	Thick	Hole	16-Pin	Material	Circuit Pattern	Solder	Wire Wrap	Extender	Recommended		Wrap
			Spac-	Num-		Dia.	DIP			Connector	Connector		Card Cage	Terminals	Socket Pins
			ing	ber		(Capacity	1					· ·		
8800V	5.30	10.00	0.125	100	0.062	0.042	52 FR	R4 Epoxy Glass	Voltage/Ground Planes	R681-3	R681-1, -2	3690-12	Series 100	T125, T126	R32
8804	5.30	10.00	0.125	100	0.062	0.042	70 CE	M-1 Epoxy Glass Composite	Voltage/Ground Planes	R681-3	R681-1, -2	3690-12	Series 100	T125, T126	R32
8801-6	5.30	10.00	0.125	100	0.062	0.042	80 FR	R4 Epoxy Glass	Pad-Per-Hole	R681-3	R681-1, -2	3690-12	Series 100	T125, T126	R32
8801-1	5.30	10.00	0.125	100	0.062	0.042	80 CE	M-1 Epoxy Glass Composite	Contacts Only	R681-3	R681-1, -2	3690-12	Series 100	T125, T126	R32



Vectorbord® Metric Prototyping Boards—Available In Vectorbord® and Multilayer Vectorbord plus™ Patterns

Vectorbord Metric Prototyping® Boards feature precision-drilled holes and FR4 Epoxy Glass construction. Compatible with VME, Multibus II, Futurebus, and most common DIN-based applications; available in a wide range of sizes and circuit patterns.

Common features include:

- 0.042" or 0.055" diameter holes on 0.1" grids
- I/O areas for ribbon cable and other connectors
- Pin coordinate legends on board surfaces identify columns, rows, and connector assignments
- Bus connector areas for 96-pin DIN connectors
- Can be used for solder or Wire Wrap applications
- Solder and Wire Wrap terminals, card ejectors, and eyelets available separately
- Layout paper and instruction sheets included

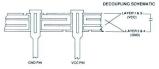
Multilayer Vectorbord plus™ Metric Prototyping Boards

High-performance, multilayer design-an innovative approach to prototyping and small production runs. Multilayer Vectorbord plus™ boards are 0.125" thick with 0.062" milled edges and feature 0.055" diameter holes, precision-drilled, on 0.1" grid. 0.042" plated-thru holes at V/G locations. All holes are "on grid" to facilitate automated soldering, wiring, component placement, and other CAE/CAM applications. Large PGA and DIP mounting areas accommodate devices in most popular sizes.

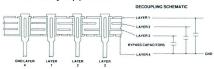
Factory-installed SMD decoupling capacitors of alternating values provide superior noise reduction; mounted on component side beneath DIP positions for unrestricted component placement and wiring.

Two versions available:

 Vectorbord plus™ Standard boards, for highspeed Schottky applications, provide redundant voltage and ground planes (2 each)



Vectorbord plus™
 Universal boards feature
 four uncommitted layers
 for superior performance
 for ECL logic and other
 applications requiring
 multiple power planes, or
 can be interconnected for
 Schottky applications



Vectorbord plus™ boards are supported by a complete line of prototyping and packaging products, including terminals and pins, backplanes, extenders, card cages, and system enclosures

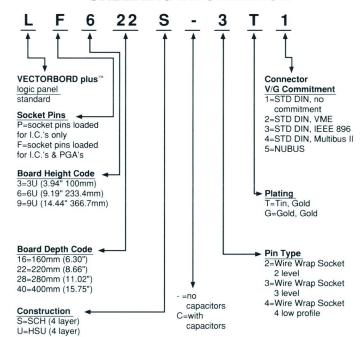
Ordering Options For Special Requirements

Vectorbord plus™ boards are available in various configurations, on special order, to meet specialized needs. See the Ordering Table for information on special configurations.

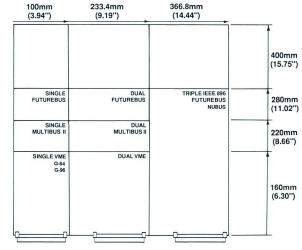
Available options include:

- Low profile socket pins for Stitch Wire applications
- Two or three level Wire Wrap socket pins
- Socket pins and SMD decoupling caps selectively loaded per user specifications
- · Gold-plated socket pins
- Protective wiring shields installed
- Connectors committed to specified bus architectures

ORDERING INFORMATION



Logic Panel Sizes

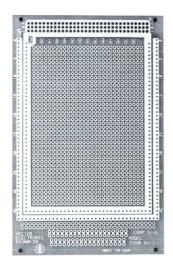




E160-3U-1: Pad-Per-Hole

With Precision-Drilled, Plated-Thru Holes

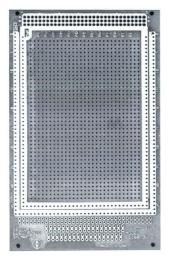
- 0.042" diameter holes on 0.1" grid with 0.080" diameter, isolated solder pad around each hole, both sides
- For solder, Wire Wrap, or mixed wiring methods
- Voltage and ground buses around board perimeter, both sides
- All pad and bus surfaces solder-coated for user convenience
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- Capacity for mounting 35, 16-pin DIP IC devices; also accepts PGA and PLCC devices



3U x 160MM

E160-3U-2: Peripheral Buses

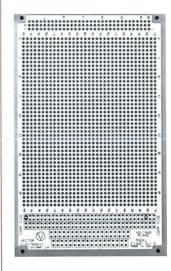
- 0.042" diameter precisiondrilled holes on 0.1" grid
- Voltage and ground buses around board perimeter, both sides
- All bus surfaces soldercoated for user convenience
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- 29 x 41 grid unrestricted component placement area
- Capacity for mounting 35, 16-pin DIP IC devices; also accepts PGA and PLCC devices



3U x 160MM

E160-3U-3: Voltage/Ground Plane

- 0.055" diameter precisiondrilled holes with 0.085" diameter clearance areas around each hole, both sides
- Overall voltage and ground planes on opposite board sides provide excellent shielding and power and ground distribution
- Plane surfaces soldercoated
- Capacity for mounting 45, 16-pin DIP IC devices
- Accepts Wire Wrap socket pins, Vector Part Nos. R52 and R53, available separately
- To commit Wire Wrap pins to voltage or ground planes, use Vector T124 solder washers, available separately
- To simulate plated-thru holes committed to voltage or ground planes, use Vector T123 eyelets, available separately (for use without pins)

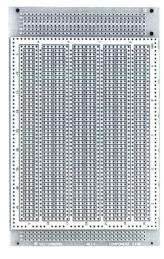


3U x 160MM

4614: 3-Hole Solder Pads

With Precision-Drilled, Plated-Thru Holes

- 0.042" diameter holes on 0.1" grid
- 3-hole solder pads (0.28" x 0.080") for interconnecting multiple component leads
- Interleaved buses on both sides, back-to-back
- Bus and pad surfaces solder-coated for user convenience
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- Capacity for mounting 20, 16-pin DIP IC devices



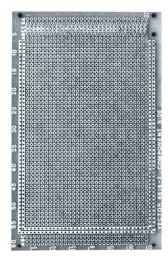
Part No.	Width	Height	Hole	16-pin	Material	96-Pin	Recommended	Wi	re Wrap
			Dia.	DIP		DIN	Card Cage	Terminals	Socket Pins
				Capacity		Connector			
E160-3U-1	6.3	3.94	0.042	35	FR4 Epoxy Glass	RE96MWR	CCK160-3U	T125, T126	R32
E160-3U-2	6.3	3.94	0.042	35	FR4 Epoxy Glass	RE96MWR	CCK160-3U	T125, T126	R32
E160-3U-3	6.3	3.94	0.055	45	FR4 Epoxy Glass	RE96MWR	CCK160-3U	-	R50,R51,R52,R53
4614	6.3	3.94	0.042	20	FR4 Epoxy Glass	RE96MWR	CCK160-3U	T125, T126	R32



4614-3: Pad-Per-Hole

With Precision-Drilled, Plated-Thru Holes

- 0.042" diameter holes on 0.1" grid with 0.080" diameter, isolated solder pad around each hole, both sides
- Voltage and ground buses around board perimeter on both sides, back-toback
- All pad and bus surfaces solder-coated for user convenience
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- Capacity for mounting 40, 16-pin DIP IC devices; also accepts PGA and PLCC devices

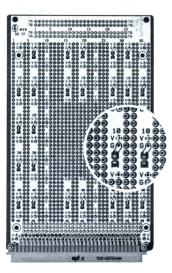


3U x 160MM

LF316UC3T1: Vectorbord plusTM, Universal Version

High-Speed, Multilayer Wire Wrap Board With Socket Pins

- 0.055" diameter precisiondrilled holes on 0.1" grid
- Factory-installed, precision socket pins with gold contacts—four finger pins in DIP IC mounting areas and six finger pins (low insertion force) in PGA mounting areas
- Factory-installed SMD caps (49) of alternating values provide excellent noise reduction; mounted on component side beneath DIP positions for unrestricted component placement and wiring



- 20 x 20 hole PGA grid accommodates PGA and PLCC devices
- Capacity for mounting 49, 16-pin DIP IC devices; 12 additional DIPS can be mounted in PGA area
- Pin coordinate legend on board surface facilitates location and designation of wiring, components, and test fixtures
- I/O connector mounting area for ribbon cable connectors
- To commit Wire Wrap pins to voltage or ground planes, use Vector T124 solder washers, available separately
- Universal version: four uncommitted copper layers provide for multiple power planes, can be interconnected for Schottky applications

Part No.	Width	Height	Hole	16-pin	Material	96-Pin	Recommended	Wir	e Wrap
			Dia.	DIP Capacity		DIN Connector	Card Cage	Terminals	Socket Pins
4614-2	6.3	3.94	0.042	30	FR4 Epoxy Glass	RE96MWR	CCK160-3U	T125, T126	R32
4614-3	6.3	3.94	0.042	40	FR4 Epoxy Glass	RE96MWR	CCK160-3U	T125, T126	R32
LF316UC3T1	6.3	3.94	0.055	49	FR4 Epoxy Glass	Installed	CCK160-3U	Installed	Installed

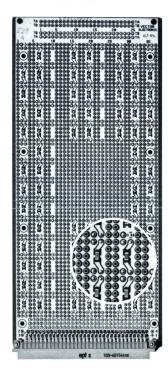


3U x 220MM

LF322SC3T1: Vectorbord plus™, Standard Version

High-Speed, Multilayer Wire Wrap Board With Socket Pins

- 0.055" diameter precisiondrilled holes on 0.1" grid
- Factory-installed precision socket pins with gold contacts—four finger pins in DIP IC mounting areas and six finger pins (low insertion force) in PGA mounting areas
- Factory-installed SMD caps (40 for Standard, 80 for Universal) of alternating values provide excellent noise reduction; mounted on component side beneath DIP positions for unrestricted component placement and wiring
- 20 x 20 hole PGA grid accommodates PGA and PLCC devices



- Capacity for mounting 81, 16-pin DIP IC devices; 12 additional DIPS can be mounted in PGA area
- Pin coordinate legend on board surface facilitates location and designation of wiring, components, and test fixtures
- I/O connector mounting area for ribbon cable connectors
- To commit Wire Wrap pins to voltage or ground planes, use Vector T124 solder washers, available separately
- Standard version: with redundant, copper power and ground layers for Schottky and other highspeed applications

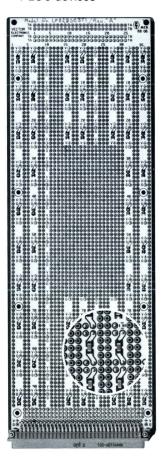
3U x 280MM

LF328SC3T1: Vectorbord plus™, Standard Version

LF328UC3T1: Vectorbord plus™, Universal Version

High-Speed, Multilayer Wire Wrap Boards With Socket Pins

- 0.055" diameter precisiondrilled holes on 0.1" grid
- Factory-installed precision socket pins with gold contacts—four finger pins in DIP IC mounting areas and six finger pins (low insertion force) in PGA mounting area
- 20 x 40 hole PGA grid accommodates PGA and PLCC devices



- P Factory-installed SMD caps (58 for Standard, 100 for Universal) of alternating values provide excellent noise reduction; mounted on component side beneath DIP positions for unrestricted component placement and wiring.
- Capacity for mounting 100, 16-pin DIP IC devices; 25 additional DIPS can be mounted in PGA area
- Pin coordinate legend on board surface facilitates location and designation of wiring, components, and test fixtures
- I/O connector mounting area for ribbon cable connectors
- To commit Wire Wrap pins to voltage or ground planes, use Vector T124 solder washers, available separately
- Standard version: with redundant, copper power and ground layers for Schottky and other highspeed applications
- Universal version: four uncommitted copper layers provide for multiple power planes, can be interconnected for Schottky applications

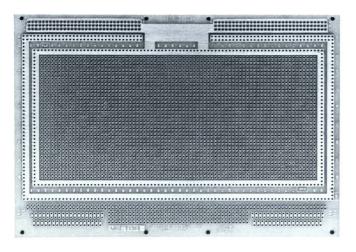
Part No.	Width	Height	Hole	16-pin	Material	96-Pin	Recommended	Wir	e Wrap
			Dia.	DIP Capacity		DIN Connector	Card Cage	Terminals	Socket Pins
LF322SC3T1	8.66	3.94	0.055	81	FR4 Epoxy Glass	Installed	CCK220-3U	Installed	Installed
LF328SC3T1	11.02	3.94	0.055	100	FR4 Epoxy Glass	Installed	CCK280-6U	Installed	Installed
LF328UC3T1	11.02	3.94	0.055	100	FR4 Epoxy Glass	Installed	CCK280-6U	Installed	Installed



E160-6U-1: Pad-Per-Hole

With Precision-Drilled, Plated-Thru Holes

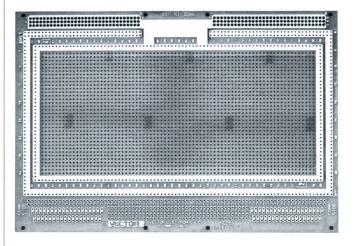
- 0.042" diameter precisiondrilled holes on 0.1" grid
- 0.080" diameter, isolated solder pad around each hole, both sides
- Voltage and ground buses around board perimeter, both sides
- Pad and bus surfaces solder-coated for user convenience
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- Capacity for mounting 100, 16-pin DIP IC devices; also accepts PGA and PLCC devices



6U x 160MM

E160-6U-2: Peripheral Buses

- 0.042" diameter precisiondrilled holes on 0.1" grid
- Voltage and ground buses around board perimeter, both sides
- Bus surfaces soldercoated for user convenience
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- 42 x 77 grid unrestricted component placement area
- Capacity for mounting 100, 16-pin DIP IC devices; also accepts PGA and PLCC devices



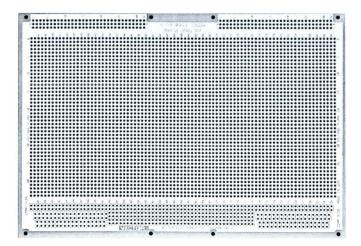
Part No.	Width	Height	Hole Dia.	16-pin DIP Capacity	Material	96-Pin DIN Connector	Recommended Card Cage	Wire Terminals	Socket Pins
E160-6U-1	6.3	9.19	0.042	100	FR4 Epoxy Glass	RE96MWR	CCK160-6U	T125, T126	R32
E160-6U-2	6.3	9.19	0.042	100	FR4 Epoxy Glass	RE96MWR	CCK160-6U	T125, T126	R32



E160-6U-3: Voltage/Ground Plane

- 0.055" diameter precisiondrilled holes with 0.085" diameter clearance areas around each hole, both sides
- Overall voltage and ground planes on opposite board sides provide excellent shielding and power distribution
- Plane surfaces soldercoated for user convenience
- Capacity for mounting 105, 16-pin DIP IC devices

- Accepts Wire Wrap socket pins, Vector Part Nos. R52 and R53, available separately
- To commit Wire Wrap pins to voltage or ground planes, use Vector T124 solder washers, available separately
- To simulate plated-thru holes committed to voltage or ground planes, use Vector T123 eyelets, available separately (for use without pins)

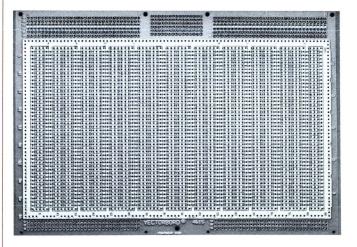


6U x 160MM

4615: 3-Hole Solder Pad

With Precision-Drilled, Plated-Thru Holes

- 0.042" diameter precisiondrilled holes on 0.1" grid
- 3-hole solder pads (0.28" x 0.080") for interconnecting multiple component leads
- Interleaved buses on both sides, back-to-back
- Bus and pad surfaces solder-coated for user convenience
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- Capacity for mounting 50, 16-pin DIP IC devices



Part No.	Width	Height	Height Hole Dia.	16-pin	Material	96-Pin	Recommended	Wire Wrap	
				DIP Capacity		DIN Connector	Card Cage	Terminals	Socket Pins
E160-6U-3 4615	6.3 6.3	9.19 9.19	0.055 0.042	105 50	FR4 Epoxy Glass FR4 Epoxy Glass	RE96MWR RE96MWR	CCK160-6U CCK160-6U	- T125,T126	R50,R51,R52,R53 R32



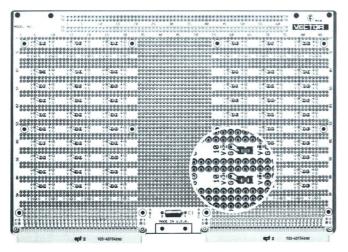
LF616SC3T1: Vectorbord plus[™], Standard Version

LF616UC3T1: Vectorbord plus™, Universal Version

High-Speed, Multilayer Wire Wrap Boards With Socket Pins

- 0.055" diameter precisiondrilled holes on 0.1" grid
- Factory-installed precision socket pins with gold contacts—four finger pins in DIP IC mounting areas and six finger pins (low insertion force) in PGA mounting area
- Factory-installed SMD caps (60 for Standard, 116 for Universal) of alternating values provide excellent noise reduction; mounted on component side beneath DIP positions for unrestricted component placement and wiring

- 21 x 48 hole PGA grid accommodates PGA and PLCC devices
- Capacity for mounting 120, 16-pin DIP IC devices; 30 additional DIPS can be mounted in PGA area
- Pin coordinate legend on board surface facilitates location and designation of wiring, components, and test fixtures
- I/O Connector mounting area for ribbon cable connectors
- To commit Wire Wrap pins to voltage or ground planes, use Vector T124 solder washers, available separately
- Standard version: with redundant, copper power and ground layers for Schottky and other highspeed applications
- Universal version: four uncommitted copper layers provide for multiple power planes, can be interconnected for Schottky applications

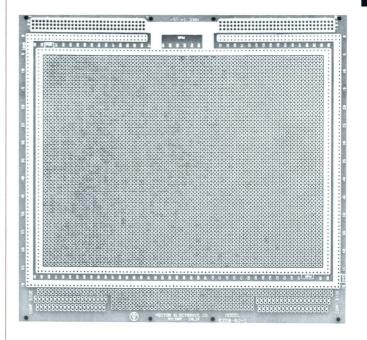


6U x 220MM

E220-6U-1: Pad-Per-Hole

With Precision-Drilled, Plated-Thru Holes

- 0.042" diameter precisiondrilled holes on 0.1" grid
- 0.080" diameter, isolated solder pad around each hole, both sides
- Voltage and ground buses around board perimeter, both sides
- Pad and bus surfaces solder-coated for user convenience
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- Capacity for mounting 140, 16-pin DIP IC devices; also accepts PGA and PLCC devices



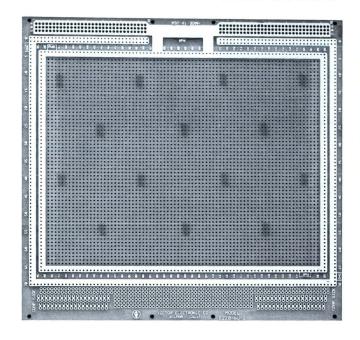
Part No.	Width	Height	Hole	16-pin	Material	96-Pin	in Recommended	Wire Wrap	
			Dia.	DIP		DIN	Card Cage	Terminals	Socket Pins
				Capacity		Connector			
LF616SC3T1	6.3	9.19	0.055	120	FR4 Epoxy Glass	Installed	CCK160-6U	Installed	Installed
LF616UC3T1	6.3	9.19	0.055	120	FR4 Epoxy Glass	Installed	CCK160-6U	Installed	Installed
E220-6U-1	8.66	9.19	0.042	140	FR4 Epoxy Glass	RE96MWR	CCK220-6U	T125,T126	R32



6U x 220MM

E220-6U-2: Peripheral Buses

- 0.042" diameter precisiondrilled holes on 0.1" grid
- Voltage and ground buses around board perimeter, both sides
- Bus surfaces soldercoated for user convenience
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- 58 x 78 grid unrestricted component placement area
- Capacity for mounting 140, 16-pin DIP IC devices; also accepts PGA and PLCC devices

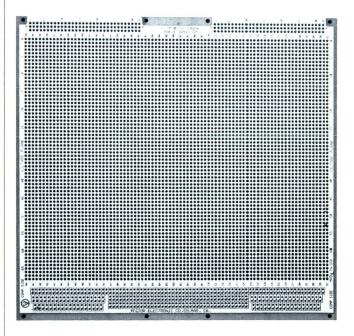


6U x 220MM

E220-6U-3: Voltage/Ground Plane

- 0.055" diameter precisiondrilled holes with 0.085" diameter clearance areas around each hole, both sides
- Overall voltage and ground planes on opposite board sides provide excellent shielding and power distribution
- Plane surfaces soldercoated for user convenience
- Capacity for mounting 168, 16-pin DIP IC devices

- Accepts Wire Wrap socket pins, Vector Part Nos. R52 and R53, available separately
- To commit Wire Wrap pins to voltage or ground planes, use Vector T124 solder washers, available separately
- To simulate plated-thru holes committed to voltage or ground planes, use Vector T123 eyelets, available separately (for use without pins)



Part No.	Width	Height	Hole Dia.	16-pin DIP Capacity	Material	96-Pin DIN Connector	Recommended Card Cage	W Terminals	fire Wrap Socket Pins
E220-6U-2	8.66	9.19	0.042	140	FR4 Epoxy Glass	RE96MWR	CCK220-6U	T125,T126	R32
E220-6U-3	8.66	9.19	0.055	168	FR4 Epoxy Glass	RE96MWR	CCK220-6U		R50,R51,R52,R53



6U X 220MM

LF622SC3T1: Vectorbord plus™, Standard Version

LF622UC3T1: Vectorbord plus™, Universal Version

High-Speed, Multilayer Wire Wrap Boards With Socket Pins

- 0.055" diameter precisiondrilled holes on 0.1" grid
- Factory-installed precision socket pins with gold contacts—four finger pins in DIP IC mounting areas and six finger pins (low insertion force) in PGA mounting areas
- Factory-installed SMD caps (94 for Standard, 184 for Universal) of alternating values provide excellent noise reduction; mounted on component side beneath DIP positions for unrestricted component placement and wiring

- 21 x 72 hole PGA grid accommodates PGA and PLCC devices
- Pin coordinate legend on board surface facilitates location and designation of wiring, components, and test fixtures
- I/O Connector mounting area for ribbon cable connectors
- To commit Wire Wrap pins to voltage or ground planes, use Vector T124 solder washers, available separately
- Standard version: with redundant, copper power and ground layers for Schottky and other highspeed applications
- Universal version: four uncommitted copper layers provide for multiple power planes, can be interconnected for Schottky applications

| FC00000T4

6U x 280MM

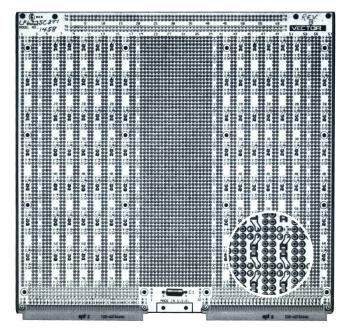
LF628SC3T1: Vectorbord plus[™], Standard Version

LF628UC3T1: Vectorbord plus™, Universal Version

High-Speed, Multilayer Wire Wrap Boards With Socket Pins

- 0.055" diameter precisiondrilled holes on 0.1" grid
- Factory-installed precision socket pins with gold contacts—four finger pins in DIP IC mounting areas and six finger pins (low insertion force) in PGA mounting areas
- Factory-installed SMD caps (126 for Standard, 240 for Universal) of alternating values provide excellent noise reduction; mounted on component side beneath DIP positions for unrestricted component placement and wiring
- 21 x 95 hole PGA grid accommodates PGA and PLCC devices

- Capacity for mounting 242, 16-pin DIP IC devices; 55 additional DIPs can be mounted in PGA area
- Pin coordinate legend on board surface facilitates location and designation of wiring, components, and test fixtures
- I/O Connector mounting area for ribbon cable connectors
- To commit Wire Wrap pins to voltage or ground planes, use Vector T124 solder washers, available separately
- Standard version: with redundant, copper power and ground layers for Schottky and other highspeed applications
- Universal version: four uncommitted copper layers provide for multiple power planes, can be interconnected for Schottky applications



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Part No.	Width	Height	Hole	16-pin	Material	96-Pin	Recommended	Wire	e Wrap
Tall No.	***************************************	rieight	Dia.	DIP Capacity	Waterial	DIN Connector	Card Cage	Terminals	Socket Pins
LF622SC3T1	8.66	9.19	0.055	198	FR4 Epoxy Glass	Installed	CCK220-6U	Installed	Installed
LF622UC3T1	8.66	9.19	0.055	198	FR4 Epoxy Glass	Installed	CCK220-6U	Installed	Installed
LF628SC3T1	11.02	9.19	0.055	242	FR4 Epoxy Glass	Installed	CCK280-6U	Installed	Installed
LF628UC3T1	11.02	9.19	0.055	242	FR4 Epoxy Glass	Installed	CCK280-6U	Installed	Installed



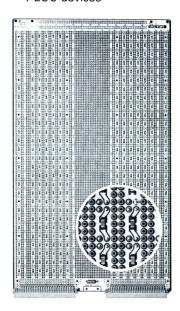
6U x 400MM

LF640SC3T1: Vectorbord plus™, Standard Version

LF640UC3T1: Vectorbord plus™, Universal Version

High-Speed, Multilayer Wire Wrap Boards With Socket Pins

- 0.055" diameter precisiondrilled holes on 0.1" grid
- Factory-installed precision socket pins with gold contacts—four finger pins in DIP IC mounting areas and six finger pins (low insertion force) in PGA mounting area
- Factory-installed SMD caps (184 for Standard, 368 for Universal) of alternating values provide excellent noise reduction; mounted on component side beneath DIP positions for unrestricted component placement and wiring
- 21 x 143 hole PGA grid accommodates PGA and PLCC devices



- Capacity for mounting 374, 16-pin DIP IC devices; 85 additional DIPs can be mounted in PGA area
- Pin coordinate legend on board surface facilitates location and designation of wiring, components, and test fixtures
- I/O Connector mounting area for ribbon cable connectors
- To commit Wire Wrap pins to voltage or ground planes, use Vector T124 solder washers, available separately
- Standard version: with redundant, copper power and ground layers for Schottky and other highspeed applications
- Universal version: four uncommitted copper layers provide for multiple power planes, can be interconnected for Schottky applications

9U x 220MM

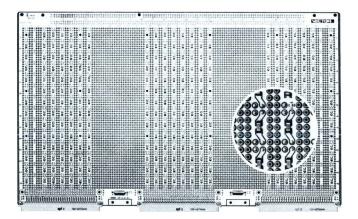
LF922SC3T1: Vectorbord plus[™], Standard Version

LF922UC3T1: Vectorbord plus™, Universal Version

High-Speed, Multilayer Wire Wrap Boards With Socket Pins

- 0.055" diameter precisiondrilled holes on 0.1" grid
- Factory-installed precision socket pins with gold contacts—four finger pins in DIP IC mounting areas and six finger pins (low insertion force) in PGA mounting areas
- Factory-installed SMD caps (148 for Standard, 280 for Universal) of alternating values provide excellent noise reduction; mounted on component side beneath DIP positions for unrestricted component placement and wiring
- Two, 24 x 72 hole PGA grids accommodate PGA and PLCC devices of any size

- Capacity for mounting 306, 16-pin DIP IC devices; 108 additional DIPs can be mounted in PGA areas
- Pin coordinate legend on board surface facilitates location and designation of wiring, components, and test fixtures
- I/O Connector mounting area for ribbon cable connectors
- To commit Wire Wrap pins to voltage or ground planes, use Vector T124 solder washers, available separately
- Standard version: with redundant, copper power and ground layers for Schottky and other highspeed applications
- Universal version: four uncommitted copper layers provide for multiple power planes, can be interconnected for Schottky applications



Part No.	Width	Height	Hole	16-pin	Material	96-Pin	Recommended	Wire	Wrap
			Dia.	DIP Capacity		DIN Connector	Card Cage	Terminals	Socket Pins
LF640SC3T1	15.75	9.19	0.055	374	FR4 Epoxy Glass	Installed	CCK400-6U	Installed	Installed
LF640UC3T1	15.75	9.19	0.055	374	FR4 Epoxy Glass	Installed	CCK400-6U	Installed	Installed
LF922UC3T1	8.66	14.44	0.055	306	FR4 Epoxy Glass	Installed	CCK220-9U	Installed	Installed
LF922SC3T1	8.66	14.44	0.055	306	FR4 Epoxy Glass	Installed	CCK220-9U	Installed	Installed



9U x 280MM

E280-9U-1: Pad-Per-Hole

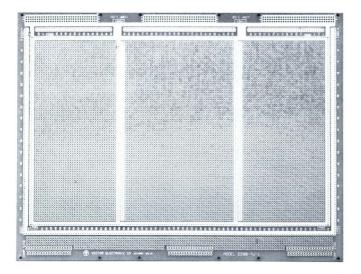
With Precision-Drilled, Plated-Thru Holes

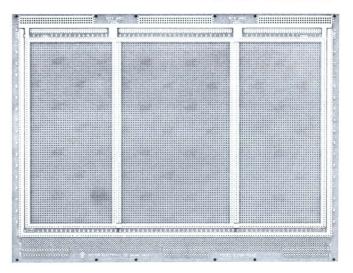
- 0.042" diameter holes on 0.1" grid
- 0.080" diameter, isolated solder pad around each hole, both sides
- Voltage and ground buses around board perimeter on both sides
- Pad and bus surfaces solder-coated for user convenience
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- Capacity for mounting 270, 16-pin DIP IC devices; also accepts PGA and PLCC devices
- Additional power and ground buses in signal area



E280-9U-2: Peripheral Buses

- 0.042" diameter precisiondrilled holes on 0.1" grid
- Voltage and ground buses around board perimeter, both sides
- Additional power and ground buses in signal
- Bus surfaces soldercoated for user convenience
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- Three 79 x 36 grid unrestricted component placement areas
- Capacity for mounting 270, 16-pin DIP IC devices; also accepts PGA and PLCC devices





Part No.	Width	Height	Hole	16-pin	Material	96-Pin	Recommended	Wire	e Wrap
			Dia.	DIP Capacity		DIN Connector	Card Cage	Terminals	Socket Pins
E280-9U-1	11.02	14.44	0.042	270	FR4 Epoxy Glass	RE96MWR	CCK280-9U	T125,T126	R32
E280-9U-2	11.02	14.44	0.042	270	FR4 Epoxy Glass	RE96MWR	CCK280-9U	T125,T126	R32

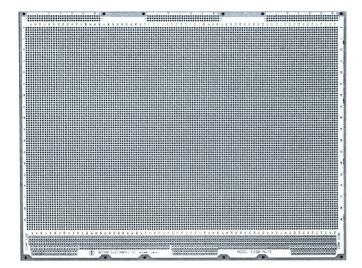


9U x 280MM

E280-9U-3: Voltage/Ground Plane

- 0.055" diameter precisiondrilled holes with 0.085" diameter clearance areas around each hole, both sides
- Overall voltage and ground planes on opposite board sides provide excellent shielding and power distribution
- Plane surfaces soldercoated for user convenience
- Capacity for mounting 348, 16-pin DIP IC devices

- Additional power and ground buses in signal area
- Accepts Wire Wrap socket pins, Vector Part Nos. R52 and R53, available separately
- To commit Wire Wrap pins to voltage or ground planes, use Vector T124 solder washers, available separately
- To simulate plated-thru holes committed to voltage or ground planes, use Vector T123 eyelets, available separately (for use without pins)



9U x 280MM

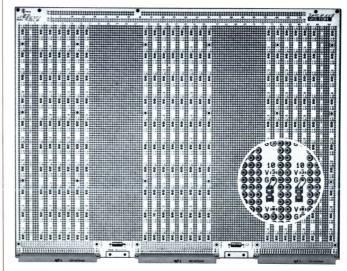
LF928SC3T1: Vectorbord plus™, Standard Version

LF928UC3T1: Vectorbord plus™, Universal Version

High-Speed, Multilayer Wire Wrap Boards With Socket Pins

- 0.055" diameter precisiondrilled holes on 0.1" grid
- Factory-installed precision socket pins with gold contacts—four finger pins in DIP IC mounting areas and six finger pins (low insertion force) in PGA mounting areas
- Factory-installed SMD caps (198 for Standard, 400 for Universal) of alternating values provide excellent noise reduction; mounted on component side beneath DIP positions for unrestricted component placement and wiring

- I/O Connector mounting area for ribbon cable connectors
- Two, 24 x 95 hole PGA grids accommodate PGA and PLCC devices of any size
- To commit Wire Wrap pins to voltage or ground planes, use Vector T124 solder washers, available separately
- Standard version: with redundant, copper power and ground layers for Schottky and other highspeed applications
- Universal version: four uncommitted copper layers provide for multiple power planes, can be interconnected for Schottky applications



Part No.	Width	Height	Hole	16-pin	Material	96-Pin	Recommended	W	ire Wrap
		-	Dia.	DIP Capacity		DIN Connector	Card Cage	Terminals	Socket Pins
E280-9U-3 LF928SC3T1	11.02 11.02	14.44 14.44	0.055 0.055	348 400	FR4 Epoxy Glass FR4 Epoxy Glass	RE96MWR Installed	CCK280-9U CCK280-9U	T125, T126 Installed	R50,R51,R52,R53 Installed
LF928UC3T1	11.02	14.44	0.055	400	FR4 Epoxy Glass	Installed	CCK280-9U	Installed	Installed



9U x 400MM

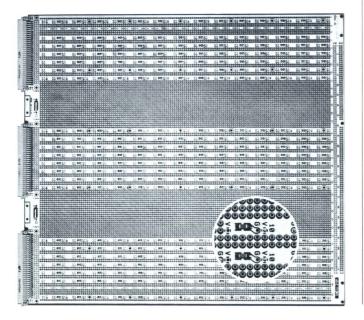
LF940SC3T1: Vectorbord plus™, Standard Version

LF940UC3T1: Vectorbord plus™, Universal Version

High-Speed, Multilayer Wire Wrap Boards With Socket Pins

- 0.055" diameter precisiondrilled holes on 0.1" grid
- Factory-installed precision socket pins with gold contacts—four finger pins in DIP IC mounting areas and six finger pins (low insertion force) in PGA mounting areas
- Factory-installed SMD caps (296 for Standard, 580 for Universal) of alternating values provide excellent noise reduction; mounted on component side beneath DIP positions for unrestricted component placement and wiring
- Two, 24 x 143 hole PGA grids accommodate PGA and PLCC devices of any size

- Capacity for mounting 578, 16-pin DIP IC devices; 204 additional DIPs can be mounted in PGA areas
- Pin coordinate legend on board surface facilitates location and designation of wiring, components, and test fixtures
- I/O Connector mounting area for ribbon cable connectors
- To commit Wire Wrap pins to voltage or ground planes, use Vector T124 solder washers, available separately
- Standard version: with redundant, copper power and ground layers for Schottky and other highspeed applications
- Universal version: four uncommitted copper layers provide for multiple power planes, can be interconnected for Schottky applications



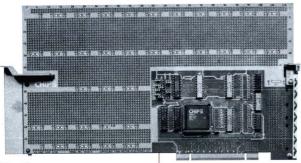
Part No.	Width	Height	Hole Dia.	16-pin DIP Capacity	Material	96-Pin DIN Connector	Recommended Card Cage	Wire Terminals	e Wrap Socket Pins
LF940SC3T1	15.75	14.44	0.055	578	FR4 Epoxy Glass	Installed	CCK400-9U	Installed	Installed
LF940UC3T1	15.75	14.44	0.055	578	FR4 Epoxy Glass	Installed	CCK400-9U	Installed	Installed



IBM PS/2 Active Interfacing Prototyping Board

Featuring Vectorbord® Performance and MicroCHIPS™ Interface Chips

Introducing the Vectorbord® PS/2 Active Interface Prototyping Board. The product of an innovative collaboration between Vector Electronic Company and Chips and Technology, Inc. With this board, engineers can concentrate on "on-board" design rather than on the bus interface.



Full Compatibility With Micro Channel Architecture

Full interface functions are provided by the MicroCHIPS' (Micro Channel Interface Parts) from Chips and Technology, Inc., built onto the boards. These functions include command and status decoding, response signal generation, and full DMA slave arbitration and handshaking (82C612 only). In addition, all IBM timing and drive specifications are met. Based on VLSI technology, the Micro-CHIPS interface can provide significant economies for IBM PS/2 development projects.

Two types of chips are included with each

board. The 82C611 decodes both I/O and memory spaces, converts the Micro Channel "encoded commands" into IBM PC/AT-like decoded commands, supports the POS (programmable option select) system, and many other interface functions. The 82C612 supports controller-type adapters, and provides all DMA slave arbitration functions.

Support circuitry is provided for both interface chips, including: I/O memory address decode PAL sockets; data bus buffers (for 8-and/or 16-bit operation); address latch sockets for all 24 address lines; and ID driver for any 16-bit ID value. Technical lists, schematics, and layout paper are included.

Precision Engineering, Superior Performance

The double-height board provides for prototype designs using classic Wire Wrap or solder techniques. Schematics for these designs then can be converted easily into single-height, three-layer production boards. Contact factory for more information.

The board pattern is based on 0.042" diameter precision-drilled, plated- thru holes with

A Complete Selection of Support Products

The PS/2 Development Kit is supported by a full range of Vectorbord® socket pins and terminals for Wire Wrap and/or solder techniques, including: R32 socket pins; T49 trifurcated klipwrap terminals; T44 bifurcated miniwrap terminals; T46 press-in terminals; T125 and T126 Wire Wrap terminals; and T42 push-in terminals. All pins and



0.080" diameter, isolated solder pads around holes on both sides. Overall voltage and ground planes on opposite sides provide excellent shielding and power distribution. In addition, positions are provided for surface-mount decoupling capacitors. which are included uninstalled. Mounted components can straddle cap positions for increased package densities and low board profiles. Voltage and ground holes at each cap position provide overall access to both planes.

terminals are available separately. Extender cards, solder washers, solder eyelets, and wiring tools also are available separately.

See page 36 for standard IBM PS/2 prototyping board.

Active Interface Board Also Available for IBM PC/XT (Part No. 4613-8). Contact Factory for Details.



Vectorbord® Prototyping Boards for the IBM PC—for Wire Wrap or solder applications.

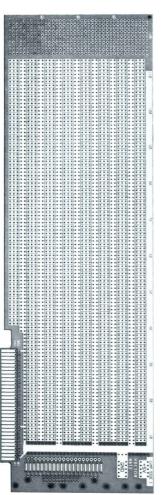
- Holes positioned on 0.1" grid
- Power and ground buses committed to connectors per bus specifications
- Gold plated edge contacts on 0.1" centers
- Identification legends for edge contacts and hole coordinates provided on board surfaces
- Layout paper and instructions included
- Constructed from 0.062" thick epoxy glass with two-ounce copper solder-plated circuit pattern surfaces
- Wire Wrap socket pins available separately for 0.042" and 0.055" holes
- Extender cards, backplanes, terminals, tools, and accessories also available separately

IBM PC, XT

4613: 3-Hole Solder Pad

With Precision-Drilled, Plated-Thru Holes

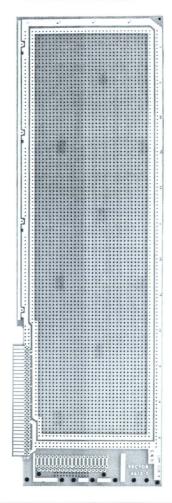
- 0.042" diameter holes on 0.1" grid
- Interleaved buses on both sides, back-to-back
- 3-hole solder pads (0.28" x 0.080") for interconnecting multiple component leads
- I/O mounting area for 37pin D-subminiature and ribbon cable connectors
- Mounting bracket and hardware kit included



IBM PC, XT

4613-1: Peripheral Buses

- 0.042" diameter precisiondrilled holes on 0.1" grid
- Voltage and ground buses around board perimeter, both sides
- Auxiliary bus line along lower edge of board, both sides
- I/O mounting area for 37pin D-subminiature and ribbon cable connectors
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- Mounting bracket and hardware kit included



IBM PC, XT

4613-2: Voltage/Ground Planes

- 0.042" diameter precisiondrilled holes on 0.1" grid
- 0.085" diameter clearance area around holes, both sides
- Full voltage and ground planes on opposite sides
- Three auxiliary bus lines along edge of board
- 12 x 39 grid unrestricted component placement area with 0.080" diameter, isolated solder pads around holes



Part No.	Width	Height	Hole Dia.	16-pin DIP Capacity	Material	Solder Connector	Wire Wrap Connector	Extender	Recommended Card Cage	V/G Terminals	Socket Pins
4613	13.25	4.2	0.042	44	FR4 Epoxy Glass		16	3690-22	-	T125,T126	R32
4613-1	13.25	4.2	0.042	93	FR4 Epoxy Glass			3690-22	2	T125,T126	R32
4613-2	13.25	4.2	0.042	154	FR4 Epoxy Glass		100	3690-22		T125,T126	R32



IBM PC, XT

4613-3: Pad-Per-Hole

With Precision-Drilled, Plated-Thru Holes

- 0.042" diameter holes on 0.1" grid
- 0.080" diameter, isolated solder pad around each hole, both sides
- Voltage and ground buses around board perimeter
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- I/O mounting area for 37pin D-subminiature and ribbon cable connectors

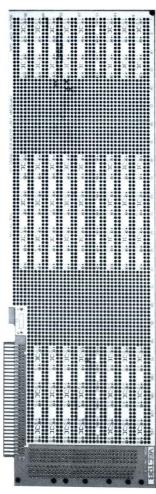


IBM PC, XT

4613-5: Vectorbord plus™

0.055" Diameter Precision-Drilled Holes On 0.1" Grid

- High-speed board accepts socket pins, ideal for Wire Wrap applications
- Plane surfaces soldercoated for user convenience
- Two 21 x 33 grid unrestricted component placement areas
- Accepts Wire Wrap socket pins, Vector Part Nos. R50, R51, R52 and R53, available separately



- Capacity for mounting 120,16-pin DIP IC devices; additional DIPs can be mounted in PGA areas
- Positions for mounting 61 SMD decoupling caps
- To commit Wire Wrap pins to voltage or ground planes, use Vector T124 solder washers, available separately
- To simulate plated-thru holes committed to voltage or ground planes, use Vector T123 eyelets, available separately (for use without pins)
- I/O area for mounting 37pin D-subminiature and ribbon cable connectors
- Holes for V/G pins and I/O connectors are platedthru, 0.042" diameter; can be committed to voltage or ground planes with pressfit pins, Vector Part Nos. T125, T126, available separately
- Mounting bracket and hardware kit included

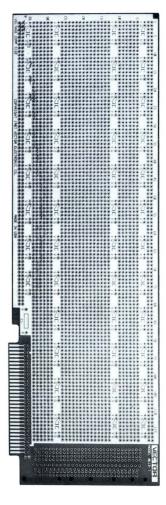
4613C5LF: Vectorbord plus™

- Fully populated Wire Wrap board with factoryinstalled socket pins and terminal pins
- Factory-installed SMD caps of alternating values provide excellent noise reduction; mounted on component side beneath DIP positions for unrestricted component placement and wiring

IBM PC, XT

4613-7: Pads & Planes™

- 0.042" diameter holes on 0.1" grid
- 0.080" diameter, isolated solder pad around each hole, both sides
- Overall voltage and ground planes
- Large component mounting area (14 x 118 grid), unrestricted component placement for DIP IC, PGA, and PLCC devices



Part No.	Width	Height	Hole Dia.	16-pin DIP Capacity	Material	Solder Connector	Wire Wrap Connector	Extender	Recommended Card Cage	V/G Terminals	Socket Pins
4613-3	13.25	4.2	0.042	154	FR4 Epoxy Glass	-	-	3690-22	-	T125,T126	R32
4613-5	13.25	4.2	0.055	120	FR4 Epoxy Glass	2		3690-22	-	T125,T126	R50,R51,R52,R53
4613C5LF	13.25	4.2	0.055	120	FR4 Epoxy Glass			3690-22		T125,T126	R50,R51,R52,R53
4613-7	13.25	4.2	0.042	120	FR4 Epoxy Glass	-	-	3690-22		T125,T126	R32



Vectorbord® Prototyping Boards for the IBM AT family—for Wire Wrap or solder applications.

- Holes on 0.1" grid pattern
- Gold plated edge contacts on 0.1" centers
- Power and ground buses committed to connectors per bus specifications
- Identification legends for edge contacts and hole coordinates provided on board surfaces
- Constructed from 0.062" thick epoxy glass with two-ounce copper solder-plated circuit pattern surfaces
- Layout paper and instructions included
- Wire Wrap socket pins available separately for 0.042" and 0.055" holes
- Extender cards, backplanes, terminals, tools, and accessories also available separately

IBM AT

4617: 3-Hole Solder Pad

With Precision-Drilled, Plated-Thru Holes

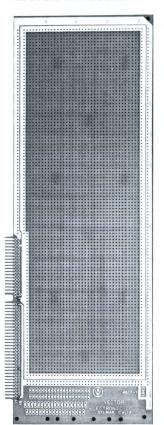
- 0.042" diameter holes on 0.1" grid
- Interleaved buses on both sides, back-to-back
- 3-hole solder pads (0.28" x 0.080") for interconnecting multiple component leads
- 10 x 42 grid unrestricted component placement area
- I/O mounting area for 37pin D-subminiature and ribbon cable connectors
- Mounting bracket and hardware kit included



IBM AT

4617-1: Peripheral Buses

- 0.042" diameter precisiondrilled holes on 0.1" grid
- Power and ground buses around board perimeter, both sides
- Bus surfaces soldercoated for user convenience
- Capacity for mounting 108, 16-pin DIP IC devices; also accepts PGA and PLCC devices
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- I/O mounting area for 37pin D-subminiature and ribbon cable connectors
- Mounting bracket and hardware kit included



IBM AT

4617-3: Pad-Per-Hole

- 0.042" diameter holes on 0.1" grid
- Voltage and ground buses around board perimeter
- Pad and bus surfaces solder-coated for user convenience
- Capacity for mounting 96, 16-pin DIP IC devices; also accepts PGA and PLCC devices
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- I/O mounting area for 37pin D-subminiature and ribbon cable connectors
- Mounting bracket and hardware kit included



Part No.	Width	Height	Hole Dia.	16-pin DIP Capacity	Material	Solder Connector	Wire Wrap Connector	Extender	Recommended Card Cage	V/G Terminals	Socket Pins
4617	13.25	4.8	0.042	32	FR4 Epoxy Glass	-	1.7	3690-26,-1	-	T125,T126	R32
4617-1	13.25	4.8	0.042	108	FR4 Epoxy Glass	-		3690-26,-1	-	T125,T126	R32
4617-3	13.25	4.8	0.042	96	FR4 Epoxy Glass		-	3690-26,-1		T125,T126	R32



IBM AT

4617-4: Voltage/Ground Planes

0.055" Diameter Precision-Drilled Holes On 0.1" Grid

- Full voltage and ground planes on opposite board sides provide excellent shielding and power distribution
- 0.085" diameter clearance area around each hole, both sides
- Plane surfaces soldercoated for user convenience
- Capacity for mounting 130, 16-pin DIP IC devices; also accepts PGA and PLCC devices



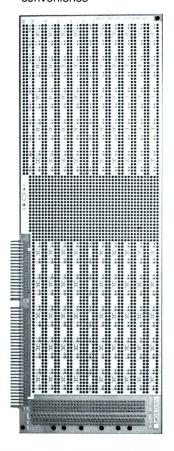
- Accepts Wire Wrap socket pins, Vector Part Nos. R50, R51, R52 and R53, available separately
- To commit Wire Wrap pins to voltage or ground planes, use Vector T124 solder washers, available separately
- To simulate plated-thru holes committed to voltage or ground planes, use Vector T123 eyelets, available separately (for use without pins)
- I/O mounting area for 37pin D-subminiature and ribbon cable connectors
- Mounting bracket and hardware kit included

IBM AT

4617-5: Vectorbord plus™

0.055" Diameter Precision-Drilled Holes On 0.1" Grid

- High speed board, designed for socket pins, ideal for Wire Wrap applications
- Two 21 x 33 grid unrestricted component placement areas
- Capacity for mounting 140, 16-pin DIP IC devices; additional DIPs can be mounted in PGA areas
- Positions for mounting 70 SMD caps
- Plane surfaces soldercoated for user convenience



- I/O mounting area for 50pin D-subminiature and ribbon cable connectors
- Accepts Wire Wrap socket pins, Vector Part Nos. R50, R51, R52 and R53, available separately
- To commit Wire Wrap pins to voltage or ground planes, use Vector T124 solder washers, available separately
- To simulate plated-thru holes committed to voltage or ground planes, use Vector T123 eyelets, available separately (for use without pins)
- Holes for V/G pins and I/O connectors are platedthru, 0.042" diameter; can be committed to voltage or ground planes with pressfit pins, Vector Part Nos. T125, T126, available separately
- Mounting bracket and hardware kit included

4617C5LF: Vectorbord plus™

- Fully populated Wire Wrap board with factoryinstalled socket pins and terminal pins
- Factory-installed SMD caps of alternating values provide excellent noise reduction; mounted on component side beneath DIP positions for unrestricted component placement and wiring

Part No.	Width	Height	Hole Dia.	16-pin DIP Capacity	Material	Solder Connector	Wire Wrap Connector	Extender	Recommended Card Cage	V/G Terminals	Socket Pins
4617-4	13.25	4.8	0.055	140	FR4 Epoxy Glass		-	3690-26,-1		T125,T126	R50,R51,R52,R53
4617-5	13.25	4.8	0.055	140	FR4 Epoxy Glass	90	-	3690-26,-1	2	T125,T126	R50,R51,R52,R53
4617C5LF	13.25	4.8	0.055	140	FR4 Epoxy Glass	±0	-	3690-26,-1	-	T125,T126	R50,R51,R52,R53



High-performance prototyping boards for IBM PS/2 Models 50, 60, and 80.

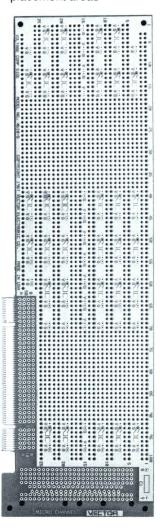
- Available in Vectorbord plus[™] and Pads & Planes[™] circuit patterns
- High density hole patterns based on 0.1" grids
- All holes are "on grid" to facilitate automatic wiring
- Unrestricted component placement, minimum wire paths
- Positions for SMD decoupling capacitors
- Low impedance, overall voltage and ground planes to ensure signal integrity, reduce crosstalk
- Layout paper and instructions included
- Extenders, socket pins, terminals, and accessories available separately

IBM PS/2

4618-5: Vectorbord plus[™]

0.055" Diameter Precision-Drilled Holes On 0.1" Grid

- High-speed board, designed for socket pins, ideal for Wire Wrap applications
- Plane surfaces soldercoated for user convenience
- Two 21 x 25 grid unrestricted component placement areas



- Capacity for mounting 79, 16-pin DIP IC devices; additional DIPs can be mounted in PGA areas
- Positions for mounting 32 SMD decoupling capacitors
- Accepts Wire Wrap socket pins, Vector Part Nos. R50, R51, R52 and R53, available separately
- To commit Wire Wrap pins to voltage or ground planes, use Vector T124 solder washers, available separately
- To simulate plated-thru holes committed to voltage or ground planes, use Vector T123 eyelets, available separately (for use without pins)
- I/O area for mounting 37pin D-subminiature and ribbon cable connectors
- Holes for V/G pins and I/O connectors are platedthru, 0.042" diameter; can be committed to voltage or ground planes with pressfit pins, Vector Part Nos. T125, T126, available separately
- Mounting bracket and hardware kit included

4618C5LF: Vectorbord plus™

- Fully populated Wire Wrap board with factoryinstalled socket pins and terminal pins
- Factory-installed SMD caps of alternating values provide excellent noise reduction; mounted on component side beneath DIP positions for unrestricted component placement and wiring

Part No.	Width	Height	Hole Dia.	16-pin DIP Capacity	Material	Solder Connector	Wire Wrap Connector	Extender	Recommended Card Cage	V/G Terminals	Socket Pins
4618-5	11.5	3.48	0.055	79	FR4 Epoxy Glass	27	-	3690-30,31		T125,T126	R50,R51,R52,R53
4618C5LF	11.5	3.48	0.055	79	FR4 Epoxy Glass	~:	-	3690-30,31	-	T125,T126	R50,R51,R52,R53

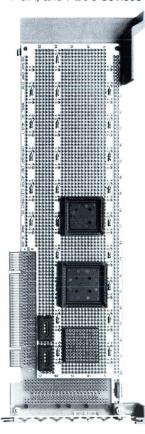


IBM PS/2

4618-7: Pads & Planes

With Precision-Drilled, Plated-Thru Holes

- 0.042" diameter holes on 0.1" grid
- 0.080" diameter, isolated solder pad around each hole, both sides
- Overall voltage and ground planes provide excellent shielding and power distribution
- Pad and plane surfaces solder-coated for user convenience
- Large component mounting area (14 x 100 grid), unrestricted component placement for DIP IC, PGA, and PLCC devices



- Capacity for mounting 79, 16-pin DIP IC devices; also accepts PGA and PLCC devices
- Positions provided for 29 SMD decoupling capacitors
- Accepts Wire Wrap socket pins, Vector Part No. R32, and V/G terminal pins, Vector Part Nos. T125, T126; both pins available separately
- To commit Wire Wrap pins to voltage or ground planes, use Vector Part No. T124 solder washers, available separately
- I/O mounting area for 37pin D-subminiature and ribbon cable connectors
- Mounting bracket and hardware kit included
- See page vi for PS/2 active interfacing prototyping board

Vectorbord® prototyping boards for Apple Macintosh II and Macintosh SE computers.

- Featuring Vectorbord plus[™] and Pads & Planes[™] designs
- Macintosh II boards designed for Apple NuBus specifications
- Massive overall voltage and ground planes on opposite board sides, combines low inductance with high distributed capacitance
- Two-ounce copper ground planes, solder-plated
- 96-pin male DIN connectors with right angle Wire Wrap tails and hardware
- Layout paper and instructions
- Mounting brackets, port expansion shields, and hardware included
- Complete selection of extender cards, Wire Wrap socket pins, terminals, accessories, and installation tools available separately

Macintosh II

5085-4: Voltage/Ground Planes

0.055" Diameter Precision-Drilled Holes On 0.1" Grid

- 0.085" diameter clearance pad around each hole, both sides
- Full voltage and ground planes on opposite sides
- I/O mounting area for 37pin D-subminiature and ribbon cable connectors
- To simulate plated-thru holes committed to voltage or ground planes, use Vector T123 eyelets, available separately (for use without pins)



Part No.	Width	Height	Hole Dia.	16-pin DIP Capacity	Material	Solder Connector	Wire Wrap Connector	Extender	Recommended Card Cage	V/G Terminals	Socket Pins
4618-7	11.5	3.48	0.042	79	FR4 Epoxy Glass		-	3690-30.31	-	T125,T126	R32
5085-4	4.0	12.86	0.055	115	FR4 Epoxy Glass	-	-	3690-27,28	-	T125,T126	R50,R51,R52,R53

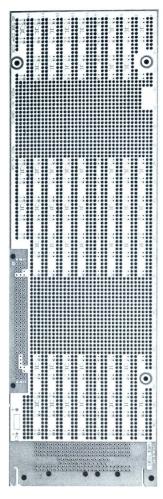


Macintosh II

5085-5: Vectorbord plus™

0.055" Diameter Precision-Drilled Holes On 0.1" Grid

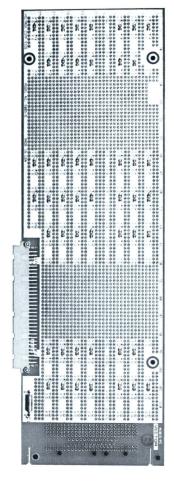
- Designed for socket pins—ideal for Wire Wrap, provides for high speed circuitry, high component density, and a variety of component sizes
- Pad and bus surfaces solder-coated for user convenience
- Two 21 x 32 grid unrestricted component placement areas



- Capacity for mounting 115, 16-pin DIP IC devices; additional DIPs can be mounted in PGA areas
- Positions for mounting 50 SMD decoupling caps
- 96-pin DIN right angle connector supplied
- Accepts Wire Wrap socket pins, Vector Part Nos. R50, R51, R52 and R53, available separately
- To commit Wire Wrap pins to voltage or ground planes, use Vector T124 solder washers, available separately
- To simulate plated-thru holes committed to voltage or ground planes, use Vector T123 eyelets, available separately (for use without pins)
- Holes for V/G pins and I/O connectors are platedthru, can be committed to voltage or ground planes with pressfit pins, Vector Part Nos. T125, T126, available separately
- I/O area for mounting 37pin D-subminiature and ribbon cable connectors

5085C5LF: Vectorbord plus™

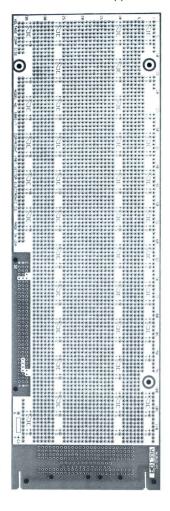
- Fully populated Wire Wrap board with factoryinstalled socket pins and terminal pins
- Factory-installed SMD caps of alternating values provide excellent noise reduction; mounted on component side beneath DIP positions for unrestricted component placement and wiring



Macintosh II

5085-7: Pads & Planes™

- 0.042" diameter holes on 0.1"grid
- 0.080" diameter, isolated solder pad around each hole, both sides
- Positions for mounting 36 SMD decoupling caps
- I/O mounting area for 37pin D-subminiature and ribbon cable connectors
- Chassis mounting bracket and 96-pin, right-angle DIN connector supplied



Part No.	Width	Height	Hole Dia.	16-pin DIP Capacity	Material	Solder Connector	Wire Wrap Connector	Extender	Recommended Card Cage	V/G Terminals	Socket Pins
5085-5	4.0	12.85	0.055	115	FR4 Epoxy Glass	181	:-	3690-27,28	-	T125,T126	R50,R51,R52,R53
5085C5LF	4.0	12.85	0.055	115	FR4 Epoxy Glass	12	9	3690-27,28	-	T125,T126	R50,R51,R52,R53
5085-7	4.0	12.85	0.042	115	FR4 Epoxy Glass	1=1	1-1	3690-27,28	-	T125,T126	R32

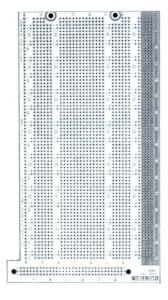


Macintosh SE

5086-7: Pads & Planes™

With Precision-Drilled, Plated-Thru Holes

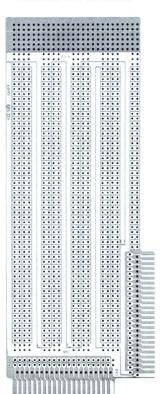
- 0.042" diameter holes on 0.1" grid
- 0.080" diameter, isolated solder pad around each hole, both sides
- Pad and plane surfaces solder-coated for user convenience
- Positions for mounting 28 SMD decoupling caps
- Capacity for mounting 81, 16-pin DIP IC devices; also accepts PGA and PLCC devices
- Accepts Wire Wrap socket pins, Vector Part No. R32, and V/G terminal pins, Vector Part Nos. T125, T126; both pins available separately
- I/O mounting area for 37pin D-subminiature and ribbon cable connectors
- Chassis mounting bracket and 96-pin, right-angle DIN connector supplied



Apple II, Ile

4609: 2-Hole Solder Pad

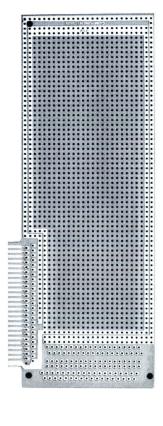
- 0.042" diameter precisiondrilled holes on 0.1" grid
- For solder or Wire Wrap applications
- Interleaved buses on both sides, back-to-back
- In addition to standard 50contact edge connector, 40-contact edge connector for I/O provided
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- Mounting area for ribbon cable connector
- 6 x 26 unrestricted component placement area
- Capacity for mounting 22, 16-pin DIP IC devices; additional DIPs can be mounted in PGA area



Apple II, Ile

4609-1: Peripheral Buses

- 0.042" diameter precisiondrilled holes on 0.1" grid
- Voltage and ground buses around board perimeter, both sides
- Bus surfaces soldercoated for user convenience
- Capacity for mounting 46, 16-pin DIP IC devices
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- I/O mounting area for 37pin D-subminiature and ribbon cable connectors



STD Bus

4610: 3-Hole Solder Pad

- 0.042" diameter precisiondrilled holes on 0.1" grid
- 3-hole solder pads (0.28" x 0.080") for interconnecting multiple component leads
- Solder pads and interleaved buses on wiring side; component side has contacts only
- Bus outlines traced on component side for user convenience
- Pad and bus surfaces solder-coated for user convenience
- I/O mounting area for ribbon cable connector
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- Capacity for mounting 20, 16-pin DIP IC devices
- STD Bus standard: 5 volt bus terminates to pins 1 and 2; ground terminates to pins 3 and 4



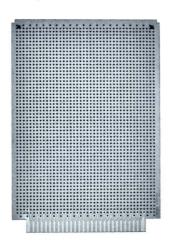
Part No.	Width	Height	Hole Dia.	16-pin DIP Capacity	Material	Solder Connector	Wire Wrap Connector	Extender	Recommended Card Cage	V/G Terminals	Socket Pins
5086-7	4.7	8.4	0.042	81	FR4 Epoxy Glass	-	-	-	-	T125,T126	R32
4609	7.7	3.06	0.042	22	CEM-1 Epoxy Glass Composite	-	-	3690-24	(A)	T125,T126	R32
4609-1	7.7	3.06	0.042	46	CEM-1 Epoxy Glass Composite	-	-	3690-24	4	T125,T126	R32
4610	6.5	4.5	0.042	20	CEM-1 Epoxy Glass Composite	R656-1	R656	3690-16	Series 13	T125,T126	R32



STD Bus

4610-1: Contacts Only

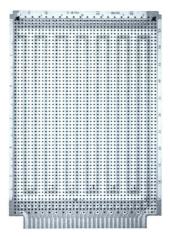
- 0.042" diameter precisiondrilled holes on 0.1" grid
- Capacity for mounting 59, 16-pin DIP IC devices; also accepts PGA and PLCC devices
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately.
- STD Bus standard: 5 volt bus terminates to pins 1 and 2; ground terminates to pins 3 and 4



STD Bus

4610-2: Interleaved Buses

- 0.042" diameter precisiondrilled holes on 0.1" grid
- Power and ground buses on wiring side only, component side has contacts only
- Bus surfaces soldercoated for user convenience
- Bus outlines traced on component side for user convenience
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- I/O mounting area for ribbon cable connector
- Capacity for mounting 35, 16-pin DIP IC devices
- STD Bus standard: 5 volt bus terminates to pins 1 and 2; ground terminates to pins 3 and 4

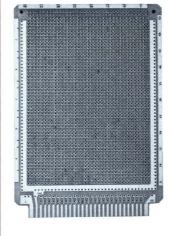


STD Bus

4610-3: Pad-Per-Hole

With Precision-Drilled, Plated-Thru Holes

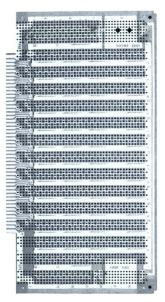
- 0.042" diameter holes on 0.1" grid
- 0.080" diameter, isolated solder pads around holes, both sides
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- Capacity for mounting 52, 16-pin DIP IC devices; also accepts PGA and PLCC devices
- STD Bus standard: 5 volt bus terminates to pins 1 and 2; ground terminates to pins 3 and 4



S-100

8800V: Voltage/Ground Buses

- 0.042" diameter precisiondrilled holes on 0.1" grid
- Pin coordinate legend on board surface facilitates location and designation of wiring, components, and test fixtures
- Zig-zag buses: pins, terminals, or wires contact either voltage or ground at each hole along bus lines
- Power and ground buses uncommitted at DIP locations
- Plane surfaces soldercoated for user convenience
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- Capacity for mounting 52, 16-pin DIP IC devices
- Pins 1 and 51 committed to power; pins 50 and 100 committed to ground per S-100 Bus specification



Part No.	Width	Height	Hole Dia.	16-pin DIP	Material	Solder Connector	Wire Wrap Connector	Extender	Recommended Card Cage	V/G Terminals	Socket Pins
4610-1	6.5	4.5	0.042	Capacity 59	CEM-1 Epoxy Glass Composite	R656-1	R656	3690-16	Series 13	T125.T126	R32
4610-2	6.5	4.5	0.042	35	CEM-1 Epoxy Glass Composite		R656	3690-16	Series 13	T125,T126	R32
4610-3	6.5	4.5	0.042	52	FR4 Epoxy Glass	R656-1	R656	3690-16	Series 13	T125,T126	R32
8800V	10.0	5.3	0.042	52	CEM-1 Epoxy Glass Composite	R681-3	R681-2	3690-12	Series 100	T125,T126	R32

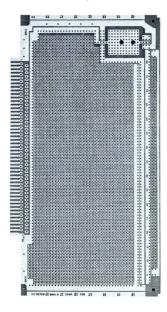


S-100

8801-6: Pad-Per-Hole (replaces Vector Part No. 8801)

With Precision-Drilled, Plated-Thru Holes

- 0.042" diameter holes on 0.1" grid
- Solder pads around holes are square, both sides
- Capacity for mounting 80, 16-pin DIP IC devices; also accepts PGA and PLCC devices
- Pin coordinate legend on board surface facilitates location and designation of wiring, components, and test fixtures
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- I/O mounting area for ribbon cable connectors
- Pins 1 and 51 committed to power; pins 50 and 100 committed to ground per S-100 Bus specification



S-100

8801-1: Contacts Only

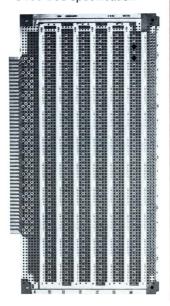
- 0.042" diameter precisiondrilled holes on 0.1" grid
- Unrestricted component placement
- Capacity for mounting 110, 16-pin DIP IC devices; also accepts PGA and PLCC devices
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- Pins 1 and 51 committed to power; pins 50 and 100 committed to ground per S-100 Bus specification



S-100

8804: Voltage/Ground Buses

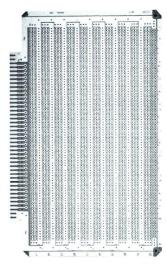
- 0.042" diameter precisiondrilled holes on 0.1" grid
- 0.085" clearance area around holes, both sides
- Pin coordinate legend on board surface facilitates location and designation of wiring, components, and test fixtures
- Zig-zag buses: pins, terminals, or wires contact either voltage or ground at each hole along bus lines
- Plane surfaces soldercoated for user convenience
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- I/O mounting area for ribbon cable connector
- Capacity for mounting 70, 16-pin DIP IC devices
- Pins 1 and 51 committed to power; pins 50 and 100 committed to ground per S100 Bus specification



Motorola Exorciser, Micromodule

4611: 3-Hole Solder Pad

- 0.042" diameter precisiondrilled holes on 0.1" grid
- 3-hole solder pads (0.28" x 0.080") for interconnecting multiple component leads
- Solder pads and interleaved buses on wiring side; component side has contacts only
- Pad and bus surfaces solder-coated
- Bus outlines traced on component side for user convenience
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- Capacity for mounting 45, 16-pin DIP IC devices
- Motorola standard: power bus terminates to pins 1,2,3, A,B,C; ground bus terminates to pins 41,42,43; w,x,y
- I/O mounting area for ribbon cable I/O connector



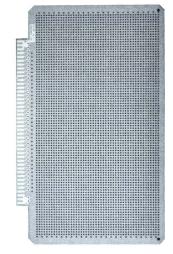
Part No.	Width	Height	Hole Dia.	16-pin DIP Capacity	Material	Solder Connector	Wire Wrap Connector	Extender	Recommended Card Cage	V/G Terminals	Socket Pins
8801-6	10.0	5.3	0.042	80	FR4 Epoxy Glass	R681-3	R681-2	3690-12	Series 100	T125,T126	R32
8801-1	10.0	5.3	0.042	110	CEM-1 Epoxy Glass Composite	R681-3	R681-2	3690-12	Series 100	T125,T126	R32
8804	10.0	5.3	0.042	70	CEM-1 Epoxy Glass Composite	R681-3	R681-2	3690-12	Series 100	T125,T126	R32
4611	9.75	6.0	0.042	45	CEM-1 Epoxy Glass Composite			3690-20	Series 100	T125,T126	R32



Motorola Exorciser, Micromodule

4611-1: Contacts Only

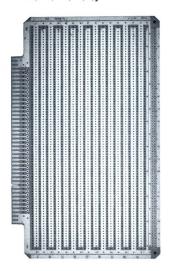
- 0.042" diameter precisiondrilled holes on 0.1" grid
- Unrestricted component placement over entire board area
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- Capacity for mounting 119, 16-pin DIP IC devices; also accepts PGA and PLCC devices
- Pins 1,2,3, A,B,C are common
- Pins 41,42,43 w,x,y are common



Motorola Exorciser, Micromodule

4611-2: Interleaved Buses

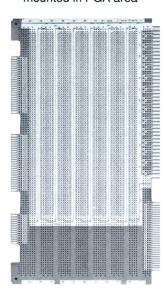
- 0.042" diameter precisiondrilled holes on 0.1" grid
- Interleaved voltage and ground buses on wiring side; component side has contacts only
- Bus surfaces soldercoated
- Bus outlines traced on component side for user convenience
- Capacity for mounting 80, 16-pin DIP IC devices
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- I/O mounting area for ribbon cable connector
- Motorola standard: power bus terminates to pins 1,2,3, A,B,C; ground bus terminates to pins 41,42,43; w,x,y



Multibus

4608: 3-Hole Solder Pad

- 0.042" diameter precisiondrilled holes on 0.1" grid
- Interleaved buses on both sides, back-to-back
- 3-hole solder pads (0.28" x 0.080") on wiring side for interconnecting multiple component leads
- Pad and bus surfaces solder-coated for user convenience
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- 23 x 49 grid unrestricted component placement area
- Capacity for mounting 54, 16-pin DIP IC devices; additional DIPs can be mounted in PGA area



- Two sets of edge contacts: 43/86 on 0.156" centers, and 30/60 on 0.1" centers
- 3 sets of I/O edge connectors at top of board: two sets are 25/50 contacts on 0.1" centers; one set is 13/26 contacts on 0.1" centers

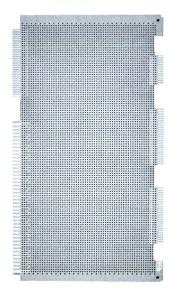
Part No.	Width	Height	Hole Dia.	16-pin DIP Capacity	Material	Solder Connector	Wire Wrap Connector	Extender	Recommended Card Cage	V/G Terminals	Socket Pins
4611-1	9.75	6.0	0.042	119	CEM-1 Epoxy Glass Composite	R685-2	-	3690-20	Series 100	T125,T126	R32
4611-2	9.75	6.0	0.042	80	CEM-1 Epoxy Glass Composite	R685-2	-	3690-20	Series 100	T125,T126	R32
4608	12.0	6.75	0.042	54	CEM-1 Epoxy Glass Composite	R683-1,R68	35-1 -	3690-18	Series 18	T125,T126	R32



Multibus

4608-1: Contacts Only

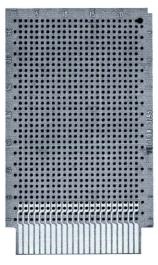
- 0.042" diameter precisiondrilled holes on 0.1" grid
- Unrestricted component placement
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- Capacity for mounting 144, 16-pin DIP IC devices; also accepts PGA and PLCC devices
- Two sets of edge contacts: 43/86 on 0.156" centers, and 30/60 on 0.1" centers
- 3 sets of I/O edge connectors at top of board: two sets are 25/50 contacts on 0.1" centers; one set is 13/26 contacts on 0.1" centers



Commodore 64

3795: Contacts Only

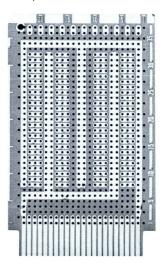
- 0.042" diameter precisiondrilled holes on 0.1" grid
- Edge contacts: 44 pins, 22 each side on 0.1" centers
- Unrestricted component placement
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- Capacity for mounting 15, 16-pin DIP IC devices; also accepts PGA and PLCC devices



Commodore 64

3795-1: 3-Hole Solder Pad

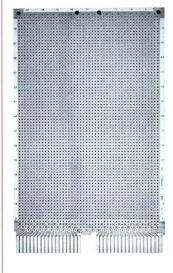
- 0.042" diameter precisiondrilled holes on 0.1" grid
- 3-hole solder pads (0.28" x 0.080") for interconnecting multiple component leads
- Solder pads and interleaved buses on wiring side; component side has contacts only
- Pad and bus surfaces solder-coated for user convenience
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- Capacity for mounting 4, 16-pin DIP IC devices



DEC LSI-11, PDP-8, PDP-11

4607: Contacts Only

- 0.042" diameter precisiondrilled holes on 0.1" grid
- Unrestricted component placement over entire board area
- Board supplied with two sets of edge contacts each set is 36 contacts, 18 each side on 0.125" centers
- Accepts Wire Wrap socket pins, Vector Part No. R32, available separately
- Capacity for mounting 85, 16-pin DIP IC devices; also accepts PGA and PLCC devices



Part No.	Width	Height	Hole Dia.	16-pin DIP	Material	Solder Connector	Wire Wrap Connector	Extender	Recommended Card Cage	V/G Terminals	Socket Pins
				Capacity							
4608-1	12.0	6.75	0.042	144	CEM-1 Epoxy Glass Composite	R683-1,R685-1	-	3690-18	Series 18	T125,T126	R32
3795	4.5	2.73	0.042	15	CEM-1 Epoxy Glass Composite	-	R644-2	3690-8	Series 12	T125,T126	R32
3795-1	4.5	2.73	0.042	4	CEM-1 Epoxy Glass Composite	-	R644-2	3690-8	Series 12	T125,T126	R32
4607	8.43	5.20	0.042	85	FR4 Epoxy Glass		-	-	12	T125,T126	R32

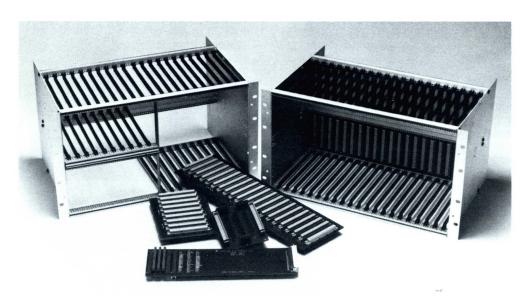


Packaging products from Vector cover a wide range of standard and specialized requirements. From complete, board-ready systems to "Lumber Yard" piece parts, Vector provides the solutions—for general purpose applications and for many bus architectures, including VME, STD, Multibus, and others.

All products, including specials, are built using a "modular" approach.

Design engineers are provided a wide range of opportunity for adjusting, substituting, interchanging, and modifying standard components and piece parts to meet specific needs. With this approach even

special-order products from Vector provide costefficient, quick turnaround solutions for packaging.



Vector Europackaging Card Cages

	Ass'y		Dimensions		Care	d Size	Card Guid	les	
Part No.	Kit	Width	Height	Depth	Height	Width	Туре	Number	Backplane
CCK160-3U	K	19	5.21	9.27	3U	160MM	Noryl, press-in		
CCA160-3U	Α	19	5.21	9.27	3U	160MM	Noryl, press-in		
CCB160-3U2	Α	19	5.21	9.27	3U	160MM	Noryl, press-in	24	12-slot J1
CCB160-3U1	Α	19	5.21	9.27	3U	160MM	Noryl, press-in	42	21-slot J1
CCK220-3U	Α	19	5.21	11.63	3U	220MM	Noryl, press-in		
CCA220-3U	Α	19	5.21	11.63	3U	220MM	Noryl, press-in		
CCK160-6U	K	19	10.46	9.27	6U	160MM	Noryl, press-in		
CCK160-6UQ	K	4.36	10.46	9.39	6U	160MM	Noryl, press-in		
CCK160-6UH	K	8.36	10.46	9.39	6U	160MM	Noryl, press-in		
CCA160-6U	Α	19	5.21	9.27	6U	160MM	Noryl, press-in		
CCB160-6U2	Α	19	10.46	9.27	6U	160MM	Noryl, press-in	24	12-slot J1
CCD160-6U2	Α	19	10.46	9.27	6U	160MM	Noryl, press-in	24	12-slot J1, J2
CCP160-6U2	Α	19	10.46	9.27	6U	160MM	Noryl, press-in	24	12-slot J1/J2 Monolithi
CCP160-6U1	Α	19	10.46	9.27	6U	160MM	Noryl, press-in	42	21-slot J1, J2
CCK220-6U	K	19	10.46	11.63	6U	220MM	Noryl, press-in		
CCA220-6U	Α	19	10.46	11.63	6U	220MM	Noryl, press-in		
CCK280-6U	K	19	10.46	14.0	6U	280MM	Noryl, press-in		
CCA280-6U	Α	19	10.46	14.0	6U	280MM	Noryl, press-in		
CCK340-6U	K	19	10.46	16.36	6U	340MM	Noryl, press-in		
CCA340-6U	Α	19	10.46	16.36	6U	340MM	Noryl, press-in		
CCK400-6U	K	19	10.46	18.72	6U	400MM	Noryl, press-in		
CCA400-6U	Α	19	10.46	18.72	6U	400MM	Noryl, press-in		
CCK220-9U	K	19	15.71	11.63	6U	220MM	Noryl, press-in		
CCA220-9U	Α	19	15.71	11.63	9U	220MM	Noryl, press-in		
CCA280-9U	Α	19	15.71	14.0	9U	280MM	Noryl, press-in		
CCK280-9U	K	19	15.71	14.0	9U	280MM	Noryl, press-in		
CCK340-9U	K	19	15.71	16.36	9U	340MM	Noryl, press-in		
CCA340-9U	Α	19	15.71	16.36	9U	340MM	Noryl, press-in		
CCK400-9U	K	19	15.71	18.72	9U	400MM	Noryl, press-in		
CCA400-9U	Α	19	15.71	18.72	9U	400MM	Noryl, press-in		



Special/Custom Subrack Assemblies

In this section, representative examples of specialorder systems are given. Most of these examples are variations on Vector's standard product line. Standard system assemblies include power supplies, cooling fans, AC filters, on/ off switches, backplanes and card guides. All manufactured products are built using the latest automated equipment and techniques, all feature industry-standard precision and reliability. The Vector product line also is designed for flexibility and interchangeability because standards often must be modified to solve real problems. Vector provides complete engineering and manufacturing services for cost-effective, rapid turnaround development projects. For custom system assemblies, card cages, and backplanesbuilt to your specifications-Vector provides the technology, the flexibility, the solutions.

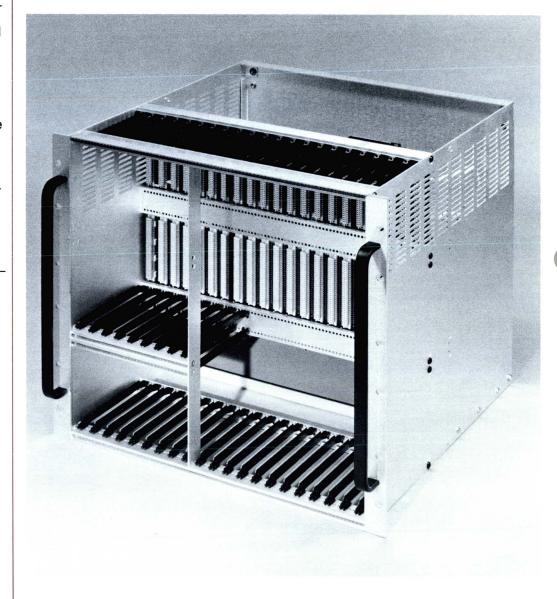
Custom Integrated Subrack Enclosure

SE21122C-1

For large systems, 11U enclosure accepts 9U card cage. Features two 1U fan trays: 3 fans per tray, each fan is rated at 115V AC and delivers 115 cubic feet/minute. 500

watt power supply provides 5V at 100 amps, + or -12V at 10 amps, with overload protection and sense lines.

Card cage includes 21 slot, J1 and J2 Monolithic Backplane with massive power bus bar. 115V power entry module at rear of cage includes fuse, filter, and on/off switch. Card cage and fan trays can be mounted in standard 19" equipment cabinet racks.





Shielded System Enclosure

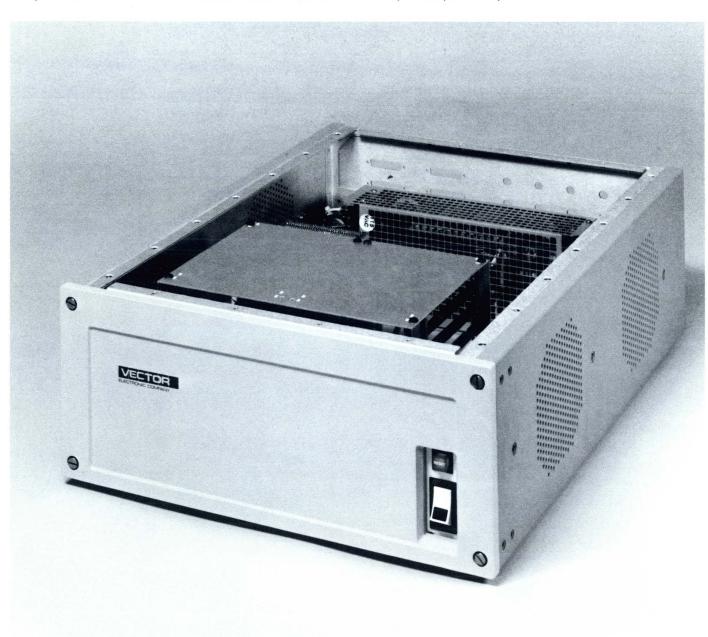
SE2822DH-1

Fully enclosed system provides excellent RF attenuation. Features allmetal construction; all seals are metal-to-metal. Includes ample space for hard disk drive or other components.

Card cage includes 7slot, J1 and/or J2 backplane, and guides for seven 6U X 160MM boards, mounted horizontally. Power supply is rated at 225 watts and provides 5V at 30 amps, 12V at 4 amps, -12V at 2 amps. Front panel has mounting positions for lighted power and reset switches; rear panel includes custom cutouts for I/O connectors and a 115V power entry module which includes filter and fuse. AC power cord also included.

The SE2822DH-1 is a custom unit built from Vector's standard shielded system enclosure (Vector Part No. SE2822), available separately. A wide selection of components—backplanes, power sup-

plies, and fans—is available for configuring systems to special needs. Other modifications, such as special cutouts in the rear panel, also can be made.





Custom Integrated Subrack System

SE2822BR-1

8U enclosure assembly accepts up to 21, 6U X

160MM cards. Features fully assembled, 21-slot backplane: one J1 and one J2 with shrouds. Card guides included for all slots. The 1U Fan tray includes three 12V DC fans rated at 60 cubic feet/

minute. 1000 watt AC to DC power supply delivers 5V DC at 150 amps, +12V DC at 10 amps, and -12V DC at 5 amps. Also includes 120V AC power distribution filter and circuit breaker with on/off switch. The SE2822BR-1 is designed to work with the SU1822BR-1 Mass Storage Unit.



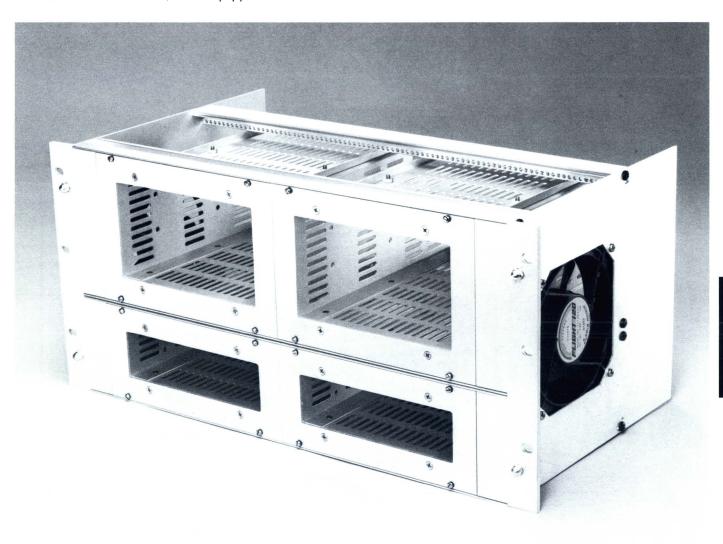


Custom Subrack for Mass Storage

SU1822BR-1

Mass storage unit, designed to work with SE2822BR-1,

includes peripheral bays for 2 full- and 2 half-height drive devices. Two 12V DC cooling fans rated at 60 cubic feet/minute are side mounted for maximum efficiency. The SU1822BR-1 is equipped with cable assemblies (installed by user), including: power distribution wiring harness, floppy drive data/control cable, Winchester drive control cable, Winchester drive data cable, and tape drive data/control cable.





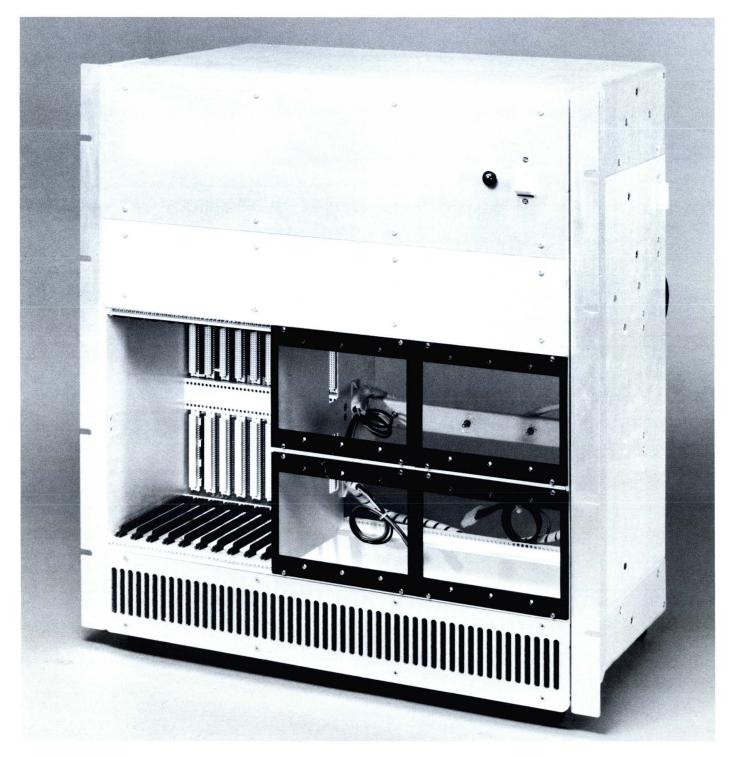
Custom Subrack Enclosure for Telecommunications

SE3022

Designed to fit standard 24" telecommunications

racks. 6U X 160MM card cage designed to VME specifications. Card cage is built around a 10-slot, monolithic (J1 and J2), pressfit-pin backplane. 10 pairs of plastic card guides are installed. System enclosure features: ple-

num with air filter and fan tray with four fans; 12V DC, 60 cubic feet/minute each; four peripheral bays for hard drives; and a DC to DC, 48V switching power supply which delivers 350W, 5V at 50 amps, +12V at 10 amps, and 12V at 9 amps. I/O boards may be mounted in plenum or rear panel.





All System
Assemblies Are
Based On Standard
Europackaging
Subracks and
Enclosures—
Virtually Any Part
or Component Can
Be Modified to Meet
Special Needs

Ruggedly handsome, sturdily built Vector System Subrack Assemblies are equally appropriate on work tables and desktops. Based on standard parts, enclosure assemblies can be configured to meet a wide range of special needs. Call factory for information.

Standard Subrack Enclosures are supplied fully assembled; most units include power supply, subrack, fans, and backplane(s). Several backplane options: eightlayer monolithic backplane with on-board termination (combines J1 and J2), six-layer J1, and four-layer J2. J1 and J2 backplanes provide off board termination. Power supplies are matched to system requirements, filtered air flow design provides optimum thermal efficiency. Backplanes and card cages are completely removable for service. System enclosures are available in grey/grey or burgundy/ grey finishes.

SE2322

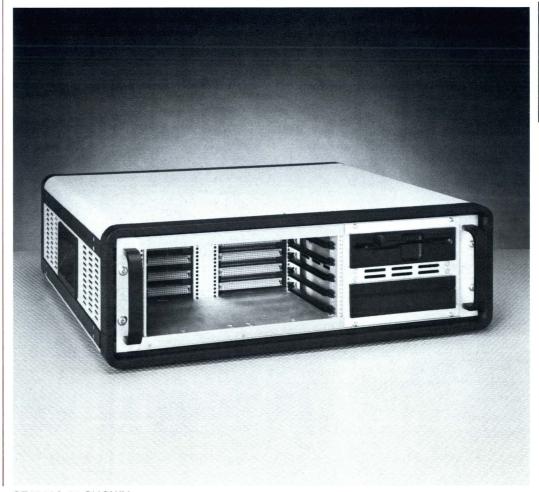
- Low-profile subrack system (3U height) with card guides and high-speed, five slot J1 and J2 backplanes installed horizontally
- Fully assembled, wired, and tested at factory
- Peripheral bay for mounting two half-height, 5 1/4" drives
- Capacity for mounting five, 6U X 160MM cards horizontally
- 175 watt switching power supply
- All electronic components mount within subrack
- Engineered for thermal efficiency: 12V DC fan with air filter and fan guard is mounted to sidewall
- Subrack system fits Vector Enclosure SE1322, available separately

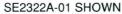
SE2322A-01

- Integrated Subrack Enclosure System: Vector SE2322 subrack assembly installed in attractive burgundy/grey enclosure (Vector Part No. SE1322A)
- Subrack is easily removable for servicing
- Perforated sidewalls provide excellent heat dispersion

SE2322B-01

- Integrated Subrack Enclosure System: Vector SE2322 subrack assembly installed in attractive grey/ grey enclosure (Vector Part No. SE1322B)
- Subrack is easily removable for servicing
- Perforated sidewalls provide excellent heat dispersion







SE2722

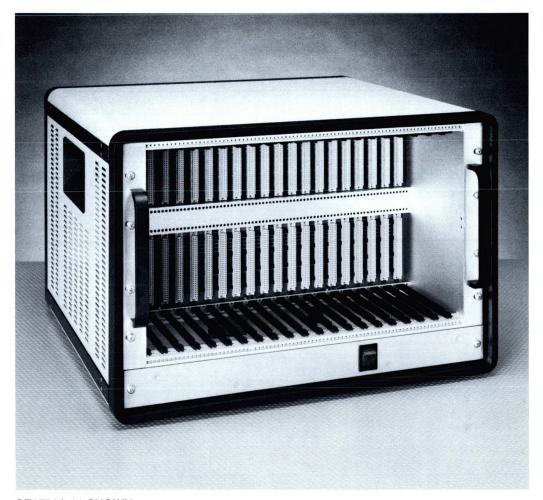
- 6U subrack system—fully assembled, wired, and tested at factory
- High-performance, 21-slot VME Monolothic Backplane (J1 and J2) and Power Bus Bar are factory-installed
- Capacity for mounting 21, 6U X 160MM cards plastic card guides are installed
- · 500 watt power supply
- Subrack system fits Vector Enclosure SE1722, available separately

SE2722A-01

- Integrated Subrack Enclosure System—Vector SE2722 subrack assembly installed in attractive burgundy/grey enclosure (Vector Part No. SE1722A)
- Engineered for thermal efficiency: perforated sidewalls provide excellent heat dispersion, installed 1U fan tray has three 12V DC fan units for optimum circulation

SE2722B-01

- Integrated Subrack Enclosure System—Vector SE2722 subrack assembly with attractive grey/grey enclosure (Vector Part No. SE1722B)
- Engineered for thermal efficiency: perforated sidewalls provide excellent heat dispersion, installed 1U fan tray has three 12V DC fan units for optimum circulation



SE2722A-01 SHOWN



Shielded Enclosure Rack Dimensions: 16.88" x 6.75" x 21.75"

SE2822:

16.88" Wide by 6.75" High by 21.75" Deep. All metal, fully enclosed system enclosure. All seals are metal-to-metal for excellent RF attenuation. Ideal for prototyping and limited production applications. This enclosure can be used to configure systems from standard Vector components —backplanes, power supplies, and cooling systems —for maximum flexibility and cost-effectiveness. Enclosure can be modified to accommodate I/O ports and to meet special re-

quirements. Fully assembled enclosure includes top, bottom, front, rear, and side panels. Mounting hardware also included. See Vector Part No. SE2822DH-1 for a representative example of a custom system built around the SE2822 enclosure.





Subrack Enclosures

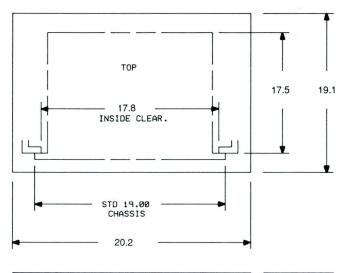
Vector Subrack Enclosures for 19" card cages are equally appropriate on desktop or worktable. Fully assembled, featuring recessed, side mount handles and lightweight aluminum construction. Cooling holes in side, rear, and bottom panels for maximum heat dispersion. Fans are mounted on sidewalls in SE1322 Enclosures. Mounting brackets are provided for mounting fan trays along top or bottom of cage in SÈ1722 enclosures. Enclosures available in burgundy/grey and grey/ grey. Protective rubber feet and hardware for mounting card cages included.

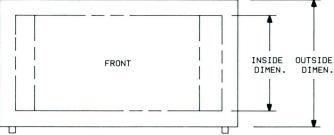
SE1322A,B:

Europackaging subracks CC Series 160-3U thru 340-3U and Card Cage Series 12, 13, and 14 (Except half width cages)

SE1722A,B:

Europackaging subracks CC Series 160-6U thru 340-6U and Card Cage Series 17,18, and 100







	He	Height		Width		Depth		
Part Number	Inside Dimension	Outside Dimension	Inside Dimension	Outside Dimension	Inside Dimension	Outside Dimension	Color	Subrack
SE1322A	5.2"	6.4"	17.8"	20.2"	17.5"	19.1"	Burg/Grey	CC Series 160-3U
SE1322B	5.2"	6.4"	17.8"	20.2"	17.5"	19.1"	Grey/Grey	thru 340-3U
SE1722A	12.2"	13.4"	17.8"	20.2"	17.5"	19.1"	Burg/Grey	CC Series 160-6U
SE1722B	12.2"	13.4"	17.8"	20.2"	17.5"	19.1"	Grey/Grey	thru 340-6U

For custom versions, consult factory



Vector DIN-Based Europackaging Subracks Are Versatile Prototyping And Production Tools

All products are designed in accordance with DIN 41914 specifications. Subracks are available in standard 19" widths or in 40 HP (8.36") and 20 HP (4.36") widths. Glass-filled Noryl card guides provide rigidity and lock in securely, vet can be installed and removed without special tools. Card guide mounting holes are positioned at each HP (0.2" centers) on T-struts. Other outstanding features include:

- All side panels deeper than 160MM include mounting holes for positioning front extrusions at 60MM increments
- Brushed aluminum construction
- 84 HP adapter strip allows mixing backplanes and DIN connectors
- DIN connectors, dress panels, cage handles, and decorative enclosures available separately
- Subrack assemblies and kits can be configured to custom specifications call factory for information

A Word About Part Numbers:

In this section, there are five basic types of subracks:

CCK = Card cage frame kit—easy assembly kits with hardware and instructions. Card guides and backplanes available separately.

CCA = Card cage assembly—factoryassembled version of CCK.

CCB = Card cage assembly—factoryassembled version of CCK with J1 or J2 backplane and card guides.

CCD = Card cage assembly—factoryassembled version of CCK with J1 and J2 backplanes and card guides.

CCP = Card cage assembly—factoryassembled version of CCK with monolithic backplane (J1 and J2) and card guides.

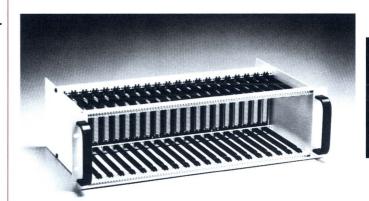
3U X 160MM Rack Dimensions: 19" x 5.21" x 9.44"

CCK160-3U

- Easy assembly subrack frame kit
- Accepts Vector glass-filled Noryl card guides, Part No. CG1-160, available separately
- Guide positions are variable at 0.2" increments

CCA160-3U

- Factory-assembled version of CCK160-3U
- Accepts Vector glass-filled Noryl card guides, Part No. CG1-160, available separately
- Guide positions are variable at 0.2" increments



CCA 160-3U SHOWN (Backplane, dress panels, and handles not included)



3U X 160MM Rack Dimensions: 19" x 5.21" x 9.27"

CCB160-3U2 (replaces C316EAA28)

- Factory-assembled version of CCK160-3U
- 12-slot J1 backplane installed
- 12 pairs of glass-filled Noryl card guides (Part No. CG1-160) are installed
- Guide positions are variable at 0.2" increments

CCB160-3U1 (replaces C316BAA42)

- Factory-assembled subrack verion of CCK160-3U
- 21-slot J1 backplane installed
- 21 pairs of glass-filled Noryl card guides (Part No. CG1-160) are installed
- Guide positions are variable at 0.2" increments



CCB160-3U2 SHOWN

3U X 220 MM Rack Dimensions: 19" x 5.21" x 11.63"

CCK220-3U

- Easy assembly subrack frame kit
- Accepts Vector glassfilled Noryl card guides, Part No. CG1-220, available separately
- Guide positions are variable at 0.2" increments

CCA220-3U

- Factory-assembled version of CCK220-3U
- Accepts Vector glassfilled Noryl card guides, Part No. CG1-220, available separately
- Guide positions are variable at 0.2" increments



CCK220-3U SHOWN



6U X 160 MM Rack Dimensions: 19" x 10.46" x 9.27"

CCK160-6U

- Easy assembly subrack frame kit
- Accepts Vector glass-filled Noryl card guides, Part No. CG1-160, available separately
- Guide positions are variable at 0.2" increments

CCK160-6UQ (formerly C160A6U5N)

- Easy assembly subrack frame kit, narrow-width version CCK160-6U
- Dimensions: 4.36" X 10.46" X 9.39"
- Accepts Vector 5-slot backplanes: Part Nos. VMEBP5J1 and VMEBP5J2, available separately
- Accepts Vector glassfilled Noryl card guides, Part No. CG1-160, available separately
- Guide positions are variable at 0.2" increments

CCK160-6UH (formerly C160A6U10N)

- Easy assembly subrack kit, half-width version of CCK160-6U
- Dimensions: 8.36" X 10.46" X 9.39"
- Accepts Vector 10-slot VME backplanes: Part Nos. VMEBP10J1 and VMEBP10J2, available separately
- Accepts Vector glassfilled Noryl card guides, Part No. CG1-160, available separately
- Guide positions are variable at 0.2" increments

CCA160-6U

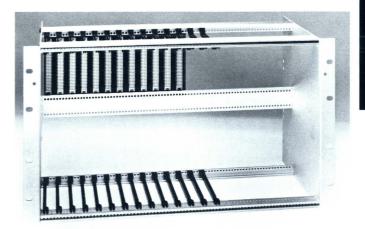
- Factory-assembled version of CCK160-6U
- Accepts Vector glassfilled Noryl card guides, Part No. CG1-160, available separately
- Guide positions are variable at 0.2" increments

CCB160-6U2 (replaces C616EAA28)

- Factory-assembled version of CCK160-6U
- 12-slot J1 backplane installed
- 12 pairs of glass-filled Noryl card guides installed
- Guide positions are variable at 0.2" increments

CCD160-6U2 (replaces C616EEA28)

- Factory-assembled version of CCK160-6U
- 12-slot J1 and J2 backplanes are installed
- 12 pairs of glass-filled Noryl card guides installed
- Guide positions are variable at 0.2" increments



CCB160-6U2 SHOWN



CCA160-6U SHOWN



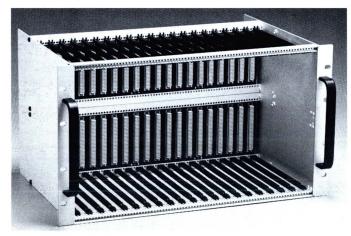
6U X 160MM Rack Dimensions: 19" x 10.46" x 9.27"

CCP160-6U2 (replaces C616PAA28)

- Factory-assembled version of CCK160-6U
- High-performance, 12-slot monolithic backplane (J1 and J2) installed
- 12 pairs of glass-filled Noryl card guides are installed
- Guide positions are variable at 0.2" increments

CCP160-6U1 (formerly C616PAA42)

- Factory-assembled version of CCK160-6U
- High-performance, 21-slot monolothic backplane (J1 and J2) installed
- 21 pairs of glass-filled Noryl card guides installed
- Guide positions are variable at 0.2" increments



CCP160-6U1 SHOWN (Handles and dress panels not included)

6U X 220MM Rack Dimensions: 19" x 10.46" x 11.63"

CCK220-6U

- Easy assembly subrack frame kit
- Accepts Vector glassfilled Noryl card guides, Part No. CG1-220, available separately
- Guide positions are variable at 0.2" increments

CCA220-6U

- Factory-assembled version of CCK220-6U
- Accepts Vector glassfilled Noryl card guides, Part No. CG1-220, available separately
- Guide positions are variable at 0.2" increments



CCA220-6U SHOWN



6U X 280MM Rack Dimensions: 19" x 10.46" x 14.00"

CCK280-6U

- Easy assembly subrack frame kit
- Accepts Vector glassfilled Noryl card guides, Part No. CG1-280, available separately
- Guide positions are variable at 0.2" increments

CCA280-6U

- Factory-assembled version of CCK280-6U
- Accepts Vector glassfilled Noryl card guides, Part No. CG1-280, available separately
- Guide positions are variable at 0.2" increments

6U X 340MM Rack Dimensions: 19" x 10.46" x 16.36"

CCK340-6U

- Easy assembly subrack frame kit
- Accepts Vector glassfilled Noryl card guides, Part No. CG1-340, available separately
- Guide positions are variable at 0.2" increments

CCA340-6U

- Factory-assembled version of CCK340-6U
- Accepts Vector glassfilled Noryl card guides, Part No. CG1-340, available separately
- Guide positions are variable at 0.2" increments

6U X 400MM Rack Dimensions: 19" x 10.46" x 18.72"

CCK400-6U

- Easy assembly subrack frame kit
- Accepts Vector glassfilled Noryl card guides, Part No. CG1-400, available separately
- Guide positions are variable at 0.2" increments

CCA400-6U

- Factory-assembled version of CCK400-6U
- Accepts Vector glassfilled Noryl card guides, Part No. CG1-400, available separately
- Guide positions are variable at 0.2" increments

9U X 220MM Rack Dimensions: 19" x 15.71" x 11.63"

CCK220-9U

- Easy assembly subrack frame kit
- Accepts Vector glassfilled Noryl card guides, Part No. CG1-220, available separately
- Guide positions are variable at 0.2" increments

CCA220-9U

- Factory-assembled version of CCK220-9U
- Accepts Vector glassfilled Noryl card guides, Part No. CG1-220, available separately
- Guide positions are variable at 0.2" increments

9U X 280MM Rack Dimensions: 19" x 15.71" x 14.00"

CCK280-9U

- Easy assembly subrack frame kit
- Accepts Vector glassfilled Noryl card guides, Part No. CG1-280, available separately
- Guide positions are variable at 0.2" increments

CCA280-9U

- Factory-assembled version of CCK280-9U
- Accepts Vector glassfilled Noryl card guides, Part No. CG1-280, available separately
- Guide positions are variable at 0.2" increments

9U X 340MM Rack Dimensions: 19" x 15.71" x 16.36"

CCK340-9U

- Easy assembly subrack frame kit
- Accepts Vector glassfilled Noryl card guides, Part No. CG1-340, available separately
- Guide positions are variable at 0.2" increments

CCA340-9U

- Factory-assembled version of CCK340-9U
- Accepts Vector glassfilled Noryl card guides, Part No. CG1-340, available separately
- Guide positions are variable at 0.2" increments

9U X 400MM Rack Dimensions: 19" x 15.71" x 18.72"

CCK400-9U

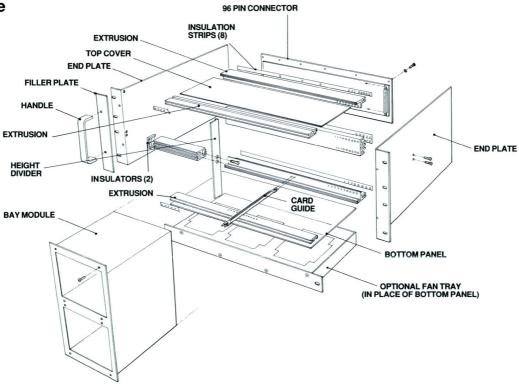
- Easy assembly subrack frame kit
- Accepts Vector glassfilled Noryl card guides, Part No. CG1-400, available separately
- Guide positions are variable at 0.2" increments

CCA400-9U

- Factory-assembled version of CCK400-9U
- Accepts Vector glassfilled Noryl card guides, Part No. CG1-400, available separately
- Guide positions are variable at 0.2" increments



Parts Guide



Fan Trays

Vector Fan Trays, with 12V DC fans, are fully assembled, factory-tested. and fit into all standard 19" racks. Highly reliable fans supply airflow at 60 cubic feet/minute. All fan trays feature solid state, brushless fan motors, and include DC mating connector housing and pins. All electrical components and finger-guard covers are UL approved or UL recognized. Flame retardant construction. Instructions included. 12V DC fans, supplying airflow at 90 cubic feet/minute, are available per special order. FT1U-1: One fan, 19" x 1.71" x 7.75"

FT1U-2: Two fans, 19" x 1.71" x 7.75"

FT1U-3: Three fans, 19" 1.71" x 7.75"

FT1U-4: Four fans, 19" x 1.71" x 12.95"

FT1U-5: Five fans, 19" x 1.71" x 12.95"

FT1U-6: Six fans, 19" x 1.71" x 12.95"

Peripheral Bay Modules

Easy assembly Vector Peripheral Bay Module Kits for 3 1/2" and 5 1/4" hard disk drives, floppy drives, and tape drives. Brushed aluminum finish. Designed for mounting with standard Vector card guides.

Assembly and mounting hardware included.

PB160-3U-1

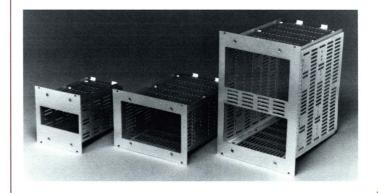
 Fits CC Series 160-3U card cages—accepts 3 1/2" drives

PB220-3U-1

 Fits CC Series 220-3U card cages—accepts 5 1/4" drives

PB220-6U-1

 Fits CC Series 220-6U card cages—accepts 5 1/4" drives





Card Guides

Specially designed card guides provide easy installation, repositioning, and removal of cards without special tools, and without damage to cards. Constructed from glassfilled Noryl material.

- For 160MM and 220MM sizes, guides are one piece
- For card sizes greater than 220MM, card guides and end pieces are supplied separately
- · Packages of 4
- For non-metric card guides, see Vector-Pak Card Guides (CG2 series), for other sizes see Lumber Yard Extrusion Parts

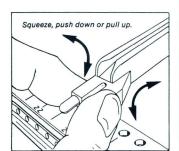
CG1-160: 160MM Card Guide

CG1-220: 220MM Card Guide

CG1-280U: 280MM Card Guide

CG1-340U: 340MM Card Guide

CG1-400U: 400MM Card Guide



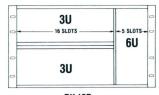
Dividers

Vector Divider Kits provide a unique method for mixing cards of different heights or depths within the same card cage. Height divider kits are related to backplane slots, not horizon-tal pitch, all backplane slots remain functional. For example, a DK16R height divider kit partitions a 6U card cage into three card sections: two 16-slot, 3U sections on the right side and one 5-slot, 6U section on the left. Height dividers may be oriented to right or left side of card cage. Depth dividers also are related to backplane slots, no slot is lost. For example, a DK280-5L depth divider kit in a 9U X 280MM card cages partitions the cage into two card sections: one 5-slot 280MM section on the left and one 16-slot 160MM or 220MM section on the right. Vector Dividers are available in kit form or as separate panels. Mounting hardware provided with kits.

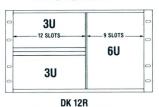
HEIGHT DIVIDERS



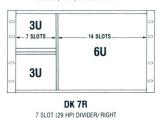
DK 21 21 SLOT FULL DIVIDER



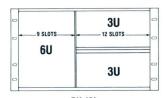
DK 16R 16 SLOT (65 HP) DIVIDER/ RIGHT



12 SLOT (49 HP) DIVIDER/ RIGHT



DK 16L 16 SLOT (64 HP) DIVIDER/LEFT



DK 12L 12 SLOT (48 HP) DIVIDER/ LEFT



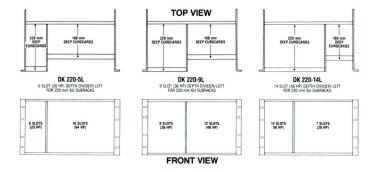
DK 7L 7 SLOT (28 HP) DIVIDER/LEFT

Height Dividers

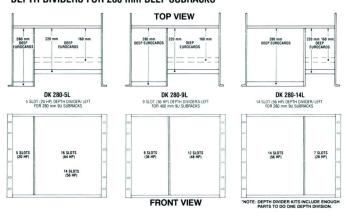
Part No.	Description	Applicable Subrack
DK21	Full Divider	CC Series 160-6U, 220-6U, 280-9U, 400-9U
DK16R	16 Slot Divider/Right	
DK16L	6 Slot Divider/Left]
DK12R	12 Slot Divider/Right	CC Series 160-6U,
DK12L	12 Slot Divider/Left	220-6U
DK7R	7 Slot Divider/Right]
DK7L	7 Slot Divider/Left	



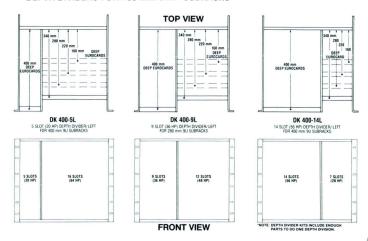
DEPTH DIVIDERS FOR 220 mm DEEP SUBRACKS



DEPTH DIVIDERS FOR 280 mm DEEP SUBRACKS



DEPTH DIVIDERS FOR 400 mm DEEP SUBRACKS



Depth Dividers

Part No.	Description	Applicable Subrack
DK220-5L	5 Slot, 220mm, 6U Left	
DK220-9L	9 Slot, 220mm, 6U Left	CC Series 220-6U
DK220-14L	14 Slot, 220mm, 6U Left	
DK280-5L	5 Slot, 280mm, 9U Left	
DK280-9L	9 Slot, 280mm, 9U Left	CC Series 280-9U
DK280-14L	14 Slot, 280mm, 9U Left	
DK400-5L	5 Slot, 400mm, 9U Left	
DK400-9L	9 Slot, 400mm, 9U Left	CC Series 400-9U
DK400-14L	14 Slot,400mm, 9U Left	

Divider Panels

Part No.	Description					
5260258	6U x 160mm Depth Divider Panel					
5250231	6U x 220mm Depth Divider Panel					
5260256	6U x 280mm Depth Divider Panel					
5260241	6U x 340mm Depth Divider Panel					
5260244	6U x 400mm Depth Divider Panel					
5260259	9U x 160mm Depth Divider Panel					
5260257	9U x 220mm Depth Divider Panel					
5260293	9U x 280mm Depth Divider Panel					
5260242	9U x 340mm Depth Divider Panel					
5260296	9U x 400mm Depth Divider Panel					

Width Dividers

Part No.	Description
5260232	6U Width Divider Panel
5260263	9U Width Divider Panel

Front Panels for Printed Circuit Boards FP04, FP08

Screw-mounted front panel kits include handle and identification panel. Ideal for mounting I/O connectors, LEDs, and other components to front of subrack. Can be used to cover empty card slots. Available in 3U, 6U, and 9U heights and in two widths: 4HP (0.788") and 8HP (1.588"). All mounting hardware, including board mounting support bracket and hardware, also included. Brushed aluminum panel with clear chem film plating matches standard finish for Vector packaging products.

Front Panels for **Printed Circuit Boards**

Part No.	Width	Height
FP04-3U	0.788"	5.06"
FP08-3U	1.588"	5.06"
FP04-6U	0.788"	10.31"
FP08-6U	1.588"	10.31"
FP04-9U	0.788"	15.56"
FP08-9U	1.588"	15.56"

Filler Panels FP-3U, FP-6U, FP-9U

Filler panels mount over subrack flanges to provide a "finished" look to subracks and cage front panels. .388" width, available in 3U, 6U, and 9U heights. Brushed aluminum with clear chem film finish matches standard Vector packaging products. Mounting hardware included.

Side Panels

Vector Europackaging Side Panels feature brushed aluminum construction with clear chem film finish. Sizes from 3U x 160mm to 9U x 400mm, in three versions:

With Flanges: Provides front mounting surface

Universal: Versatile sidewall with flanges—strut mounting holes positioned on 12mm centers for maximum flexibility.

Flangeless: For maximum economy of space.







3U X 160

5260475: Flangeless 5260251: With Flanges

3U X 220

5260476: Flangeless 5260252: With Flanges

3U X 280

5260477: Flangeless 5260264: With Flanges

6U X 160

5260267: Flangeless 5260204: With Flanges

6U X 220

5260266: Flangeless 5260312: Universal 5260212: With Flanges

6U X 280

5260472: Flangeless 5260289: Universal 5260247: With Flanges

6U X 340

5260473: Flangeless 5260239: With Flanges

6U X 400

5260474: Flangeless 5260309: Universal 5260243: With Flanges

9U X 160

5260467: Flangeless 5260249: With Flanges

9U X 220

5260468: Flangeless 5260311: Universal 5260248: With Flanges



9U X 280

5260469: Flangeless 5260291: Universal 5260294: With Flanges

9U X 340

5260470: Flangeless 5260240: With Flanges

9U X 400

5260471: Flangeless 5260308: Universal 5260299: With Flanges



Top/Bottom Covers AC160, AC220, AC280, AC340, AC400

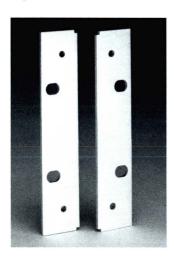
Top and Bottom Panels provide maximum protection for card cage interiors. Perforated to ensure proper ventilation, constructed from 0.062" aluminum, satin finish with clear chem film plating. Covers slide into T-Strut grooves, no mounting hardware required.

Top/Bottom Covers

Part No.	Width	Height
AC160-84-1	16.98"	4.93"
AC220-84-1	16.98"	7.29"
AC280-84-1	16.98"	9.65"
AC340-84-1	16.98"	12.01"
AC400-84-1	16.98"	14.37"

Dress PanelsDP

Dress Panels provide an attractive, finished look for Vector Card Cages. Mounting hardware included.



Dress Panels

DP-3U	For 3U Subrack 5.21" high x 1.10" wide
DP-6U	For 6U Subrack 10.45" high x 1.10" wide
DP-9U	For 9U Subrack 15.70" high x 1.10" wide

Accessories

Handles HA19

Functional and attractive, card cage handles mount easily, securely. Mounting hardware included.

H	landle	
F	IA19-3U	Handle for 3U subrack - 4" mount- ing centers, 8-32 tapped holes
F	IA19-6U	Handle for 6U - 6" mounting centers, 8-32 tapped holes
F	łA19-9U	Handle for 9U subrack - 11" mounting centers, 8-32 tapped holes

Hardware

Vector provides a wide selection of hardware and accessories for performing modifications and meeting special requirements.

Cubrook	Hardware
Subrack	naruware

80880107	Screw, 8-32 x .625, Pan Head
88000106	Screw, 2.5mm x .45mm x 10mm, Pan Head
84004006	Washer, Flat, DIN # 125
5700209	ID Strip, Adhesive Backed Mylar
5210218	Spacer, Extrusion Front
5210208	Strip, Insulation

Nut Strips

An extremely functional packaging tool. Threaded mounting holes spaced at 0.2" centers slide into strut grooves, can be used to anchor panels, cards, or other components. Use on front or rear struts for any Europackaging subrack.

5700202	85HP Nut Strip, 17" Wide
5250268-63	63HP Nut Strip, 12.8" Wide
5250268-42	42HP Nut Strip, 8.6" Wide
525068-21	21HP Nut Strip, 4.4" Wide

Adapter Strip

Adapter strip for mounting DIN connectors on subrack with 84 tapped holes (2.5mm x 4.5mm pitch). Pkg 2



The Vector-Pak® line of subracks for non-metric packaging requirements— a complete selection of subracks for prototyping and short production runs

Designed for mounting in 19" racks, these units are equally appropriate on desktop or worktable. Available factory-assembled or as easy assembly kits. All Vector-Pak® subracks are constructed from sturdy, brushed anodized or chem filmed aluminum and feature:

- Extruded aluminum struts, adjustable four ways (up, down, forward, back)
- Marker strips for quick card positioning and identification
- Three card mounting methods:

FIXED: Zinc, aluminum or plastic guides installed, usually on 0.75" centers CONTINUOUS: Aluminum card guide plates with guide slots on 0.15" centers

VARIABLE: Snap-in card guides are mounted into holes positioned at 0.25" centers

 Complete selection of accessories available: including front and rear panels, covers, enclosures, and handles

A Word About Part Numbers:

In this section, part numbers indicate the basic categories of subracks:

CCK = Card Cage Kit easy assembly, hardware provided.

CCA = Card Cage Assembly—factory assembled version of CCK.

CCA and CCK subracks are available in several configurations: frame kits; kits and assemblies with fixed, continuous, or variable position card guides; and kits and assemblies with backplane and card guides.

ccm = Assembled card cage designed for cards at 1" spacing intervals or for Cardmount Modules. These cages use standard (0.062") card guides spaced at intervals of 1". Cardmount modules provide shielding, especially from heat, and rigidity for printed circuit cards. Front panel can be used for cutouts and labeling, or for switches and other components.

CMA = Factory-assembled card cage, designed for EFP modules, with module mounting guides. EFP modules provide excellent shielding; and slots within modules can be used for mounting printed circuit cards. Front and rear panels provide for mounting instruments and components.

The number that follows these three-letter designations indicates the size of card for which the subrack has been designed:

Series 12 = For 4.5" height cards with nominal widths of 4.5". Maximum recommended card width is 5".

Series 13 = For 4.5" height cards with nominal widths of 6.5". Maximum recommended card width is 7".

Series 14 = For 4.5" height cards with nominal widths of 9.6". Maximum recommended card width is 10".

Series 15 = For 6.25" height cards with nominal widths of 9.6". Maximum recommended card width is 10".

Series 17 = For 8" height cards with nominal widths of 9.6". Maximum recommended card width is 10".

Series 18 = For 9.75" height cards with nominal widths of 13.5". Maximum recommended card width is 14".

Series 100 = For 10" height cards with nominal widths of 5.3" (designed for S100). Maximum recommended card width is 8.5".

Vector-Pak® Non-metric Card Cages

Ass		ss'y Dimensions			Car	d Size	Card Guides			
Part No.	Kit	Width	Height	Depth	Height	Width	Туре	Number	r Backplane	
CCK12S	K	19	5.25	9	4.5	3.0 to 5.0	Nylon, press-in	42		
CCK12S-H	K	10.25	5.25	9	4.5	3.0 to 5.0	Nylon, press-in	22		
CCK13F	K	19	5.25	9	4.5	5.5 to 7.0				
CCK13S	K	19	5.25	9	4.5	5.5 to 7.0	Nylon, press-in	42		
CCK13S-16	K	19	5.25	9	4.5	5.5 to 7.0	Nylon, press-in	42	16-slot STD	
CCA13S	Α	19	5.25	9	4.5	5.5 to 7.0	Nylon, press-in	42		
CCA13M	Α	19	5.25	9	4.5	5.5 to 7.0	Zinc, riveted	42		
CCA13C	Α	19	5.25	9	4.5	5.5 to 7.0	Aluminum, continuous			
CCM13S	A	19	5.25	9	4.5	5.5 to 7.0	Nylon, press-in	32		
CMA13-16	Α	19	5.25	9	4.5	7.0	EFP module, fixed 1.6"	20		
CMA13-20	Α	19	5.25	9	4.5	7.0	EFP module, fixed 2.0"	16		
CCK13S-H	K	10.25	5.25	9	4.5	5.5 to 7.0	Nylon, press-in	22		
CCK13S-HT	K	8.12	5.25	8.12	4.5	5.5 to 7.0	Nylon, press-in	20		
CCK13S-HT8	K	8.12	5.25	8.12	4.5	5.5 to 7.0	Nylon, press-in	20	8-slot STD	
CCK14F	K	19	5.25	12	4.5	8.6 to 10.1				
CCA14S	Α	19	5.25	12	4.5	8.6 to 10.1	Plastic, riveted	42		
CCM14S	Α	19	5.25	12	4.5	8.6 to 10.1	Nylon, press-in	32		
CMA14-16	Α	19	5.25	12	4.5	10.0	EFP module, fixed 1.6"	32		
CMA14-20	Α	19	5.25	12	4.5	10.0	EFP module, fixed 2.0"	16		
CMA14-30	Α	19	5.25	12	4.5	10.0	EFP module, fixed 3.0"	10		
CCK15F	K	19	7	12	6.25	8.6 to 10.1				
CCM15S	Α	19	7	12	6.25	8.6 to 10.1	Nylon, press-in 32			
CCK17F	K	19	8.75	12	8.0	8.6 to 10.1				
CCA17S	Α	19	8.75	12	8.0	8.6 to 10.1	Nylon, press-in 42			
CCK18F	K	19	10.50	15.75	9.75	11.0 to 13.5				
CCK100S	K	19	12.25	9	10.0	4.0 to 8.5	Nylon, press-in	42		



For 4.5" High Cards

4.5" Nominal Width For Cards Up to 5" Wide Rack Dimensions: 19" x 5.25" x 9"

CCK12S (formerly CCK13AS)

- · Easy assembly subrack kit
- 21 pairs of nylon, snap-in card guides
- Guide positions are variable at 0.25" increments

CCK12S-H (formerly CCK135AS)

- Dimensions: 10.25" x 5.25" x 9"
- Easy assembly subrack kit, narrow-width version of CCK12S
- 11 pairs of nylon, snap-in card guides included
- Guide positions are variable at 0.25" increments



For 4.5" High Cards

6.5" Nominal Width For Cards Up to 7" Wide Rack Dimensions: 19" x 5.25" x 9"

CCK13F (formerly CA52HP89)

- Easy assembly subrack frame kit
- Slotted sidewalls provide horizontal and vertical adjustability for struts
- Accepts snap-in card guides (CG2-65S), available separately, which provide guide positioning at 0.25" increments
- Also accepts screw-mount (CG2-65M, CG2-65P) card guides, available separately; guide positions variable along entire length of strut
- Accepts Cardmount Modules (CM45A65 series), available separately

CCK13S

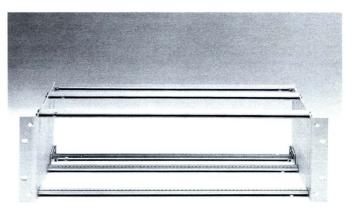
- · Same as CCK13F
- 21 pairs of nylon, snap-in card guides included
- Guide positions are variable at 0.25" increments

CCK13S-16 (formerly CCK13SMB16)

- · Same as CCK13F
- Factory-assembled, 16-slot STD Bus backplane and 21 pairs of nylon, snap-in card guides included
- Guide positions are variable at 0.25" increments

CCA13S (replaces CCK13P, now available as specialorder CCA13P)

- Factory-assembled version of CCK13F
- 21 pairs of nylon, snap-in card guides installed on 0.075" centers
- Guide positions are variable at 0.25" increments



CCK13F SHOWN ASSEMBLED



For 4.5" High Cards

6.5" Nominal Width For Cards Up To 7" Wide Rack Dimension: 19" x 5.25" x 9"

CCA13M (formerly CCK13)

- Factory-assembled version of CCK13F
- 21 pairs of fixed-position, zinc card guides installed on 0.75" centers
- Zinc card guides provide excellent card retention and security

CCA13C (formerly CCK3)

- Factory-assembled version of CCK13F
- Continuous card guide installed, allows placement of cards on continuous 0.15" centers

CCM13S (replaces CCM14A, now available as specialorder CCM14P)

- Factory-assembled version of CCK13F
- Designed for Cardmount Modules (Part No. CM45A65), which provide for mounting cards of any thickness, and for miscellaneous component mounting
- 16 pairs of nylon, snap-in card guides installed at 1" intervals
- Guide positions are variable at 0.25" increments

CMA13-16 (formerly CMA3A16)

- Factory-assembled version of CCK13F, designed for mounting EFP modules (Part No. EFP164A66)
- 10 pairs of fixed-position, aluminum module guides spaced at 1.6" centers installed

CMA13-20 (formerly CMA3A20)

- Factory-assembled version of CCK13F, designed for mounting EFP modules (Part No. EFP204A66)
- 8 pairs of fixed-position, aluminum module guides spaced at 2" centers installed

CCK13S-H (formerly CCK135S)

- Dimensions: 10.25" x 5.25" x 9"
- Easy assembly subrack kit, narrow-width version of CCK13F
- 11 pairs of nylon, snap-in card guides included
- Guide positions are variable at 0.25" increments

CCK13S-HT (formerly CCK19S)

- Dimensions: 8.12" x 5.25" x 8.12"
- Easy assembly, narrowwidth version of CCK13F with flangeless sidewalls
- Ideal for STD Bus applications, but can be used for any 4.5" x 6.5" cards
- 10 pairs of nylon, snap-in card guides included
- Guide positions are variable at 0.25" increments

CCK13S-HT8 (formerly CCK19SMB8)

- Dimensions: 8.12" x 5.25" x 8.12"
- · Same as CCK13S-HT
- Factory-assembled, 8-slot STD Bus backplane and 10 pairs of nylon, snap-in card guides included
- Guide positions are variable at 0.25" increments



CCA13C SHOWN



CMA13-16 SHOWN





For 4.5" High Cards

9.6" Nominal Width For Cards Up to 10" Wide Rack Dimensions: 19" x 5.25" x 12"

CCK14F (formerly CA52HP119)

- Easy assembly subrack frame kit
- Slotted sidewalls provide horizontal and vertical adjustability for struts
- Accepts snap-in card guides (CG2-80S, CG2-95S), available separately, which provide guide positioning at 0.25" increments
- Also accepts screw-mount (CG2-80M, CG2-80P, CG2-95P) card guides, available separately; guide positions are variable along entire length of strut
- Accepts Cardmount Modules (CM45B95 series) available separately

CCA14S (replaces CCK14P, now available as specialorder CCA14P)

- Factory-assembled version of CCK14F
- 21 pairs of nylon, snap-in card guides installed on 0.075" centers
- Guide positions are variable at 0.25" increments

CCM14S (replaces CCM14B, now available as specialorder CCM14P)

- Factory-assembled version of CCK14F
- Designed for Cardmount Modules (CMA45B95-1), which provide for mounting cards of any thickness, and for miscellaneous component mounting
- 16 pairs of nylon, snap-in card guides installed at 1" intervals
- Guide positions are variable at 0.25" increments

CMA14-16 (formerly CMA4A16)

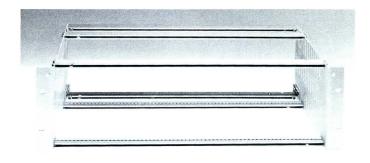
- Factory-assembled version of CCK14F, designed for mounting EFP modules (EFP164A97)
- 10 pairs of fixed-position, aluminum module mounting guides spaced at 1.6" centers installed

CMA14-20 (formerly CMA4A20)

- Factory-assembled version of CCK14F, designed for mounting EFP modules (EFP204A97)
- 8 pairs of fixed-position, aluminum module mounting guides spaced at 2" intervals installed

CMA14-30 (formerly CMA4A30)

- Factory-assembled version of CCK14F, designed for mounting EFP modules (EFP304A97)
- 5 pairs of fixed-position, aluminum module mounting guides spaced at 3" intervals installed



CCK14F SHOWN ASSEMBLED



CMA14-16 SHOWN



For 6.25" High Cards

9.6" Nominal Width For Cards Up to 10" Wide Rack Dimensions: 19" x 7" x 12"

CCK15F (formerly CA69HP119)

- Easy assembly subrack frame kit
- Slotted sidewalls provide maxium horizontal and vertical adjustability for struts
- Accepts snap in card guides (CG2-80S, CG2-95S), available separately, which provide guide positioning at 0.25" increments
- Also accepts screw-mount (CG2-80M, CG2-80P, CG2-95P) card guides, available separately; guide positions are variable along entire length of strut
- Accepts Cardmount Modules (CM62B95 series), available separately

CCM15S (replaces CCM14F, now available as specialorder CCM15P)

- Factory-assembled version of CCK15F
- Designed for Cardmount Modules (CM62F95-1), which provide for mounting cards of any thickness, and for miscellaneous component mounting
- 16 pairs of nylon, snap-in card guides are installed at 1" intervals
- Guide positions are variable at 0.25" increments



9.6" Nominal Width For Cards Up to 10" Wide Rack Dimensions: 19" x 8.75" x 12"

CCK17F (formerly CA87HP119)

- Easy assembly subrack frame kit
- Slotted sidewalls provide maximum horizontal and vertical adjustability
- Accepts snap-in card guides (CG2-80S, CG2-95S), available separately, which provide guide positioning at 0.25" increments
- Also accepts screw-mount (CG2-80M, CG2-80P, CG2-95P) card guides, available separately; guide positions are variable along entire length of strut

CCA17S (formerly CCK17P, now available as specialorder CCA17P)

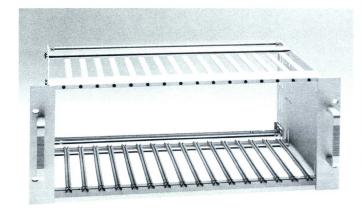
- Factory-assembled version of CCK17F
- 21 pairs of nylon, snap-in card guides installed on 0.075" centers
- Guide positions are variable at 0.25" increments

For 9.75" High Cards

13.5" Nominal Width For Cards Up To 14" Wide Rack Dimensions: 19" x 10.5" x 15.75"

CCK18F (formerly CA104HP156)

- Easy assembly subrack frame kit
- Slotted sidewalls provide maximum horizontal and vertical adjustability for struts
- Accepts snap-in card guides (CG2-80S, CG2-95S), available separately, which provide guide positioning at 0.25" increments
- Also accepts screw-mount (CG2-80M, CG2-80P, CG2-95P) card guides, available separately; guide positions are variable along entire length of strut



CCM15S SHOWN



For 10" Wide Cards

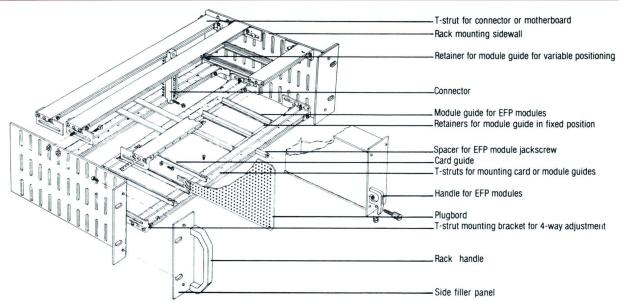
5.3" Nominal Width For Cards Up to 8.5" Wide Rack Dimensions: 19" x 12.25" x 9"

CCK100S (formerly CCK100)

Designed for S100 Bus (IEEE696), Motorola Exorciser™, Micromodule™, or General Purpose Applications

- · Easy assembly subrack kit
- Accepts S100 BUS backplane (8803-6-1A, 8803-12-1A, 8803-18-1A), available separately
- 21 pairs of nylon, snap-in card guides included
- Guide positions are variable at 0.25" increments





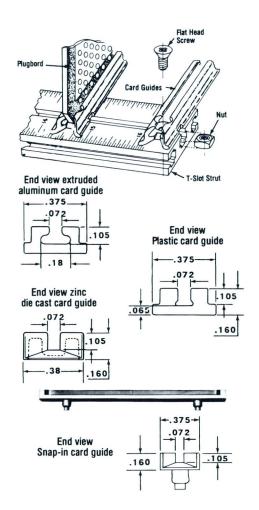
Card Guides for Subracks

High-quality card guides with tapered slots for easy insertion. Screw-mounted models are available in metal or plastic and provide variable positioning along entire length of strut. Snap-in nylon models provide easy installation and removal—without tools—and can be positioned at 0.25" increments when used with Vector-Pak® T-struts.

Holes for mounting guides to struts are based on center-to-center multiples of 0.75", which matches slot positions on Vector SWP sidewalls. All materials are flame retardant. Mounting hardware included.

Rack or Panel Mounted Card Guides

Part No.	Туре	Length	Centers	Card Length	Application
CG2-45P	Plastic, Screw	2.89	2.25	4.50"	
CGP-45S	Nylon, Snap-in	3.17	2.25	4.50"	Subrack series 12, 13,
CG2-50P	Plastic, Screw	4.39	3.75	5.00"	14, 17, 18 & 100 &
CG2-65M	Metal, Screw	5.42	4.50	6.50"	Vector P series sidewalls
CG2-65P Plastic, Screw	Plastic, Screw	5.42	4.50	6.50"	
CG2-65S	Nylon, Snap-in	5.42	4.50	6.50"	
CG2-80M	Metal, Screw	6.64	6.00	8.00"	
CG2-80P	Plastic, Screw	6.64	6.00	8.00"	Subrack series 14, 15, 17, 18 & 100 &
CG2-80S	Nylon, Snap-in	6.93	6.00	8.00"	Vector P series sidewalls
CG2-95P	Plastic, Screw	8.14	7.50	9.50"	ending in 119 or 156
CG2-95S	Nylon, Snap-in	8.43	7.50	9.50"	

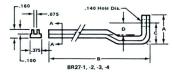




Free Standing Connector Mounted Card Guides BR27

Secure connection, rugged support for 0.062" thick, free standing circuit boards. For applications in which space is at a premium. Several sizes and styles available. Aluminum alloy construction. Mounting hardware included.

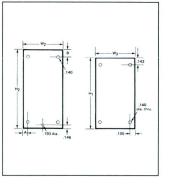




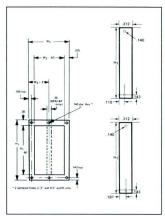
Card Modules EFP Modules

EFP Modules are designed for packaging circuit boards and for insertion into Vector CMA Series module racks. Modules mount securely into cages with jack screw on front panel. All aluminum. brushed anodized finish. easy assembly kits use aluminum frame-loc rails for top and bottom panels; grooves in these panels are used to locate and support one or more 0.062" boards. Card stops are provided for securing boards of varying lengths. Three rear panel treatments: full cover, strip cut-out ("E" type), and full cut-out ("F" type). Instructions and mounting hardware included. Module handles available separately.









Free Standing Card Guides Connector Mounted

The standing said saides connector insuring										
Part No.	Use With Connector	Α	В	С	D	For Use With				
BR27D	R644 R644-1	.60	2.96	.47	.25	4.5" wide Plugbords with centered contacts, such as Vector 3677, 3682 & 3662 series.				
BR27-1	R636 R636-1	.49	3.08	.35	.13	4.5" wide Plugbords with centered contacts such as Vector 3719 series.				
BR27-1	R644 R644-1 R644-3	.49	3.08	.35	.13	4.25" wide Plugbords with centered contacts.				
BR27-3	R630	.49	3.01	.36	.10	2.73" wide Plugbords with centered contacts such as Vector 3796 & 3797 series.				
BR27-5	R656-1	.55	3.00	.42	.22	4.48" wide Plugbords with centered contacts, such as Vector 4610-1.				

EFP Module Ordering Table

Kit with Full Rear Panel	Kit with F Type Rear Panel	Kit with E Type Rear Panel	Body Size Figure 8					Recomm. Card Size		Module Rack
Part No.	Part No.	Part No.	W1	H1	L	W2	H2	Ht	Lth	
EFP164A66	EFP164A66F	EFP164A66E	1.6	4.62	6.69	1.65	5.23	4.5	6.5	CMA13-16
EFP164A97	EFP164A97F	_	1.6	4.62	9.8	1.65	5.23	4.5	9.6	CMA14-16
EFP204A66	EFP204A66F	EFP204A66E	2.0	4.62	6.69	2.05	5.23	4.5	6.5	CMA13-20
EFP204A97	EFP204A97F	EFP204A97E	2.0	4.62	9.8	2.05	5.23	4.5	9.6	CMA14-20
EFP304A66	_	_	3.0	4.62	6.69	3.05	5.23	4.5	6.5	CCK13F
EFP304A97	EFP304A97F	_	3.0	4.62	9.8	3.05	5.23	4.5	9.6	CCK14F
EFP454A66	_	_	4.5	4.62	6.69	4.55	5.23	4.5	6.5	CCK13F
EFP454A97	_	_	4.5	4.62	9.8	4.55	5.23	4.5	9.6	CCK14F

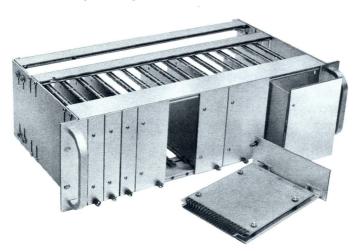


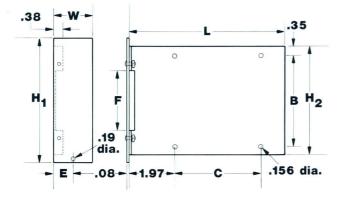
Cardmount Modules

Ideal for applications requiring front panel component mounting, increased rigidity, or varying card thicknesses. Cardmount panel, 0.062" thick, slides into standard Vector-Pak® card guides.

Removable front panel for convenient punching

and/or screening. Easy insertion and removal using 10/32 jack screws. Constructed from brushed anodized aluminum materials. Fixed-position plastic or snap-in nylon card guides are available separately or with Vector-Pak® CCM Subracks.



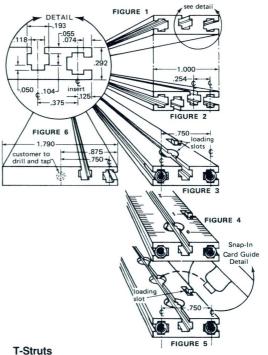


Card Mount Modules

Part No.	Hei H1	ight H2	Width W	Length L	В	С	E	F	Module Rack	Card Guide
CM45A65-1	5.25	4.5	1.0	6.57	3.8	3.6	0.5	2.5	CCM13S	CG2-65
CM45B95-1	5.25	4.5	1.0	9.57	3.8	6.6	0.5	4.2	CCM14S	CG2-95
CM45A65-2	5.25	4.5	2.0	6.57	3.8	3.6	0.5	2.5	CCM13S	CG2-65
CM45B95-2	5.25	4.5	2.0	9.57	3.8	6.6	0.5	4.2	CCM14S	CG2-95
CM62F95-2	7.0	6.25	2.0	9.57	5.5	6.6	0.5	4.2	CCM15S	CG2-95
CM45A65-4	5.25	4.5	4.0	6.57	3.8	3.6	0.5	2.5	CCM13S	CG2-65
CM45B95-4	5.25	4.5	4.0	9.57	3.8	6.6	0.5	4.2	CCM14S	CG2-95

T-Struts

Vector T-Struts can be used for custom assemblies or to fit existing cage assemblies. Available with either three or four nut slots, and with or without inserts (brass or plastic) for retaining mounting screws. As an alternative, mounting brackets (BR16A, available separately) may be used to attach struts to cages.



Part No. Length		End Insert	Scale Printed	Fastening Method	Fig
TS81	8.12	none	no	Brackets or end inserts	1
TS81-5	8.12	4 brass	no	Direct 6-32 screw mounting	5
TS81N4	8.12	4 brass	no	Direct 6-32 screw mounting	4
TS169	16.85	none	no	Brackets or end inserts	1
TS169A	16.85	none	no	Brackets or end inserts	2
TS169P	16.85	none	yes	Brackets or end inserts	1
TS169-4	16.85	4 brass	no	Direct 6-32 screw mounting	3
TSW169-4	16.85	4 brass	no	Direct 6-32 screw mounting	6
TS169-6	16.85	4 brass	no	Direct 6-32 screw mounting	5
TS169NP4	16.85	4 brass	yes	Direct 6-32 screw mounting	4
TS209	20.85	none	no	Brackets or end inserts	1
TS300	30.00	none	no	Raw stock	1
TS300A	30.00	none	no	Raw stock	2
TSW300	30.00	none	no	Raw stock	6
TS600	60.00	none	no	Raw stock/pkg. 4	1

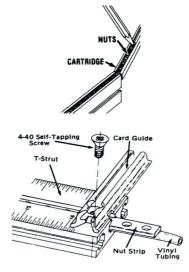


T-Struts

Part Mounting Hardware NT4, SC4

Vector NT4-7PA square nuts slide into T-strut slots and anchor 4-40 screws for mounting parts. Supplied in quantities of 25, packaged in easy-loading cartridges.

Vector Nut Strips, NT4-3 and NT4-9, slide into T-strut slots with vinyl tubing (included) to anchor 4-40 self-tapping screws. Available with 0.25" and 0.2" hole spacing.

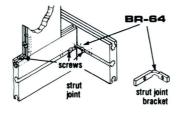


Hardware For Attaching Parts To T-Struts

Part No.	Description	Size	Pkg. Qty.	Ref. Fig.
NT4-3	Nut strip with holes on .25" centers	.175" x 16.50"	6	3
NT4-9	Nut strip with holes on .20" centers	.175" x 16.50"	6	3
NT4-10	Front entry nut for loading slot	.175" x .60"	12	1
NT4-7PA	4-40 sq. nuts in strut loading cartridge		25	2
SC4-27/25	4-40 100° flat head screw	4-40 x 1/4"	25	3

Recessed Bracket BR64#

The BR64# bracket is used to fasten pieces of T-Strut extrusion with right angle butt or mitered joints. Enables mounting a smaller connector between larger ones, or box frames may be constructed. Bracket has threaded holes and is supplied with two screws per packet.



T-Struts

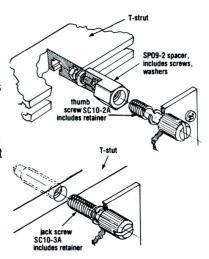
Hardware Kit HD34

HD34 is a complete connector mounting kit consisting of 42, 4-40 screws (SC4-28), nuts (NT4-2#), and lockwashers. To mount connectors, simply slide nut into desired position and fasten with screws and lockwasher, as illustrated. SC4-28 screws available in bulk quantities.



Modules or Front Panel Mounting Hardware

SC10-2A thumb screws and SC10-3A jack screws (supplied with EFP modules) are available separately in bags of 12. Both screws are used to attach EFP modules, Cardmount Modules, and front panel assemblies to T-Struts. SP09-2 spacers are used as standoffs for mounting modules to 1" T-Struts (1.79" struts are standard with module subracks).



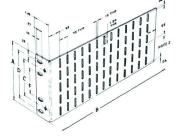
T-Strut Hardware

Part No.	Description	Pkg. Qty.
BR64#	Right angle bracket and mounting screws. Part No. includes all 3.	Bulk
SP09-2	Hex spacer for module mounting, includes hardware.	12
SC10-2A	Thumb screw fully threaded for direct attachment of panels.	12
SC10-3A	Jack screw for mounting modules to T-Struts with jacking action.	12
HD34	Connector mounting hardware, includes SC4-28 screws, NT4-2# nuts, and lockwashers.	42 ea.
NT4-2#	4-40 nut for connector mounting.	Bulk
SC4-26	4-40 hex head screw, 3/4" long for connector mounting.	24
SC428	4-40 hex head screw, 1/2" long for connector mounting.	24



Sidewalls

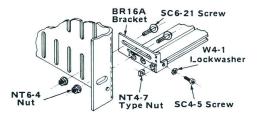
Vector-Pak® sidewalls are ideal for multi-function equipment subracks and cabinets. Versatile slot pattern provides excellent adjustability—horizontal and vertical—for T-Struts and cross members.



P TYPE SIDEWALL

T-Strut Bracket BR16A

- Provides additional horizontal adjustability for T-Struts
- · Hardware included



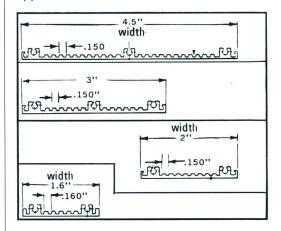
Sidewalls

	Height	Depth	Handle Mounting Centers	Rack Mounting Centers		Accepts Card
Part No.	Α	В	С	D	F	Height
SW52P89	5.25	9.0	4.25	_	2.25	4.5
SW52P119	5.25	12.0	4.25	_	2.25	4.5
SW52P156	5.25	15.75	4.25	_	2.25	4.5
SW87P89	8.75	9.0	4.25	5.75	2.25	8.0
SW87P119	8.75	12.0	4.25	5.75	2.25	8.0
SW104P156	10.5	15.75	4.25	7.5	3.0	9.75

Multi-Mod Cases W45, W30, W20, W16

Versatile Multi-Mod Cases are ideal for small case packaging of testers, controllers, and other instruments. Brushed aluminum construction provides excellent RF attenuation and an attractive, "finished" appearance. Kits include

frame, top and bottom covers, and hardware. Extruded, two-piece frame assembles quickly with self-tapping screws. Standard 0.062" cards slide into grooves in Frame-Loc Rails.





Off The Shelf Clear Anodized Cases

Part No.	Width	Length	Height	Circuit Card Size Range
W45-10-66B	4.5	10.00	6.64	9.88 x 6.50
W45-10-46B	4.5	10.00	4.61	9.88 x 4.50
W45-86-46B	4.5	8.61	4.61	8.50 x 4.50
W45-66-46B	4.5	6.61	4.61	6.50 x 4.50
W30-10-66B	3.0	10.00	6.61	9.88 x 6.50
W30-86-46B	3.0	8.61	4.61	8.50 x 4.50
W30-66-46B	3.0	6.61	4.61	6.50 x 4.50
W20-66-46B	2.0	6.61	4.61	6.50 x 4.50
W20-46-31B	2.0	4.61	3.10	4.50 x 2.98
W16-31-31B	1.6	3.10	3.10	2.98 x 2.98



Rack Components

Rack Encasements CE55

Designed to fit standard Vector card cages and module racks, Vector Rack Encasements provide a finished look for desktop or worktable. Easily removable top and bottom covers provide excellent accessibility to cards and other components. Complete encasements cover subracks to flange edges. Encasements supplied as kits, which include top and bottom panels, rear panel, two side panels, and aluminum trim strips. Sturdy, brushed anodized aluminum construction. Use with bottom-hinge front panels (HFP series) and filler panels (FP series) or with side-hinge front panels (HP series, filler panels included). Front panels may be ordered separately.

Top/Bottom Panels CAC1, CAC2

Panels (packages of 2) are designed to provide protective cover and still allow subrack to be mounted into equipment rack or cabinet. Aluminum construction, mounting screws and instructions included.

Rear Panels CRK3

Blank rear panel, fits 19" card cages and module racks.

Side Filler Panels FP52, FP87

Side Filler Panels are 3" wide, slotted to fit sidewall mounting flanges. Can be cut to size as needed. 0.080" aluminum, brushed anodized finish.

Front Panels

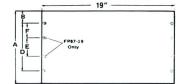
0.125" aluminum construction, brushed anodized finish. Two front panel versions available:

Side Hinged: HP52

Easy to assemble kit includes the hinged panel with latch, striker plate, and 2 filler panels. Also includes mounting hardware and instructions.

Bottom Hinged: HFP52, HFP69, HFP87

Designed for "drop down" assembly. Includes lanyard, mounting hardware and instructions.







							Front P	anels	Cover I	Panels								Dim.		
Use Wi	Use With Rack Size		R	ack Enc	asement	ts	Hinged		Hinged Top & Blank Dimensions			Dimensions				Side Filters				
_							Side	Bottom	Bottom	Rear	Lanyard	Panel			Front			Only	Panels	Handles
Height	Width	Depth	Part No.	Height	Width	Depth	Part No.	Part No.	Part No.	Part No.	Part No.	Part No.	Α	В	D	E	F	G	Part No.	Part No.
5.25	19.00	9.00										FP52-19	5.25	1.50		2.25		4.25	FP52-2	HA12
5.25	19.00	9.00	CE55-95	5.5	19.00	9.5	HP52-1	HFP52-1	CAC1	CRK3	L20	FP52-19	5.25	1.50		2.25		4.25	FP52-2	HA12
5.25	19.00	12.00	CE55-125	5.5	19.00	12.5	HP52-1	HFP52-1	CAC2	CRK3	L20	FP52-19	5.25	1.50		2.25		4.25	FP52-2	HA12
5.25	19.00	15.75					HP52-1	HFP52-1		CRK3	L20	FP52-19	5.25	1.50		2.25		4.25	FP52-2	HA12
7.00	19.00	9.00						HFP69-1	CAC1			FP69-19	7.00	1.50		4.00		3.09		HA13
7.00	19.00	12.00						HFP69-1	CAC2				7.00	1.50		4.00		3.09		HA13
7.00	19.00	15.75						HFP69-1					7.00	1.50		4.00		3.09		HA13
8.75	19.00	9.00						HFP87-1	CAC1		L20	FP87-19	8.75	1.50	5.75	2.25	1.75	4.25	FP87-2	HA12
8.75	19.00	12.00						HFP87-1	CAC2		L20	FP87-19	8.75	1.50	5.75	2.25	1.75	4.25	FP87-2	HA12
8.75	19.00	15.75						HFP87-1			L20	FP87-19	8.75	1.50	5.57	2.25	1.75	4.25	FP87-2	HA12



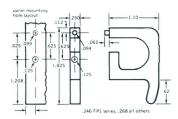
Rack Components

Handle Kit for Modules HA11/2

Aluminum handle with unique, finger-hugging design adds function and style to module subracks. Mounting hardware included.

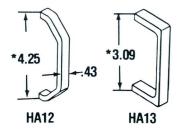
Rubber, Stick-On Feet FT3

Convenient and functional, protect worktable or desktop surfaces with Vector Rubber Feet, supplied 8 to a package.



Handles for Subracks HA12, HA13

Brushed anodized aluminum handles, add to the appearance and function of card cages or subracks. Mounting hardware included.



*C-C mounting hole spacing



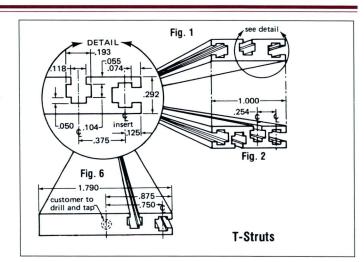
Vector's Most Versatile Products Custom sized To Your Specifications

In keeping with Vector's policy of providing custom assemblies and modifications to meet special needs, Lumber Yard Parts are available. These parts are cut to any length at 90°. Frame-Loc Rails are available with 45° miter cut. All extrusions are aluminum. standard finish is clear anodize. Mounting brackets and hardware available separately for all Lumber Yard Parts.

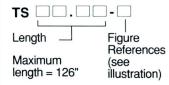
T-Strut Extrusions

Vector's most popular strut can be ordered in custom lengths. Durable aluminum construction. T-struts can be joined easily with Vector's BR-64 bracket. Many options to choose from, including

- 1" wide T-struts with 3 nut slots
- 1" wide T-stuts with 4 nut slots, ideal for double tier card guides and vertical guide cages
- Extra width T-struts, 1.79", for use with modules or for added strength



T-Strut Extrusion Ordering Table



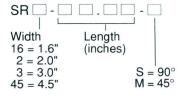


Frame-Loc Rails

Ideal for applications, requiring quick, versatile packaging. Frame-Loc Rails can be cut or bent to form enclosures of virtually any size. Aluminum construction with 0.062" grooves accommodate most Vectorbord® printed circuit boards. Four available widths. Standard length

is 41, shorter lengths can be ordered using table below. Standard finish is clear anodize.

Frame-Loc Rail Ordering Table



Front Extrusions

Eurocard-style front cross member, easily adapted to any application. Available in four versions, with 21, 42, 63, and 85 HP, in lengths as described below, or cut to customer specifications.

Front Extrusions Ordering Table

5250236 - _____ Length in HPs ___ Note: 1 HP = 0.2"

Rear Extrusions

Eurocard-style rear cross member, easily adapted to any application. Available in four versions, with 21, 42, 63, and 85 HP, in lengths as described below, or cut to customer specifications.

Rear Extrusions Ordering Table

5250238 - _____ Length in HPs Note: 1 HP = 0.2"

Center Extrusions

Eurocard-style front cross member, easily adapted to any application. Available in four versions, with 21, 42, 63, and 85 HP, in lengths as described below, or cut to customer specifications.

Center Extrusions Ordering Table

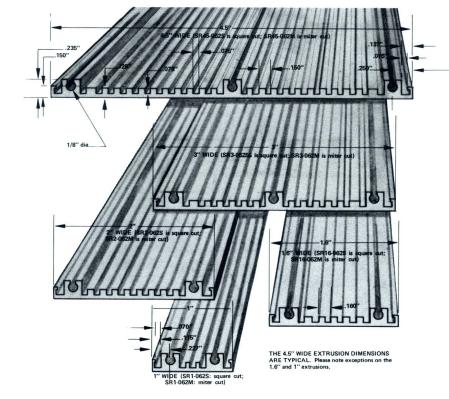
5250237 - _____ Length in HPs Note: 1 HP = 0.2"

Nut Strips

An extremely functional packaging tool, can be cut to any length. Nut strips provide threaded anchoring holes at 0.2" increments. No mounting hardware required.

Nut Strips Ordering Table

5700202 - 🔲 🗆
Length in HPs Note: 1 HP = 0.2"



Vectors 14 -Slot Passive Backplane An Excellent Platform for Configuring Industrial AT Computers

The Vectorbord® model 4617-6-14, enhanced 14-slot passive backplane provides clean, quiet transmission lines, even for systems based on high speed/ high frequency CPUs. The design virtually eliminates compatibility problems, and allows the ready integration of ISA (Industry Standard Architecture) boards from different manufacturers performing different functions at different operating speeds. It also assures accurate "square wave" switching at any speed.

Massive power and ground planes, filtered power input, and user-selectable termination provisions assure clean, quiet "slot indifference" signal performance. Chokes and filters on all voltages isolate the backplane and cards from peripheral and motor noises.

Maximum Capacity

14-slots: 8 full size, 6, 3/4 or 1/2 size slots accept PC, XT, and AT add-in cards.

Ease of Configurability

Filtered power input, massive power and ground planes, and user selectable termination provide clean, quiet signal performance and "slot indifference," regardless of the amount or type of add-in boards used to configure the system.

High Speed, High Frequency Applications

The 4617-6-14 backplane is designed to maintain signal integrity, regardless of speed or complexity.

Five Resistor Packs:

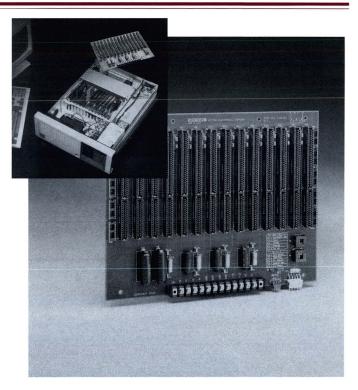
Each end of the backplane provides for transmission line termination. Each resistor pack handles up to 18 signal lines. Each pack provides a connection to Vcc (5V) on pin 20 and Gnd on pin 10, so that by appropriate selection of the pack type, the terminator can take the form of a pull-up, pull-down, or voltage-divider termination network. In addition, leads of resistor packs can be clipped away to omit designated pins from the termination scheme.

Large, Accessible Terminal Block:

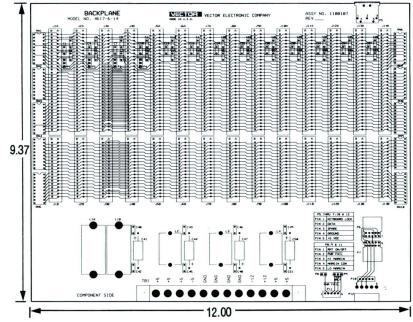
For easy hookup. Also provides access to +5V filtered from two separate terminals.

Specifications

Material: FR4 Epoxy
Thickness: 0.9"
Operating Temp: 100°F



Reference	Description
L1A, L1B	Inductor, 10µH, 20A
L2, L3, L4	Inductor, 10µH, 12A
C41, C44, C47, C50	Capacitor, Tantalum,10μf, 23V
C40, C43, C46, C2, C3, C5, C49	Capacitor, .003µf, 50V, 10%
C6, C8, C9, C11, C12, C14, C15	100 m
C17, C18, C20, C21, C23, C24,	
C26, C27, C29, C30, C32, C33,	
C35, C36, C38, C39	
C42, C45, C48, C51, C1, C4, C7,	Capacitor, .01µf, 100V, 10%
C10, C13, C16, C19, C22, C25,	Am. 52
C28, C31, C34, C37	

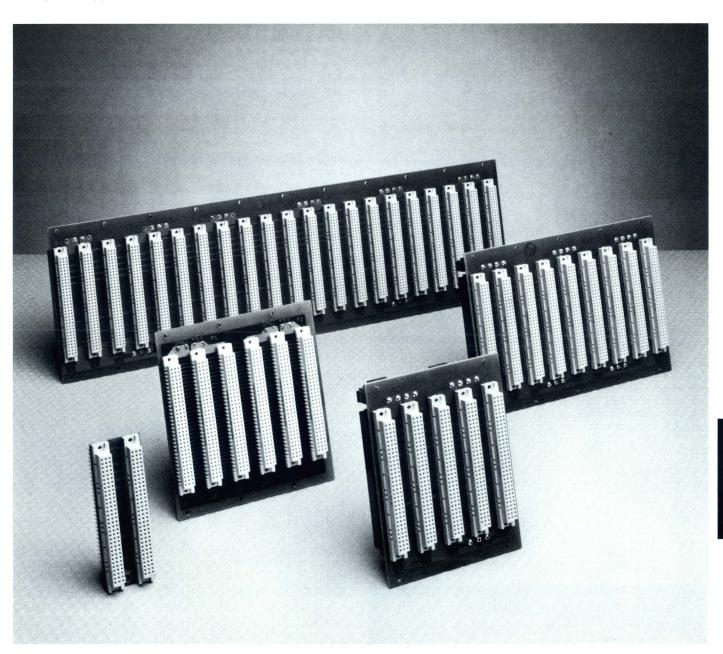




General Purpose & Bus Specific

Vector Backplanes support uncommitted as well as bus specific applicationsVME, Multibus, S100, and STD Bus. Utilizing proven designs, quality materials,

and precision engineering, Vector puts performance in backplanes.





Vector Uncommitted Backplanes provide maximum performance, maximum flexibility

Massive, three ounce copper voltage and ground planes handle power requirements for high performance applications. Several power hook-up options provide excellent power handling capacities. Connector slots spaced on 0.80' centers. All connector pins are isolated from power layers and from other pins, and are assigned by user. Pins can be committed easily to power or ground layers with Vector T124 Solder Washers.

Vector off-board terminator modules, available separately, can be used to terminate backplanes according to VME J1 and J2 specifications. VME terminator modules are available for perpendicular, Vector Part No. VMETBJ1 or J2, and parallel, Vector Part No. VMETBJ1-P or J2-P, mounting.

Multilayer Construction:

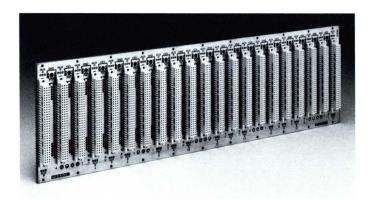
- Four-layer backplanes, 0.125" thick
- Full Power Planes—four independent power layers, one can be split between AUX A and AUX B—extremely low impedance power distribution
- Layer 1: Chassis Ground (component side), full coverage on component side, also available on solder side, isolated from circuit ground
- Layer 2: One or two auxiliary voltages (AUX A and AUX B) can be delivered through Mate-N-Lok® connectors; AUX A and AUX B (typically +12V and -12V) accessible through goldplated Wire Wrap power pick-up pins—three each at most slot positions
- Layer 3: Source power is delivered through Mate-N-Lok® connectors and/or Power Bugs connectors on solder side; +5V is accessible through gold-plated, Wire Wrap power pick-up pins—12 pins available at each slot position
- Layer 4: Circuit ground (solder side) can be dedicated to chassis ground using pins and solder washers (supplied with backplanes); and is accessible at any pin position and through Mate-N-Lok® and Power Bugs connectors

Outstanding Performance

- Positions provided adjacent to A and C rows of each slot for mounting ribbon cable I/O connectors or for grounding DIN connector pins
- Positions provided for decoupling capacitors, power to ground and ground to chassis, for reducing signal noise and RFI
- Power connectors: Mate-N-Lok®, 20 amps per pin, provides access to AUX A and AUX B; and Power Bugs (10 amps per pin @ 85C)
- Bus Bar, Vector Part No. BB21S available separately, can be mounted on the Power Bugs for extra heavy power-handling requirements and greatly simplified wiring hook-ups

Ordering Options:

- Four configurations forpower connectors: Mate-N-Lok®, Power Bugs, combination of Mate-N-Lok® and Power Bugs, and no connectors
- Power Pick-Up Pins: Factory-installed, goldplated, 0.025" square post Wire Wrap pins, 12 each per slot position (0); or no pins installed (1)
- Terminator Modules, available separately:
 VMETBJ1, VMETBJ1-P,
 VMETBJ2, AND
 VMETBJ2-P
- · 1.2" connector slot spacing



Layer Designation

GROUND	LAYER 1	3oz
INSULATION		
AUX PWR	LAYER 2	1oz
INSULATION		7////
POWER	LAYER 3	1oz
INSULATION		/////
GROUND	LAYER 4	3oz

Uncommited Backplane Ordering Table

UM 21 A	<u>3U</u> 2	<u> </u>
Number Of Slots	Board Height 3U 6U 9U	Power pick- up Pins Ø = No pins installed 1 = Power pins
Slot Spacing A = 0.8" B = 1.2"	g	installed 2 = Power and Ground pins installed
Ø = No o		rs

Ø = No connectors
1 = Mate-N-Lok
2 = Power bugs
3 = Mate-N-Lok and power bugs



All Vector VME Backplanes are fully assembled and tested.

Backplanes include pressfit, 96-pin female DIN connectors (DIN 41612, class 2). Engineered to meet advanced requirements for system performance and for accessibility for engineering and testing.

Recommended for use with Vector Europackaging Subracks and Prototyping Boards, available for board sizes from 3U x 160mm to 9U x 400mm.

J1 Backplanes

Vector J1 Backplanes handle high signal densities and circuit speeds with integrity and reliability. Six-layer construction and controlled-impedance design effectively reduce crosstalk and ringing on bus lines. Massive copperclad power and ground planes on opposite board sides; patented shielding technique* effectively surrounds each signal trace with a closed conductive loop for blocking both capacitive and inductive coupling.

Featuring Off-Board Termination

Termination for Vector J1 Backplanes is "off board" using VMETBJ1 terminator modules (supplied). Terminator modules are available for mounting perpendicular (Vector Part No. VMETBJ1) and parallel (Vector Part No. VMETBJ1P) to backplanes. Off-board termination provides capabilities for connecting two or more backplanes, for termination on extender cards. for termination according to specialized requirements, and for full, 21-slot backplanes.

- 96-pin female connectors designed to DIN 41612, class 2 specification
- Standard +5V and ground access through Mate-N-Lok® connectors, mating connector housings and pins provided
- Extensive labeling on board surface identifies user assignable pins, IACK and IACK OUT pins, and other information

 Power Cable Assemblies in three- and four-foot lengths, Vector Part Nos. CA3-UM and CA4-UM, available separately

Vector J1 Backplanes are available in many sizes, including the 2-slot VMEBP2J1 Interconnect Board. The Interconnect Board can be used to connect two backplanes without sacrificing slot positions or electrical characteristics.

Layer Designation

COMP	LAYER 1	
POWER	LAYER 2	
INSULATION		
GROUND	LAYER 3	
POWER	LAYER 4	
INSULATION		
GND/+5SBY	LAYER 5	
SOLDER	LAYER 6	



Backplanes (For custom backplanes, contact factory)

VME J1	Description	Height	Length	Connector	Layers
Part No.	Description	ricigiit	Longui	Spacing	Luyers
VMEBP21J1	21-Slot J1	5.12"	16.74"	.80"	6
VMEBP20J1	20-Slot J1	5.12"	15.94"	.80"	6
VMEBP14J1	14-Slot J1	5.12"	11.14"	.80"	6
VMEBP12J1	12-Slot J1	5.12"	9.54"	.80"	6
VMEBP10J1	10-Slot J1	5.12"	7.94"	.80"	6
VMEBP9J1	9-Slot J1	5.12"	7.14"	.80"	6
VMEBP8J1	8-Slot J1	5.12"	6.34"	.80"	6
VMEBP7J1	7-Slot J1	5.12"	5.54"	.80"	6
VMEBP6J1	6-Slot J1	5.12"	4.74"	.80"	6
VMEBP5J1	5-Slot J1	5.12"	3.94"	.80"	6
VMEBP2J1	2-Slot J1	5.12"	1.33"	.80"	6

^{*}Licensed from UCL and BICC

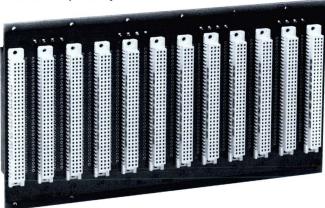


J2 Backplanes

Vector J2 backplanes are available in many sizes, corresponding to available Vector J1 backplanes. Featuring off-board termination using VMETBJ2 terminator modules (supplied). Pressfit 96-pin DIN connector pins are configured according to VME specifications: connector row B is bussed for 32-bit expansion; A and C rows can be used for local extension buses, such as VMX or VSB, or can be assigned according to user I/O requirements.

Two-slot J2 backplanes, the VMEBP2J2 Interconnect Boards, also are available. The Interconnect Board can be used to connect two backplanes without sacrificing slot positions or electrical characteristics. Power cable assemblies in three and four feet lengths, Vector Part Nos. CA3-UM and CA4-UM, available separately.





Backplanes (For custom backplanes, contact factory)

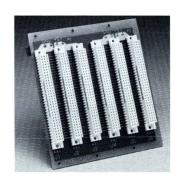
Part No.	Description	Height	Length	Connector Spacing
VMEBP21J2	21-Slot J2	5.12"	16.74"	.80"
VMEBP20J2	20-Slot J2	5.12"	15.94"	.80"
VMEBP14J2	14-Slot J2	5.12"	11.14"	.80"
VMEBP12J2	12-Slot J2	5.12"	9.54"	.80"
VMEBP10J2	10-Slot J2	5.12"	7.94"	.80"
VMEBP9J2	9-Slot J2	5.12"	7.14"	.80"
VMEBP8J2	8-Slot J2	5.12"	6.34"	.80"
VMEBP7J2	7-Slot J2	5.12"	5.54"	.80"
VMEBP6J2	6-Slot J2	5.12"	4.74"	.80"
VMEBP5J2	5-Slot J2	5.12"	3.94"	.80"
VMEBP2J2	2-Slot J2	5.12"	1.55"	.80"

VMX Backplanes

Vector VMX Backplanes are mounted "piggyback" onto Vector J2 backplanes and provide pin assignments for A and C rows according to VMX specifications. B row pins correspond to VMX J2 power and ground pins and are connected to power and ground planes. Featuring 4-layer construction, VMX backplanes are available in 4-slot and 6-slot versions. On-board power connectors allow Vector VMX Backplanes to be mounted as standalone backplanes in subracks.

Layer Designation

COMP ROW A	LAYER 1	1oz
INSULATION		
GND	LAYER 2	1oz
INSULATION		
POWER	LAYER 3	1oz
INSULATION		
SOLDER ROW	C LAYER 4	1oz



VMX Backplanes

Part No.	Description	Height	Length	Connect. Spacing	Layers
VMX-4-01	4-Slot, VMX 4 Layer Backplane Without J2	5.12"	3.14"	.80"	4
VMX-6-01	6-Slot, VMX 4 Layer Backplane Without J2	5.12"	4.74"	.80"	4



ckplanes

Monolithic J1/J2 Backplanes

Eight-layer Monolithic Backplanes—For Very High Performance Applications

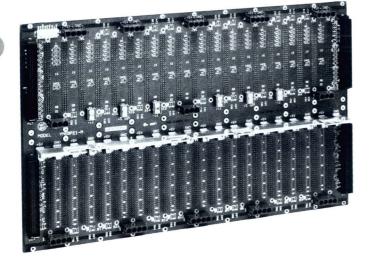
High-performance, 8-layer Vector Monolithic back-planes combine J1 and J2 on a single panel. These backplanes have been used in systems driven by 1000 watt power supplies, connected with 2-gage wire at opposite ends of a Power Bus Bar, delivering 5V at 150 amps and (+-) 12V at 20 amps with no noticeable heat rise. Multiple connectors and power options can provide even greater power capacities.

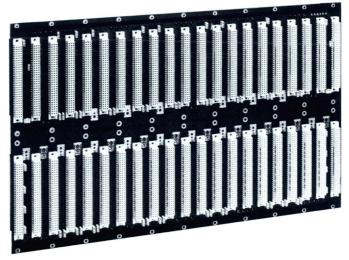
Ground layers separate signal and power layers from each other and effectively prevent crosstalk between signals and between signals and power plane. Pressfit DIN connectors (DIN 41612, Class 2) are easily accessible and serviceable.

Eight-Layer Construction

- Designed in accordance with VME bus specification C1
- · On-board termination
- Molex® connector provides convenient access to SYSRESET, SYSFAIL, and ACFAIL lines
- Positions for decoupling capacitors, power to circuit ground and circuit ground to chassis, for increased protection against resonance and crosstalk
- Mounting areas adjacent to J1 connectors for I/O to J2
- I/O mounting areas adjacent to J2 connectors, rows A and C, for ribbon cable connectors

- Power Bug power connectors (10 amps per pin @ 85C); three- and four-pin Mate-N-Lok® power connectors (20 amps per pin), Vector Part Nos. 73003003 and 73004003, available optionally—both types of connectors provide for ground and other voltages, such as +5V, +12V and -12V
- Vector Bus Bar, Part No. BB21S available separately, can be used with Power Bugs for excellent power distribution and greatly simplified wiring hook-up



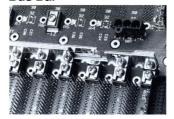


Monolithic J1/J2 Backplanes

Ordering Options:

- Four configurations for power connectors: Power Bugs, Mate-N-Lok®, combination of Mate-N-Lok® and Power Bugs, and no connectors
- I/O mounting area adjacent to J1 connectors: with gold-plated, double-tailed (accessible from both sides of backplane) Wire Wrap pins installed at factory, or with no pins installed
- Decoupling capacitors: factory-installed at power to ground positions only, at ground to chassis positions only, at both power to ground and ground to chassis positions, or with no pins installed

Bus Bar



Layer Designation

POWER	LAYER 1	3oz
INSULATION		7//////
GROUND	LAYER 2	1oz
INSULATION		77777777
SIGNAL	LAYER 3	1oz
INSULATION		7//////
GROUND	LAYER 4	1oz
INSULATION		77/1/1/1/
SIGNAL	LAYER 5	1oz
INSULATION		7//////
GROUND	LAYER 6	1oz
INSULATION		77777777
SIGNAL	LAYER 7	1oz
INSULATION		7//////
GROUND	LAYER 8	3oz

Terminator Boards

Vector Terminator Boards terminate bus lines for backplanes with "off board" termination. Designed according to VME specifications, can also be used with Vector Uncommitted Backplanes. Terminator boards can be mounted on extender cards for proper bus termination during testing. Two versions available: perpendicular mounting; and parallel mounting on right angle connector, for applications in which space is restricted. Both versions come two to a package—parallel version includes one right side, one left side.



Monolithic Backplane Ordering Table

		100		•
VME BP	21	Р	Ø	Ø
No. of slots Power Conr Ø = No Co M = Mate- P = Powe S = Mate- Powe Pins For I/0 Ø = No Pi	onnectors N-Lok r Bugs N-Lok an r Bugs to J2 —			Capacitors Ø = No caps 1 = Caps installed at power to ground positions only 2 = Caps installed at ground to chassis positions only 3 = Caps installed at both power and ground positions
1 = Pins I	nstalled			

Typical Performance Specifications

Data Transfer Rate:	Up to 40 Mbyte	s/sec
Cross Talk: Signal to Signal:		six closest lines in simulta- using AS type drivers
Power to Signal:	4 mv per volt of	power plane noise
Delay:	25 ns (AS type	driver to AS type receiver)
Overshoot:	260 mv max	
Voltage Rating:	100 volts	
Altitude Rating:	10,000 feet	
Operating Temperature:	-55 C to +125C	
Power Rating:	Voltage	Per Slot Rating
	+5V	9.0 amps
	+12V	1.5 amps
	-12V	1.5 amps
	+5V standby	1.5 amps
Connector Type:	Press-fit DIN 41	612 Class II
Housing Material:	Thermoplastic p	polyester 94V-O UL rated
Insertion Force:	36 pounds typic	cal (3.0 oz. per pin)
Withdrawl Force:	24 pounds typic	cal (2.0 oz. per pin)

Monolithic Backplanes (For custom versions, consult factory)

Part No.	Description	Height	Length	Connect. Spacing	Layers
VMEBP21-M00	21-slot VME J1 and J2	10.32 (263.4 mm)	16.74 (425.2 mm)	.80	8
VMEBP10-M00	10-slot VME J1 and J2	10.32 (263.4 mm)	7.94 (201.7 mm)	.80	8
VMEBP7-M00	7-slot VME J1 and J2	10.32 (263.4 mm)	5.54 (161.0 mm)	.80	8

Terminator Boards

Part No.	Description	Height	Width	Thickness
VMETBJ1	J1, perpendicular to backplane	3.70"	1.325"	.520"
VMETBJ1-P	J1, parallel to backplane	3.70"	1.000"	.520"
VMETBJ2	J2, perpendicular to backplane	3.70"	1.325"	.520"
VMETBJ2-P	J2, parallel to backplane	3.70"	1.000"	.520"



Баскріапез

Multibus Backplanes

Fully assembled and tested, Vector Backplanes for Multibus (IEEE 796) applications. Four-slot backplane features:

- Termination resistors on bus lines
- Solder pads for mounting reset switch
- Gold-plated card connectors with 0.6" contact spacing and full-bellows contact design
- · Solder-mask protection
- Easy-to-read component legend on backplane surface



STD Bus Backplanes

Fully assembled and tested, Vector Backplanes for STD Bus applications. Eight- or 16-slot versions available, connector spacing is on 0.75"centers. Speed capabilities up to 10 MHz; ample positions for decoupling capacitors. Meets all STD Bus specifications, including interrupt priority lines. Featuring:

- Faraday shield lines reduce cross talk
- Wiring pads on board to connect RESET switch for front panel controls
- High reliability connectors with gold/plated contacts and 10 position power connector



S100 Backplanes

Fully assembled and tested, Vector Backplanes for S100 applications. Available in 6-, 12- or 18-slot versions, connector spacing is on 0.75" centers. Speed capabilities up to 10 MHz; ample positions for decoupling capacitors. Featuring:

- Faraday shield lines reduce cross talk
- Special etched circuit pattern facilitates active termination on all signal lines
- Components for active termination circuit: connectors, capacitors, decoupling capacitors, resistors, voltage regulator, and quickrelease terminal switch
- Wiring pads on board for connecting RESET switch for front panel controls

- Solder masks prevent bridging during soldering
- Pin legend on backplane surface for easy assembly and application



Multibus, Bus Backplanes

Part		Dimensions			Dimensions Connec			Connector	Accessories		
No.	Description	Width	Length	Thickness	Spacing	Plugbord Series	Extender	Card Racks/Enclosure			
4608-4-1	4 Slot Assembled	3.33	12.52	1/16	.600	4608 Series	3690-18				

STD Bus Backplanes

Part			Dimensions				Accessor	ries	
No.	Description	Width	Length	Thickness	Spacing	Plugbord Series	Extender	Card Racks/Enclosure	
4610-8-1A	8 Slot Assembled	4.35	7.00	1/16	.750	4610 Series	3690-16	CCK13 Series	
4610-16-1A	16 Slot Assembled	4.35	13.00	1/16	.750	4610 Series	3690-16	- CONTO Series	

S100 Backplanes

Part Number of Mothe		Motherbord	Board Size			Board	Motherbord	Accessories		
	Card Slots		Width	Length	Thickness	Material	Connector	Extender	Card Racks/Enclosure	
8803-6-1A	6	Assembled	6.50	9.00	1/16	Epoxy Glass	Supplied	3690-12		
8803-12-1A	12	Assembled	9.00	11.125	1/16	Epoxy Glass	Supplied	3690-12	CCK100S	
8803-18-1A	18	Assembled	9.00	15.55	1/16	Epoxy Glass	Supplied	3690-12		



Multilayer AT Extender Card: Ideal For High Performance **Board Testing**

The 3690-26-1 Vectorbord® multilayer extender board is designed for testing IBM AT and compatible boards especially in high performance applications.

Two outer layers for signal hook-up are separated by two inner layers, power and ground. This multilayer construction results in an extremely quiet board virtually eliminating crosstalk and distortion. To further reduce noise, all power lines are filtered with bypass capacitors.

For user convenience, at AT bus pin legend is clearly marked on both sides of board surface. This enables accurate testing using test points at the connector. All connector contacts are gold plated to ensure secure connections.

3690-26-1

- High performance multilaver design
- Quiet operation, no crosstalk or distortion
- Power lines filtered with bypass capacitors further réduces noise
- AT Bus pin legend clearly identifies pin designations
- · Provisions for convenient attaching of test probes to pins at connector
- Finest quality laminated, copper and gold for accuracy

Specifications

Laminate:

Copper Layers: Contacts:

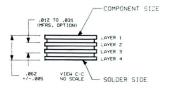
FR4 Epoxy 2 oz. (.0028 in.) inner and outer nickel/gold plated fingers

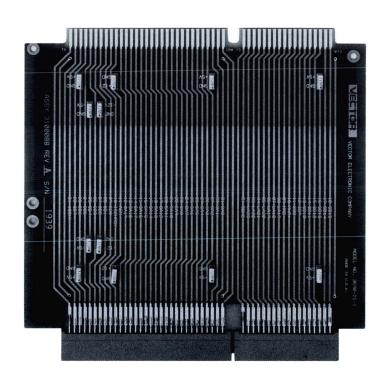
Solder coat:

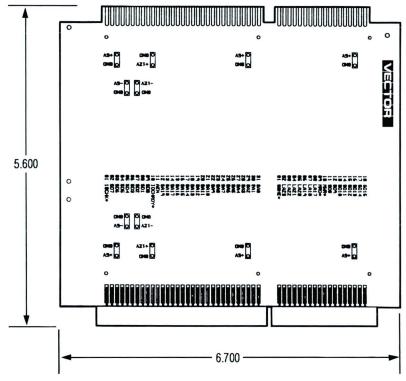
both sides 0.062" in.

Thickness: Capacitors (12): .1Mf, 50V, 20%

Layer Designations









General Purpose Plugbord Extenders

VECTORBORD® EXTENDER CARDS

Vectorbord® Extender Cards

Vectorbord® Extender Cards provide convenient access to functioning circuit boards for testing. Engineered for quality, Vectorbord Extenders include many standard features:

- Low insertion force, goldplated connectors for reliable contact, minimum wear on circuit board
- Gold/nickel plated connector contacts
- Epoxy glass composite— 2 oz. copperclad

30 Contacts

3690-10:

- Extension length: 5.5"
- 15 contacts per side on 0.156" centers
- · Fits Vector Series 12 Subracks
- Current rating: 5 amps at 10 degrees Farenheit rise
- Voltage rating: 200 RMS or 300 VDC



44 Contacts

3690:

- Extension length: 6.5"
- 22 contacts per side on 0.156" centers
- · Fits Vector Series 13 Subracks
- Current rating: 5 amps at 10 degrees Farenheit rise
- Voltage rating: 200 RMS or 300 VDC

3690-6:

- · Extension length: 11"
- 22 contacts per side on 0.156" centers
- · Fits Vector Series 14 Subracks
- Current rating: 5 amps at 10 degrees Farenheit rise
- Voltage rating: 200 RMS or 300 VDC

3690-8:

- Extension length: 5.5"
- 22 contacts per side on 0.1" centers
- · Fits Vector Series 12 Subracks
- Current rating: 5 amps at 10 degrees Farenheit rise
- Voltage rating: 200 RMS or 300 VDC



3690 SHOWN

56 Contacts

3690-16:

- · Extension length: 6.5"
- 28 contacts per side on 0.125" centers
- Fits Vector Series 13 Subracks
- Also fits STD bus specifications
- Current rating: 5 amps at 10 degrees Farenheit rise
- Voltage rating: 200 RMS or 300 VDC



Extender Cards

Part No.	Contacts	Spacing	Height	Width	Material	Bus
3690-10	30	0.156	5.500	2.730	Epoxy Glass Composite	_
3690-8	44	0.100	5.500	2.730	Epoxy Glass Composite	_
3690	44	0.156	6.500	4.500	Epoxy Glass Composite	_
3690-6	44	0.156	11.000	4.500	Epoxy Glass Composite	RCA Cosmac
3690-16	56	0.125	6.500	4.500	Epoxy Glass Composite	SDT



72 Contacts

3690-2:

- Extension length: 11"
- 36 contacts per side on 0.10" centers
- · Fits Vector Series 14 Subracks
- Current rating: 5 amps at 10 degrees Farenheit rise
- Voltage rating: 200 RMS or 300 VDC

3690-4:

- Extension length: 7.5"
- 36 contacts per side, on 0.10" centers
- Fits Vector Series 13 Subracks
- Current rating: 5 amps at 10 degrees Farenheit rise
- Voltage rating: 200 RMS or 300 VDC



3690-2 SHOWN

80 Contacts

3690-14:

- Extension length: 11"
- 40 contacts per side, on 0.125" centers
- Current rating: 5 amps at 10 degrees Farenheit rise
- Voltage rating: 200 RMS or 300 VDC



100 Contacts

3690-12:

- Extension length: 7.5"
- 50 contacts per side, on 0.125" centers
- Designed to S100 bus specifications
- Fits Vector CCK100S Subracks
- Current rating: 5 amps at 10 degrees Farenheit rise
- Voltage rating: 200 RMS or 300 VDC



Ext	ender	Cards

Extender Cards						
Part No.	Contacts	Spacing	Height	Width	Materials	Bus
3690-2	72	0.100	11.000	4.500	Epoxy Glass Composite	_
3690-4	72	0.100	7.500	4.500	Epoxy Glass Composite	_
3690-14	80	0.125	11.000	6.990	Epoxy Glass Composite	T1
3690-12	100	0.125	7.500	10.000	Epoxy Glass Composite	S100



xtenders

Vectorbord® Metric Extender Cards

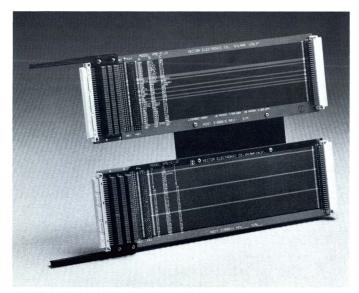
VME Extenders

VME Extender Cards for 160mm and 220mm card cages. Three-layer construction, controlled impedance design, and patented signal trace shielding minimize crosstalk. Jumpers are provided for interrupting all signal lines. Mounting pads for additional DIN connector or for test point mounting of logic analyzer also included.

Also available: Uncommitted extender cards. Contact factory.

Excellent Selection of Options

Termination for Vector J1 and J2 backplanes can be moved to extenders using male DIN connector (included) and Vector VMETB Terminator Boards, available separately. Blank extender provides rigidity when using a 3U extender in 6U card cage. Extender bracket, Part No. BR6U, can be used to connect J1 and J2 backplanes, or to connect blank extender, Part No. EB220-3U, to J1 or J2 backplane. J1 Extender, extender bracket, and blank extender are available separately or can be ordered as an assembly, Part No. VMEE-J1/B.



VMEE-M Extender Bracket Assembly

IBM PC, XT

3690-22:

- Extension length: 5.7"
- Double-sided, controlled impedance board
- · 62 Contacts on 0.1" centers
- Test points for mounting probes on each connector line
- Current rating: 5 amps at 10 degrees Farenheit temperature rise
- Voltage rating: 200 RMS or 300 VDC
- Flame retardant laminate construction, 2 oz. copperclad



IBM AT

3690-26:

- Extension length: 5.6"
- Double-sided, controlled impedance board
- Two sets of contacts—36 and 62 on 0.1" centers
- Current rating: 5 amps at 10 degrees Farenheit temperature rise
- Voltage rating: 200 RMS or 300 VDC
- Test points for mounting probes on each connector line
- Also available: 3690-26-1, multilayer extender with decoupling capacitors (see page 86)



Extenders	And	Brackets

Part No.	Description	Height	Width	Layers		
VMEEJ1	J1 Extender	3.94"	12.20"	3		
VMEEJ2	J2 Extender	3.94"	12.20"	3		
EB220-3U	Blank Extender	3.94"	11.40"			
BR6U	Extender Bracket (For Connecting J1 and J2 Extenders)					

Extender	Cards

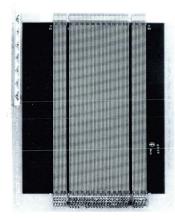
Part No.	Contacts	Spacing	Height	Width	Materials	Bus
3690-22	62	0.100	5.100	3.180	Epoxy Glass Composite	IBM PC, XT
3690-26	36 62	0.100 0.100	5.600	6.700	Epoxy Glass Composite	IBM AT



IBM PS/2

3690-30:

- Extension length: 7.5"
- Multilayer design, controlled impedance, engineered to maintain signal integrity at high speeds
- Decoupling capacitors included
- 16 bit connector, includes buses for video extension
- Current rating:
 1.6 amps maximum
- Voltage rating: 40V DC
- Test points for mounting probes on each connector line



IBM PS/2

3690-31:

- Extension length: 7.5"
- Multilayer design, controlled impedance, engineered to maintain signal integrity at high speeds
- Decoupling capacitors included
- 32 bit connector, includes buses for matched memory extension
- Current rating: 1.6 amps maximum
- · Voltage rating: 40V DC
- Test points for mounting probes on each connector line



Apple Macintosh II

3690-27:

- Extension length: 4.5"
- Double-sided, controlled impedance board
- Male and female DIN connectors installed
- Current rating: 1.5 amps per connector line
- Test points for mounting probes on each connector line



Apple Macintosh II

3690-28:

High Performance Extender Card For Macintosh II

- Extension length: 6.3"
- · Five-layer, stripline design
- Controlled impedance, engineered for signal integrity at high speeds
- Decoupling capacitors (installed) minimize crosstalk
- All signal lines can be interrupted with jumpers plugged into connector on card surface
- Test points for mounting probes on each connector line
- Bus line identification on card surface for user convenience
- Current rating: 1.5 amps per connector line
- Voltage rating: 200 RMS or 300 VDC
- Fully equipped—includes male and female 96 pin DIN connectors and mounting brackets



Extender Cards

Part No.	Contacts	Spacing	Height	Width	Material	Bus
3690-30	66	0.050"	7.475	6.100	Epoxy Glass	PS/2 50,60
3690-31	91	0.050"	7.475	7.650	Epoxy Glass	PS/2 80
3690-27	96	0.1"	4.500	4.000	Epoxy Glass	Mac II
3690-28	96	0.1"	6.300	12.860	Epoxy Glass	Mac II



STD Extenders

3690-16:

- Extension length: 6.5"
- Double-sided, controlled impedance board
- High reliability, gold-plated connector (mounted)
- Contact fingers on card are nickel/gold-plated
- 2 oz. copperclad, flame retardant epoxy glass composite material—94V-O UL classification
- Current rating: 5 amps at 10 degrees Farenheit temperature rise
- Voltage rating: 200 RMS or 300 VDC



S-100 Extenders

3690-12:

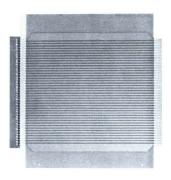
- Extension length: 7.5"
- Double-sided, controlled impedance board
- High reliability, gold-plated connector (mounted)
- Contact fingers on card are nickel/gold-plated
- 2 oz. copperclad, flame retardant epoxy glass composite material—94V-O UL classification
- Current rating: 5 amps at 10 degrees Farenheit temperature rise
- Voltage rating: 200 RMS or 300 VDC



Motorola Exorciser, Micromodule Extenders

3690-20:

- · Extension length: 9"
- Double-sided, controlled impedance board
- High reliability, gold-plated connector (mounted)
- Contact fingers on card are nickel/gold-plated
- 2 oz. copperclad, flame retardant epoxy glass composite material—94V-O UL classification
- Current rating: 5 amps at 10 degrees Farenheit temperature rise
- Voltage rating: 200 RMS or 300 VDC



Multibus Extenders

3690-18:

- · Extension length: 7.65"
- Double-sided, controlled impedance board
- Reliable, gold-plated connector—mounted on top and connected to circuit traces
- Nickel/gold-plated contact fingers on extender card
- Current rating: 5 amps at 10 degrees Farenheit temperature rise
- Voltage rating: 200 RMS or 300 VDC
- Flame retardant laminate construction, 2 oz. copperclad
- Also functions as cable terminator or experimental plugboard



Extender Cards

Part No.	Contacts	Spacing	Height	Width	Material	Bus
3690-16	56	0.125	6.500	4.500	Epoxy Glass Composite	SDTI
3690-10	100	0.125	7.500	10.000	Epoxy Glass Composite	S100
3690-20	86	0.156	9.000	9.750	Epoxy Glass Composite	Motorola
3690-18	60	0.100	7.650	12.000	Epoxy Glass Composite	Multibus



Vectorbord® **Printed Circuit Board** Connectors

R600 Series Wire Wrap and Solder Tail Edge Card **Connectors For** 0.062" Thick Printed **Circuit Boards**

Designed for low insertion force, minimum wear on circuit board edge contacts. Mating contacts are gold/ nickel plated for reliability. Highly efficient, 30Mv maximum contact resistance drop at 3 amps rated current. Insulation resistance is 5000 Megohms at 500V DC. Vectorbord® Edge Card Connectors are supplied with betweencontact polarizing keys. R630 and R644 connectors supplied with in-contact polarizing keys.

General Specifications:

Solder Type Insulator Material:

Phenolic, UL-94V-0 or Glass filled diallyl phthalate UL-94V 1 or Ryton R10.

Wire Wrap Type Insulator Material:

Phenolic, UL-94V-0 or Glass filled diallyl phthalate UL-94V-1 or Polyester (VALOX) UL-94V-0.

Contact Material:

Phosphor bronze QQ-B-750 or Beryllium copper.

Contact Plating: .000010" gold over .000050" nickel.

Test Voltage: 650 VAC.

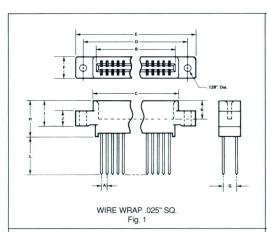
Rated Current:

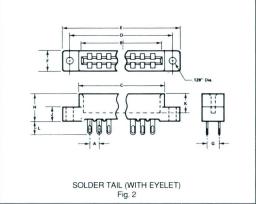
3 AMPS.

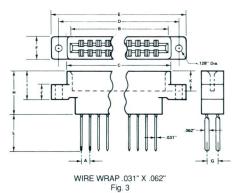
Contact Res. Drop: 30 MV Max. @ rated current.

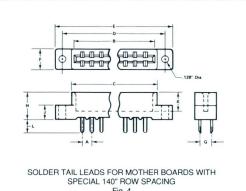
Insulation Resistance:

5000 meghoms, mon. @ 500 VDC.









Connecto	Connector Ordering Table By Contact Centers															
Part No.	A Ctrs.	No. of Contacts	Termination Type	B Card Slot	С	D Mtg. Hole Ctrs.	E	F	G Row Spacing	Н	1	J	K	L	Mounting Ears	Fig.
R644-2	.100	44	Wire Wrap	2.300	2.55	2.850	3.120	.41	.200	.62	.55	.25	.34	.65	Center	1
R683-1	.100	60	Solder Tail	3.100	3.28	3.575	3.950	.41	.200	.47	n/a	.25	.34	.25	Flush	2
R636	.100	72	Wire Wrap	3.707	3.88	4.175	4.475	.41	.200	.62	.55	.25	.34	.65	Center	1
R636-1	.100	72	Wire Wrap	3.707	3.88	4.175	4.475	.41	.200	.62	.55	.25	.34	.65	Center	1
R636-2	.100	72	Solder Tail	3.707	3.88	4.175	4.475	.41	.200	.47	n/a	.25	.34	.25	Flush	2
R656	.125	56	Wire Wrap	3.625	3.79	4.045	4.325	.41	.250	.62	.55	.25	.34	.65	Center	1
R656-1	.125	56	Solder Tail	3.625	3.79	4.045	4.336	.41	.200	.47	n/a	.25	.34	.25	Flush	2
R656-2	.125	56	Wire Wrap	3.625	3.79	4.045	4.325	.41	.250	.62	.55	.25	.34	.22	Center	1
R680	.125	80	Wire Wrap	5.125	5.29	5.545	5.805	.41	.250	.62	.55	.25	.34	.65	Center	1
R680-1	.125	80	Wire Wrap	5.125	5.29	5.545	5.805	.41	.250	.62	.55	.25	.34	.65	Center	1
R680-2	.125	80	Solder Tail	5.125	5.29	5.545	5.805	.41	.200	.62	.55	.25	.34	.65	Center	2
R681	.125	100	Solder Tail	6.375	6.54	6.795	7.065	.33	.150	.45	n/a	.25	.34	.23	Flush	4
R681-1	.125	100	Wire Wrap	6.375	6.54	6.795	7.065	.41	.250	.62	.55	.25	.34	.65	Center	1
R681-2	.125	100	Wire Wrap	6.375	6.54	6.795	7.065	.41	.250	.62	.55	.25	.34	.22	Center	4
R681-3	.125	100	Solder Tail	6.375	6.54	6.795	7.065	.41	.200	.47	n/a	.25	.34	.25	Center	2
R630	.156	30	Solder Tail	2.504	2.65	2.938	3.270	.41	.200	.47	n/a	.25	.34	.25	Center	2
R644	.156	44	Solder Tail	3.596	3.75	4.032	4.360	.41	.200	.47	n/a	.25	.34	.25	Flush	2
R644-1	.156	44	Wire Wrap	3.596	3.75	4.032	4.360	.36	.188	.72	.46	.25	.35	.77	Center	3
			.031 x .062													
R644-3	.156	44	Wire Wrap	3.596	3.75	4.032	4.360	.41	.200	.62	.55	.25	.34	.65	Center	1
R685-1	.156	86	Solder Tail	6.872	7.00	7.302	7.550	.41	.200	.47	n/a	.25	.34	.25	Flush	2
R685-2	.156	86	Solder Tail	6.802	7.00	7.302	7.550	.41	.200	.47	n/a	.25	.34	.25	Flush	2

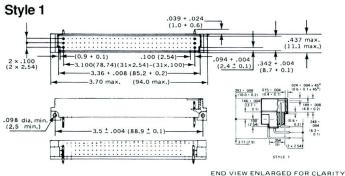
Vectorbord® Printed Circuit Board Connectors

96-Pin DIN Connectors

For solder or Wire Wrap applications, designed in accordance with DIN specification 41612. DIN Connectors, essential

Fully Loaded 96 Position Connectors, Type C

		Fully Loaded 96 Position Connectors, Type C								
Part No.	Terminal Leads & Application	Photo								
RE96MSR										
RE96FW										
RE96FSD										
RE96FWP										
RE96MWR										
	RE96FWP	Part No. & Application RE96MSR RE96FW RE96FSD RE96FWP								



Style 4

31 EO. SP @ 100 = 3 100

110 DIA

133

3 543

3 736

3 342

125

For Y dimension see confact designation code.

TAICKNESS

components of the DIN/ Eurocard Standard, are also used with many bus specific and uncommitted architectures, including VMEbus and Multibus. Superior, two-piece design features gold/nickel plated

Materials

Insulating material:	Glass-filled
	polycarbonate or
	polyether sulphone
Contact material:	Copper alloy
Contact plating:	Gold over nickel

Electrical Data

Current rating:	1.5A at 20°C;
	1A at 70°C
Operating voltage:	300V AC
Test voltage:	1000V AC
Contact resistance:	\leq 20 milli-ohms
Insulating resistance:	$\geq 1 \times 10^9 \text{ ohms}$

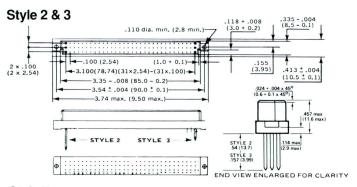
copper alloy contacts and glass-filled polycarbonate or polyether sulphone insulating material. Excellent electrical properties. Custom configurations available per special order.

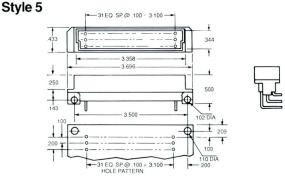
Physical Data

Temperature range:	-55 +125°C
Insertion force:	\leq 90 N \leq 20 LBS.
Tested durability	
according dto IEC:	> 400 cycles

96-Pin DIN Connectors

			Contact	
Part No.	Style	M/F	Length	Туре
RE96FSD	3	F	0.157	Solder Tail
RE96MSD	1	М	0.157	Solder Tail
RE96FSP	4	F	0.208	Pressfit Solder Tail
RE96FSR	1	F	0.087	Solder Tail, Right Angle
RE96FW	2	F	0.54	Wire Wrap
RE96FWP	4	F	0.366	Pressfit Wire Wrap
RE96FWP-G	4	F	0.366	Pressfit Wire Wrap, Gold Platted
RE96MSR-062	1	М	0.087	Solder Tail, Right Angle
RE96MSR-125	1	М	0.174	Solder Tail, Right Angle
RE96MW	2	М	0.54	Wire Wrap
RE96MWR	5	М	0.445	Wire Wrap, Right Angle





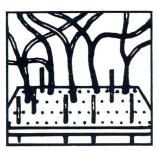


12460 Gladstone Ave., Sylmar, CA 91342 Phone (818) 365-9661 Fax (818) 365-5718 Inside CA (800) 426-4652 Outside CA (800) 423-5659

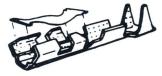
Connector Accessories

T120-1 Slip-On Contacts

Ideal for applications requiring quick tests and changes. Tin-plated contacts slip easily onto 0.025" square wrap posts or pins. Contacts are installed on wire reels, spaced 5" apart.



Wired together "daisy chain" 28 gage stranded

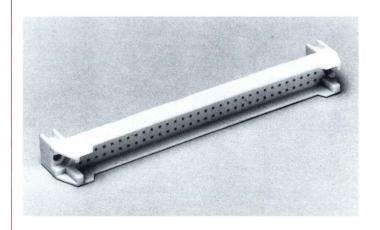


T120 slip-on contacts for .025" square pins, single contacts

Part Number	Contact Description	Package Quantity		
T120-1/50	Installed on wire	Reel of 50		
T120-1/250	Installed on wire	Reel of 250		

79900004 Connector Shrouds

Vector Connector Shrouds provide protective support and housing for wrap tails of 96-pin DIN connectors. Connector Shrouds can convert tails into a 96-pin male DIN connector that can be mated with 96-pin female DIN connector.

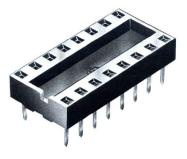


R700 Series DIP Sockets

DIP Socket configurations accommodate most DIP IC packages and include many outstanding features:

- · Gold springs in contact areas
- Designed to accept rectangular and round component leads
- Molded, glass-filled nylon housings

- Designed for most Vectorbord patterns
- · Contact row spacing is 0.30"
- Vector P150 Extraction Tool available separately
- Also available: High performance DIP sockets with surface-mount decoupling capacitors, contact factory



	Package	Number		Cas	Term. Length		
Part No.	Quantity	of Contacts	Type	Height	Length	Width	Below Casting
R714/25	25	14	Wrap Post	.280	.765	.400	.690
R716/25	25	16	Wrap Post	.280	.865	.400	.690
R716-2/10	25	16	Solder Tail	.150	.800	.400	.150



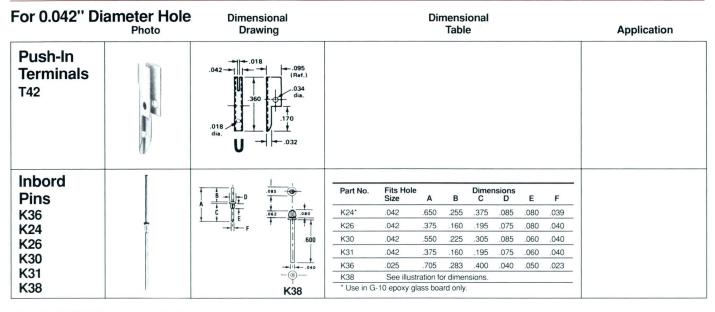
Socket Pins and Terminals

An excellent selection of socket pins, terminals, and accessories is available for all Vectorbord patterns,

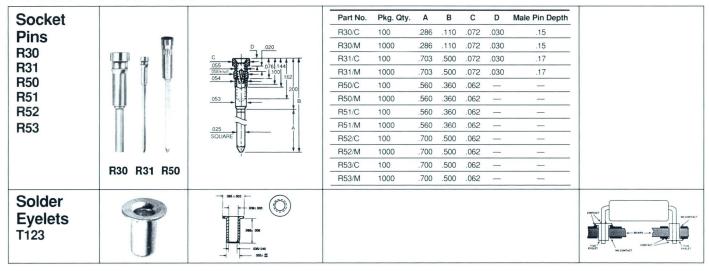
sizes, and hole diameters. Installation tools available separately, see tables. See Pins and Terminals on pages 98 to 100

For 0.042" Di	ameter Hole	Dimensional Drawing			Di	mens Tab	sional le			Application
Socket Pins R32		10 - 620 Cit. (2)1 - 101 10. (0) WAS. (2)	Part No. R32/C R32/M	Pkg. Qty. 100 1000	A .745 .745	.500 .500	C .072 .072	D .155 .155	Male Pin Depth .13 .13	
Trifurcated Klipwrap Terminals T49		149 .560 149-1 .388								
Bifurcated Miniwrap Terminals T44 T68		000 172 000 000 000 172 000 000 172 000 000 172 000 000 172 000 000 172 000 000 000 172 000 000 172 000 000 172 000 000 172 000 000 172 000 000 000 172 000 000 172 000 000 172 000 000 172 000 000 172 000 000 000 172 000 000 172 000 000 172 000 000 172 000 000 172 000 000 000 172 000 000 172 000 000 172 000 000 172 000 000 172 000 000 000 172 000 000 172 000 000 172 000 000 172 000 000 172 000 000 000 172 000 000 172 000 000 172 000 000 172 000 000 172 000 000 000 172 000 000 000 172 000 000 000 172 000 000 000 000 000 000 000 000 000 0								
Press-In Terminals T46		.063- .120 .040 .044 B		Part No. T46-2-9 T46-3-9 T46-5-9		.36 .46		0	3 42 60	
Wire Wrap Terminals T125 T126		014 MAX		Part No. T125/C T126/C	10	nty. 00 00	A .560		529	
J-Pin Terminals K32		0 \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \		Part No. K32 K32-2		A .250 .170		.6	3 50 50	'P PATTERN MICRO- VECTORBORD T.42-1 MICRO- KLIP





For 0.055" Diameter Holes



For 0.062" Diameter Holes

Push-In Terminals T28		1115 - T	,	Part No.		A		В	8
	0 .055	7 .035		T28	.4	37		.237	9
Rolled Flanged Eyelet				Part No.	A	В	С	I.D.	
T15.23		1 · 003 0		T15.23/M	.059	.150	.093	.068	



Socket Pins and Terminals

Socket Pins

Vector socket pins with gold-plated contact surfaces, for 0.042" and 0.055" hole diameters. Precision 0.025" square posts provide excellent 'grip" for both manual and automated Wire Wrap wiring. Engineered for secure electrical connections, easy insertion of leads, and solderless mounting. Available with two- or three-level Wire Wrap tails, and in standard (four-finger contacts) and low insertion force (six-finger contacts) models. Pressfit socket pins and gold-plated socket pins also available.

Terminals

Vector Wiring Terminals provide convenient, low-cost solutions for connection requirements. Engineered for versatility and reliabilty, and available in many styles and options.

See Selector Guides for Pins and Terminals pages 96, 97

T124 Solder Washers

Multi-functional solder washer kits, Vector Part No. T124, with three sizes of washers. Different sizes provided to fit over sockets and tails of most Vector socket pins and wiring terminals. Ideal tools for committing pins to voltage and ground planes in Vectorbord patterns, such as Voltage/Ground Plane and Vectorbord plus™, that have clearance area isolating holes from planes.



Qty.	I.D.	O.D.	Application
500	.078	.110	Vcc Side
500	.058	.103	GND Side
100	.040	.106	Connector
Part No.	T124-040/50	0	
Qty.	I.D.	O.D.	Application

.106 Connector

.040

Part No. T124/M

500

For 0.042" Diameter Holes

R32 Socket Pin

- Low profile Wire Wrap socket pins
- · Pressfit mounting
- Four-finger contacts, tapered sockets for easy insertion



T44, T68 Bifurcated Miniwrap Terminals

- Wire Wrap Tail with twopronged receptacle for wires or leads
- · 0.025" square posts
- Rectangular terminal with stepped shank presses securely into plated or unplated holes, requires no staking or soldering
- Bifurcated end holds soldered leads securely
- T44: maximum 0.021" diameter leads or 24 gage wires
- T68: maximum 0.032" diameter leads or 20 gage wires

T49 Trifurcated Klipwrap Terminals

- Wire Wrap tail with threepronged receptacle for wires or leads
- 0.025" square posts
- Wires or leads are crimped into receptacle on component side, secured for soldering
- Holds 0.018"-0.025" diameter leads or 22 gauge wires in lower slot, 0.032"-0.040" diameter leads or 17 gage wires in upper slot

T46 Press-In Terminals

- Single- and double-tailed (accessible from both sides) Wire Wrap terminals
- 0.025" square posts
- Provides secure contact without soldering or staking
- Rectangular base with stepped shank presses into plain or plated-thru holes and is retained without etching or soldering
- Pointed ends slide neatly into all wrapping bits

Terminal:	Terminal:		Hand	P15	P158 Insertion Tool:			
Tin Plate Part No.	Gold Plate Part No.	Package Quantity	Insertion Tool	with Die	Anvil	Base		
T44/M	T44-1/M	1000	A13	D11	D7-3	P96C1		
T68/C		100	A13-1	D17	D7-3	P96C1		
T68/M	T68-1/M	1000	A13-1	D17	D7-3	P96C1		
T68A/M	_	1000	A13-1	D17	D7-3	P96C1		
T46-2-9/M	T46-2A9/M	1000	P133B	D7-4	_			
T46-3-9/C	_	100	P133B	D7-4	_	4		
T46-3-9/M	T46-3A9/M	1000	P133B	D7-4	_	_		
T46-4-9/C		100	P133B	D7-4	_	_		
T46-4-9/M	T46-4A9/M	1000	P133B	D7-4		_		
T46-5-9/C	_	100	P133B	D7-4	_	1		
T46-5-9M	T46-5A9/M	1000	P133B	D7-4	_	1_		
T49/C	T49A/C	100	P156	D8	D7-3	P96C1		
T49/M	T49A/M	1000	P156	D8	D7-3	P96C1		



For 0.042" **Diameter Holes**

T125, T126 Wire Wrap Terminals

- Pressfit Wire Wrap terminals, ideal for voltage and ground holes in Vectorbord plus and Pads & Planes' patterns
- Two-level terminals: Part No. T125
- · Three-level terminals: Part No. T126
- · 0.025" square posts
- Secure contact in plated-thru holes for soldering



J Pin Terminals

- Wire Wrap terminal installs in two 0.042" diameter holes on 0.1" centers
- · Short leg can be bent to secure pin
- · Long post can share hole with T42-1 Micro-Klip



T42 **Push-In Terminals**

- Wiring terminals for mounting leads or wires horizontally or vertically (through board hole)
- Connections require no staking for most applications
- Horizontal slot holds up to seven wires, depending upon thickness of wire



K36, K24, K26, K30, K31, K38 **Inbord Pins**

- · Press-in pins provide excellent solder points
- · Installation tools available separately, see table
- · Available in several sizes



See Selector **Guides for Pins** and Terminals pages 96, 97

Terminal: Tin Plate Part No.	Terminal:		Hand	P	P158 Insertion Tool:			
	Gold Plate Part No.		Insertion Tool	with Die	with Anvil	with Base		
K32/C	_	100	_	D14	A14	P96C1		
K32/M	_	1000	_	D14	A14	P96C1		
K32-2/M	_	1000	_	D14	A14	P96C1		
T44/C	T44-1/C	100	A13	D11	D7-3	P96C1		

		For Hole	Package			Hand Insertion		B Impact T	ool with
Part No.	Туре	Dia.	Quantity	Material	Plating	Tool	Die	Anvil	Base
K24A/M	Inbord Pin	.042	1000	Phosphor Bronze	Gold	P133A	D7-2	_	_
K24C/M	Inbord Pin	.042	1000	Phosphor Bronze	Tin	P133A	D7-2	_	_
K26C/M	Inbord Pin	.042	1000	Phosphor Bronze	Tin	P133A	D7-2	_	_
K30C/M	Inbord Pin	.042	1000	Phosphor Bronze	Tin	P133A	D7-2	_	
K31A/M	Inbord Pin	.042	1000	Phosphor Bronze	Gold	P133A	D7-2	_	1
K31C/M	Inbord Pin	.042	1000	Phosphor Bronze	Tin	P133A	D7-2	_	_
K38C/M	Inbord Pin	.042	1000	Phosphor Bronze	Tin	P133A	D7-2	=	-
T42-1/C	Micro Klip	.042	100	Copper Alloy	Tin	P149 or P149A	_	_	-
T42-1/M	Micro Klip	.042	1000	Copper Alloy	Tin	P149 or P149A	_	_	



For 0.042" Diameter **Holes**

T112 **Bus Links**

- 0.075" solder-coated links connect 0.1" hole centers and provide firm anchoring for 0.025" square wrap posts
- · Also can be used to anchor **DIP** sockets
- · Available in 0.2", 0.3", and 12" lengths, with cutout holes positioned at 0.1" intervals

Part No.	Pkg.	Len.	Holes	Ctrs
T112/C	100	12"	120	0.1"
T112-1/M	1000	0.2"	1	_
T112-2/M	1000	0.3"	1	_

T107 **Bus Strips**

- Solder-coated strips, 0.08" wide, with 0.042" diameter holes space on 0.1" centers
- Compatible with most Vectorbord® hole patterns
- · Can be mounted on circuit boards as bus lines

Part No.	Package
T107/10	10
T107/C	100

See Selector **Guides for Pins** and Terminals pages 96-97

For 0.055" Diameter Holes

Socket Pins

For specification of package quantity, indicate either 1C for 100/package or 1M for 1000/package. Example: R31/C

R31

- · Low profile Wire Wrap socket pins
- · Four-finger contacts, tapered socket for easy insertion

R50

- Two-level Wire Wrap pins, 0.025" square posts
- Four-finger contacts, tapered sockets for easy insertion
- Gold-plated contact surfaces

R51

- Two-level Wire Wrap pins, 0.025" square posts
- Six-finger contacts, low insertion force sockets
- · Gold-plated contact surfaces

R52

- Three-level Wire Wrap pins, 0.025" square posts
- Four-finger contacts, tapered sockets for easy insertion



R30 R31 R50

· Gold-plated contact surfaces

R53

- Three-level Wire Wrap pins, 0.025" square posts
- · Six-finger contacts, low insertion force sockets
- · Gold-plated contact surfaces

R30

- Low profile, pressfit pins, for hand or dip solder applica-
- · Solder post is 0.110" long, extends 0.19" below and 0.030" above board surface

T123 Solder Eyelets

- · Used to commit holes to power and ground planes, for printed circuit boards with clearance areas isolating holes from planes
- · Simulates plated-thru hole
- Reduces diameter of 0.055" holes to 0.042"
- Also can be used in I/O connector area on many Vectorbord prototyping boards



FOR EASY INSERTION OF THESE SOCKET PINS USE P158 INSERTION TOOL AND D19 DIE

For 0.062" Diameter Holes

T28 Push-In Terminals

- · Wiring terminals for mounting leads or wires horizontally or vertically (through board holes)
- Connections require no staking for most applications
- Vertical (longitudinal) slot holes 0.025" diameter leads or .22 gage wires
- Includes 0.018" diameter tab hole which accepts transistor wires, can be used to hold an anchoring wire

T19/M **Turret Terminal**

· Turret evelet for 0.062" diameter holes, 0.062" thick boards

T15.23/M Rolled Flange Eyelet

- · Eyelet for 0.062" diameter
- · Can be used to simulate plated-thru holes in G and H pattern Vectorbord® prototyping boards
- · Also can be used to reduce hole sizes



		For Hole	Package	Hand ackage Insertion		P158 Impact To			
Part No.	Туре	Dia.	Quantity	Material	Plating	Tool	Die	Anvil	Base
T28/C	Mini-Klip	.062	100	Phosphor Bronze	Tin	P91 or P 91A	_	_	_
T28/M	Mini-Klip	.062	1000	Phosphor Bronze	Tin	P91 or P 91A	_	_	_



Wire

An excellent selection of wire products, many choices of gage size, color, and insulating materials.

Wire For Slit-N-Wrap® Wire Wrapping Tools Tefzel Insulated Silver Plated Wire for use with No. 02 Bit

Part No.	AWG	Color	Spool Dia.	Feet per Spool	Spools Per Pkg.
W28-6A	28	green	1"	50	2
W28-6B	28	red	1"	50	2
W28-6D	28	blue	1"	50	2
W28-6E	28	white	1"	50	2
W28-6F	28	yellow	1"	50	2
W28-6H	28	black	1"	50	2
W28-6AU	28	green	1-1/2"	150	1
W28-6BU	28	red	1-1/2"	150	1
W28-6DU	28	blue	1-12"	150	1
W28-6EU	28	white	1-1/2"	150	1
W28-6FU	28	yellow	1-1/2"	150	1
W28-6HU	28	black	1-1/2"	150	1

Tefzel Insulated Silver Plated Wire for use with No. 04 Bit

Part No.	AWG	Color	Spool Dia.	Feet per Spool	Spools Per Pkg.
W30-6D	30	blue	1-1/2"	200	1
W30-6E	30	white	1-1/2"	200	1
W30-6F	30	yellow	1-1/2"	200	1
W30-6J	30	orange	1-1/2"	200	1

Polyurethane-Nylon Insulated Wire for use with No. 01 Bit

Part No.	AWG	Color	Spool Dia.	Feet per Spool	Spools Per Pkg.
W28-2A	28	green	1"	100	3
W28-2B	28	red	1"	100	3
W28-2C	28	clear	1"	100	3
W28-2D	28	blue	1"	100	3
W36-2B	36	red	1"	200	1

Wire For Conventional Wire Wrapping Kynar Insulated Wire, Silver Plated, Solid Conductor, Easy Stripping, for use with No. 03 Bit

Part No.	AWG	Color	Spool Dia.	Feet per Spool	Spools Per Pkg.
W30-5A	30	green	1"	75	1
W30-5B	30	red	1"	75	1
W30-5E	30	white	1"	75	1
W30-5F	30	yellow	1"	75	1
W30-5AS	30	green	2"	300	1
W30-5BS	30	red	2"	300	1
W30-5ES	30	white	2"	300	1
W30-5FS	30	yellow	2"	300	1

A wide variety of hand tools for use with a wide variety of Vectorbord® products

Designed for installing Vector socket pins and terminals, see tables. Most are excellent tools for installing small quantities of Vector socket pins and terminals. For larger quantities, the P158 springimpact installation tool is recommended. Also recommended are Vector Die Points, Anvils, and Alignment blocks for insuring perpendicularity and board rigidity.

P158 Spring Impact Insertion Tool

Excellent tool for installing terminals, wrap posts, pins, and eyelets—provides consistent, adjustable insertion pressure. Spring activated tool features interchangeable die points and can be adapted to arbor or drill press. Dies, anvils and alignment blocks available separately.



Wrapping Tools

Part No.	Description	Replacement Wire
P160-1B	Manual unwrap tool, bit included	
P160-2B	Manual wrap tool, bit included	
P160-9A	Combination manual wrap/unwrap tool, bits included	
P180-1	Manual Slit-N-Wrap tool with #28 ga. wire Poly-Nylon	W28-2 series
P184-1	Manual Slit-N-Wrap tool with #28 ga. Tefzel wire	
P184-6	Manual Slit-N-Wrap tool with #30 ga. Tetzel wire	W30-6 series

Anvils & Dies

Terminal Reference	Description	Req'd Hole Dia.	Bd. Thk.	Die Part No.	Anvil Part No.	Die/Anvil Intended For:
K24, K41	Inbord Pin	.042	1/6	D7-2	 0	Insertion
K26, K30	Inbord Pin	.042	1/16 3/32	D7-2		Insertion
K31, K38	Inbord Pin	.042	1/16 3/32	D7-2		Insertion
T15, 23	Eyelet	.062	1/16	D1	_	Staking
T19	Terminal	.062	1/16	D1	A6	Staking
T44 series	Sq. Pin	.042	1/16	D11	_	Insertion
T44 series	Sq. Pin	.042	1/16	D11	_	Staking
T49 series	Sq. Pin	.042	1/16	D8	D7-3	Insertion
T49 series	Sq. Pin	.042	1/16	D7	D8	Staking
T68 series	Sq. Pin	.042	1/16	D17	D7-3	Insertion
T68 series	Sq. Pin	.042	1/16	D17	_	Staking

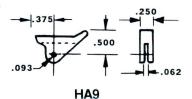
HA9, HA14 Ejector Handles

Ejector Handles available in two versions: corner mounting and front mounting. Corner mount handles are designed for Vectorbord prototyping boards with cut corners and support up to 40 lbs. extraction force. Front mounting handles provide flat, white nylon surface—can be labeled with markers or hot stamped for identification. Mounting hardware included.

Part No.	Package
HA9/4	4
HA9/C	100
HA9/M	1000
HA14	4

HA14

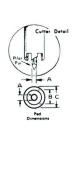




P116, P138 Pad Cutters

Vector Pad Cutters provide an effective method for creating isolated solder pads around holes in copper clad boards. Pilot pin enters hole and rotates, creating a clearance area around the solder pad. Available for holes with 0.055", 0.042" and diameters. Also available without handles for use in manual or power drills.





Part No.	Shank Handle	Α	В	С	Shank	Use With Vectorbord®
P116C	Yes	.055	.188	.250	.250	Pattern F, G, H .062"
P138A	Yes	.040	.086	.125	.125	Pattern P
P138C	No	.040	.086	.125	.125	.042" holes



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4P44XXXP	1	3690-26		5085-4		5260264	
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	1						
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69P84WE		4608-4-1	85	5250237-63		84004006	
69P84WEC1	1	4608	41	5250237-84	77	880000106	E
	1	4609-1		5250238-21			10
70H48-032		4609		5250238-42		AC160-84-1	
701140145						AC100-04-1	
70H48WE		4610-1		5250238-63		AC220-84-1	6
	1	4610-2		5250238-84	77	AC280-84-1	
75F99WE	1	4610-3	12,39	5250268-21	62	AC340-84-1	6
49P84	1	4610-8-1 A	85	5250268-21	77	AC400-84-1	6
38WE		4610-16-1 A		5250268-42		BB21S	
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677	10	4613-8	30	5260232	60	C316EAA28	ŗ
682-2		4613		5260239		C616EAA28	
		4613C5LF	١٥				
682-4				5260240		C616EEA28	
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CCA400-6U		CG2-65M		EFP164A66		LF328UC3T1		
				EFP164A66E				
CCA400-9U		CG2-65P				LF616SC3T1		
CCB160-3U1		CG2-65S		EFP164A66F		LF616UC3T1		
CCB160-3U2		CG2-80M		EFP164A97		LF622SC3T1		
CCB160-6U2		CG2-80P		EFP164A97F		LF622UC3T1.		
CCD160-6U2		CG2-80S		EFP204A66		LF628SC3T1		
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CCK220-6U	56	DK12R		HA9/4		R30/C		
CCK220-9U	57	DK16L		HA9/C		R30/M	97	
CCK280-6U		DK16R		HA9/M		R31/C		
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R51/M		SW52P156		VMEBP5J1		W30-66-46B	
R52/C		SW87P89		VMEBP5J2		W30-86-46B	
R52/M	97	SW87P119	73	VMEBP6J1	81	W45-10-46B	
R53/C	97	SW104P156		VMEBP6J2		W45-10-66B	73
R53/M		T15.23/M	100	VMEBP7J1	81	W45-66-46B.	
R636	93	T19/M		VMEBP7J2	82	W45-86-46B.	73
R636-1	93	T19/M	100	VMEBP8J1	81		
R636-2	93	T28/C	100	VMEBP8J2	82		
R644	93	T28/M	100	VMEBP9J1	81		
R644-1	93	T42-1/C	99	VMEBP9J2	82		
R644-2		T42-1/M	99	VMEBP10J1			
R644-3		T44-1/C	98	VMEBP10J2			
R656		T44-1/M	98	VMEBP12J1			
R656-1		T44/C		VMEBP12J2	82		
R656-2		T44/M	98	VMEBP14J1	81		
R680		T46-2-9/M		VMEBP14J2	82		
R680-1		T46-2A9/M		VMEBP20J1			
R680-2		T46-3-9/C		VMEBP20J2			
		T46-3-9/M	90	VMEBP21-M00			
R681							
3681-1	93	T46-3A9/M	98	VMEBP21J1	81		
R681-2		T46-4-9/C		VMEBP21J2			
3681-3		T46-4-9/M	98	VMEEJ1	87		
R683-1		T46-4A9/M		VMEEJ2	87		
R685-1		T46-5-9/C		VMETBJ1			
7685-2		T46-5-9/M		VMETBJ1-P	84		
R714/25		T46-5A9/M	98	VMETBJ2-P	84		
7716-2/10		T49/C		VMETBJ12			
R716/25		T49/M	98	VMX-4-01			
RE96FS		T49A/C		VMX-6-01	82		
RE96FSP		T49A/M	98	W16-31-21B	73		
RE96FSR	94	T68-1/M	98	W16-31-31B	73		
RE96FW	94	T68/C	98	W20-28-46B	73		
RE96FWP	94	T68/M	98	W20-46-31B	73		
RE96FWP-G	94	T68A/M	98	W20-66-46B			
RE96MS		T107/10	100	W28-2A			
RE96MSD		T107/C	100	W28-2B			
RE96MSR-062.		T112-1/M	100	W28-2C			
RE96MSR-125		T112-2/M	100	W28-2D	101		
RE96MW		T112/C		W28-6A	101		
RE96MWR		T120-1/50		W28-6AU			
SE1322A	52	T120-1/250	95	W28-6B	101		
SE1322B		T123-1/230		W28-6BU			
SE1722A		T124-040/500		W28-6D			
E1722B		T124/M		W28-6DU			
SE2322		T125		W28-6E			
SE2322A-01		T126					
				W28-6EU			
SE2322B-01		TS81		W28-6F			
SE2722		TS81-5		W28-6FU			
SE2722A-01		TS81N4		W28-6H			
SE2722B-01		TS169		W28-6HU			
SE2822		TS169-4		W30-5A			
SE2822BR-1		TS169-6		W30-5AS			
SE2822DH-1		TS169NP4		W30-5B			
SE3022		TS169P		W30-5BS			
SE21122C-1		TS209		W30-5E			
SE4617		TS300	71	W30-5ES			
SR2-41		TS300A		W30-5F	101		
SR3-41		TS600		W30-5FS	101		
SR16-41		TSW169-4		W30-6D			
SR45-41		TSW300		W30-6E			



Laminate Table of Properties

Board Type	Phenolic			Epoxy Paper			Epoxy Glass*			Epoxy Glass Composite*		
Description	Unclad	1 oz. Copper Clad 1 side	1 oz. Copper Clad 2 side	Unclad	2 oz. Copper Clad 1 side	2 oz. Copper Clad 2 side	Unclad	2 oz. Copper Clad 1 side	2 oz. Copper Clad 2 side	Unclad	2 oz. Copper Clad 1 side	2 oz. Copper Clad 2 side
Overall Board Thickness	.062 NOM	.062 NOM	.062 NOM	.062 NOM	.062 NOM	.062 NOM	.062 NOM	.962 NOM	.062 NOM	.062 NOM	.062 NOM	.062 NOM
Copper Clad Thickness Each Side (IN)		.0014 (1 oz.)	.0014 (1 oz.)		.0028 (2 oz.)	.0028 (2 oz.)		.0028 (2 oz.)	.0028 (2 oz.)		.0028 (2 oz.)	.0028 (2 oz.)
Max Electrical Temperature	221°F (105°C)	221°F (105°C)	221°F (105°C)	230°F (110°C)	230°F (110°C)	230°F (110°C)	266°F (130°C)	266°F (130°C)	266°F (130°C)	266°F (130°C)	266°F (130°C)	266°F (130°C)
NEMA Grade	FR-2	FR-2	FR-2				FR-4	FR-4	FR-4	CEM-1	CEM-1	CEM-1
UL-Flamability Classification				94HB	94HB	94HB	94V-0	94V-0	94V-0	94V-0	94V-0	94V-0
MIL-STD							MIL-P13949 Type GF	MIL-P-13949 Type GF	MIL-P-13949 Type GF			

*On PTH boards, trace thickness is approximately 1.5 oz.

Limited Warranty:

Vector Electronic Company (Vector) warrants the products it offers for sale in this catalog for ninety (90) days from date of delivery to original consumer in the normal course of business up to the price actually paid by that customer, against manufacturing defects in material or workmanship in accordance with the following terms and conditions.

- Vector's sole liability under this warranty will be to repair or replace, at its discretion, products which do not meet the specifications and descriptions provided herein due to defects in materials and workmanship. This warranty does not apply to products damaged after shipment from Vector or distributor warehouse.
- Repairs or adjustments covered under this warranty will be determined by Vector at its sole discretion.
- **3** For your protection, we require proof of original purchase date for warranty determination.
- Products must be returned prepaid to the factory for repair or replacement. Please include a detailed, written description of the problem. This description should explain the application for which the Vector product was intended, including any and all tools and devices used in accordance with this application. Vector will return the repaired or replacement unit prepaid if the defects are within the scope of the warranty. Products returned for repair that are not covered by this warranty will only be returned at customer's expense. If there are any questions, please call first for authorization to return the products.
- The Warranty Period shall not be extended beyond its original term with respect to any part or parts repaired or replaced by Vector hereunder. This Warranty Period shall not apply to any product which has been repaired or altered in any manner or if the defect, malfunction or failure of the product to conform to this warranty.

was caused by damage while in the possession of the consumer, or from unreasonable use, improper installation or application, or to any product which has not been maintained or used in accordance with the operating specifications set forth in Vector's written instructions.

- 6 Implied warranties of merchantability or fitness for any particular purpose are limited in duration to the ninety day warranty period specified above.
- Under no circumstances shall Vector be liable for any consequential or special damages for breach of this warranty. Vector's total liability under this warranty shall be limited to the price actually paid by the customer for the products covered. Vector neither assumes nor authorizes any person to assume for it any obligation or liability other than as herein expressly stated.
- This warranty gives you certain specific legal rights, and you may also have other rights which vary from state to state.
- This Limited Warranty applies only to standard Vector products. Custom products, such as VLS-3 and Multiwire, are covered by warranties stated in the Terms and Conditions of the Vector quotation produced at time of order.



ELECTRONIC COMPANY

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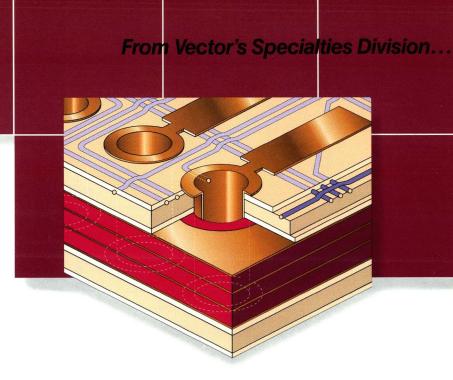
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Turn your existing hydraulic press equipment into a cost-effective, high quality PCB Vacuum Lamination System with a VSL-3 from Vector. Your return on investment is typically 12 months or less!

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- Efficient removal of air, water and solvents
- Elimination of warping problems
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- · Increased throughput

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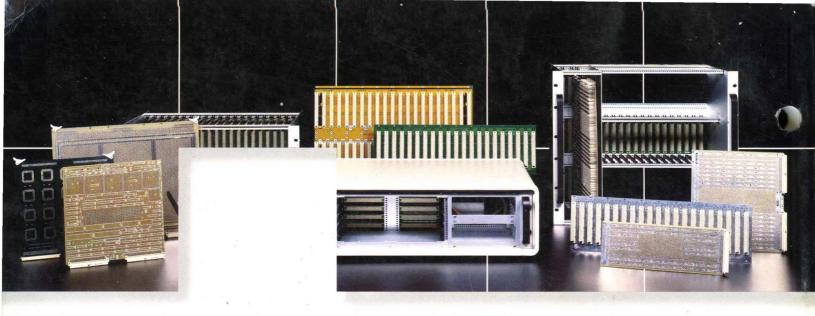
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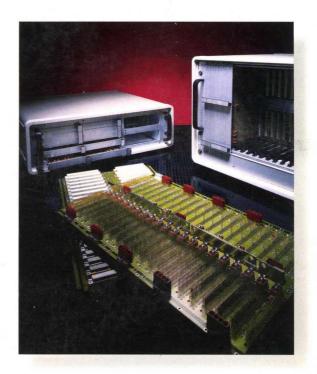




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